Quicksilver Design

POWER

AC/BATT CONNECTOR PG 49

BATT CHARGER PG 43

HybridSLI POWER

HybridSLI SW PG 19, 21
+5V_MXM1/ +5V_MXM2
+3.3V_MXM1/ +3.3V_MXM2

Dual/Quad Core CPU
Intel
Penryn
(35W/45W/OC 55W)
(478 Micro-FCPGA)
35 x 35 mm
PG 5,6

1066 MHz FSB

SYSTEM POWER

MCP VR
+MCP_CORE
PG 45

CPU VR
+VCC_CORE/
+1.05V_VCCP
PG 44, 45

REGULATOR For DDR3
+1.5V_DDR/
+0.75V_DDR_VTT
PG 46

REGULATOR
SYS 5V/ 3V
PG 47

RUN/SUS POWER SW
+5V/+3.3V/+1.5V_RUN
+3.3V_SUS/ +3.3V_ALW
PG 50

LDO
+1.05V_SUS
PG 48

LDO
+1.8V_RUN
PG 48

DDR3-SODIMM PG 17

DDR3-SODIMM PG 18

1333 MHZ DDR III

1333 MHZ DDR III

NVIDIA
MCP79SLI

(1437 Pin PBGA)
35 x 35 mm
PG 7~16

USB x 2

USB2.0

Audio/ Express Board

Audio Jack

Audio Jack

Audio Jack

Audio Jack

Amplifier MAX9724A

Amplifier MAX9724A

AUDIO IDT 92HD73C
(56 LQFP)
9 x 9 mm

IHDA

Internal Speaker 5Wx2

Amplifier TPA6040A4

WebCam+DMIC PG 24

USB2.0

LVDS Mux
TI TS3DV520E PG 23

LVDS

Panel PG 24

VGA

CRT CONN PG 25

HDMI

HDMI Connector PG 27

HDMI Mux
TI TMDS251
PG 26

DP

Display Port PG 27

DP-C

DP-D

DP-A

LVDS

SLI

PCIEx8

PCIEx8

MXM CONNECTOR 1 PG 19-20

MXM CONNECTOR 2 PG 21-22

USB2.0

Light FX PG 36, 37

Keyboard BL
T/P Module

Head Logo - A

Logo - B

Speaker LED

I2C

PCI-E
USB2.0

WLAN Half MINI-CARD PG 30

PCI-E
USB2.0

WWAN MINI-CARD PG 31

PCI-E
USB2.0

UWB/BT MINI-CARD

PG 31

USBx2 PG 28

USB2.0

COMBO CONN USB/eSATA PG 28

USB2.0
SATA2

SATA - ODD PG 29

SATA2

SATA - HDD1 PG 29

SATA2

SATA - HDD2 PG 29

SATA2

PCI-E
USB2.0
RGMII

Express Card

Express Switch
RICOH
R5538D001
(20 QFN)
4 x 4 mm

Audio/ Express Board

33MHz PCI

LPC

1394 PG 39

CardReader CONN

PC Card/1394
RICOH
R5C833T
(128 Pin TQFP) PG 38,39
14 x 14 mm

SM Bus

SPI

SIO
ITE
ITE8512E
(128 Pin LQFP)
16 x 16 mm
PG 34

PHY
Broadcom
B5071A2KFBG
(100 BGA)
9 x 9 mm PG 40

Magnetic PG 41

RJ45 PG 41

Audio/ Express Board

THERMAL
SMSC4002
PG 32

USER INTERFACE
PG 35

MAX7313 X 3
PG 36

FLASH Memory
2MB
(8 Pin SO8W)
PG 34

T/P Board

CIR Board

PS/2

Keyboard PG 35

Touchpad

CIR

DELL/FLEX CONFIDENTIAL

Title: Cover Sheet		
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Power States

Power Rail	Control Signal	S0	S3	S4	S5	G3	S4/ M-off	S5/ M-off
+PWR_SRC	N/A	V	V	V	V	V		
+0.75V_DDR_VTT	RUN_ON	V						
+1.05V_VCCP	CPUVDD_EN	V						
+1.05V_RMGT	SLP_RMGT#	V						
+1.05V_SUS	SUS_ON	V	V					
+1.5V_RUN	RUN_ON	V						
+1.5V_DDR	SUS_ON	V	V					
+1.8V_RUN	RUN_ON	V						
+15V_ALW	N/A	V	V	V	V	V		
+3.3V_ALW	+3.3V_EN2	V	V	V	V	V		
+3.3V_RMGT	SLP_RMGT#	V						
+3.3V_RUN	RUN_ON	V						
+3.3V_SUS	SUS_ON	V	V					
+5V_ALW	+5V_EN1	V	V	V	V	V		
+5V_ALW2	N/A	V	V	V	V	V		
+5V_SUS	SUS_ON	V	V					
+5V_HDD	HDDC_EN	V	TBD					
+5V_MOD	MODC_EN	V	TBD					
+5V_RUN	RUN_ON	V						
+GFX_PWR_SRC	N/A	V	V	V	V	V		
+LCDVCC	ENVDD	V						
+MCP_CORE	RUN_ON	V						
+RTC_CELL	RTC	V	V	V	V	V		
+VCC_CORE	1.05V_VCCP _PWRGD	V						
+USB_RIGHT_PWR	USB_SIDE_EN#	V	TBD					
+USB_LEFT_PWR	USB_BACK_EN#	V	TBD					

By Anthony

Title	FRONTPAGE	
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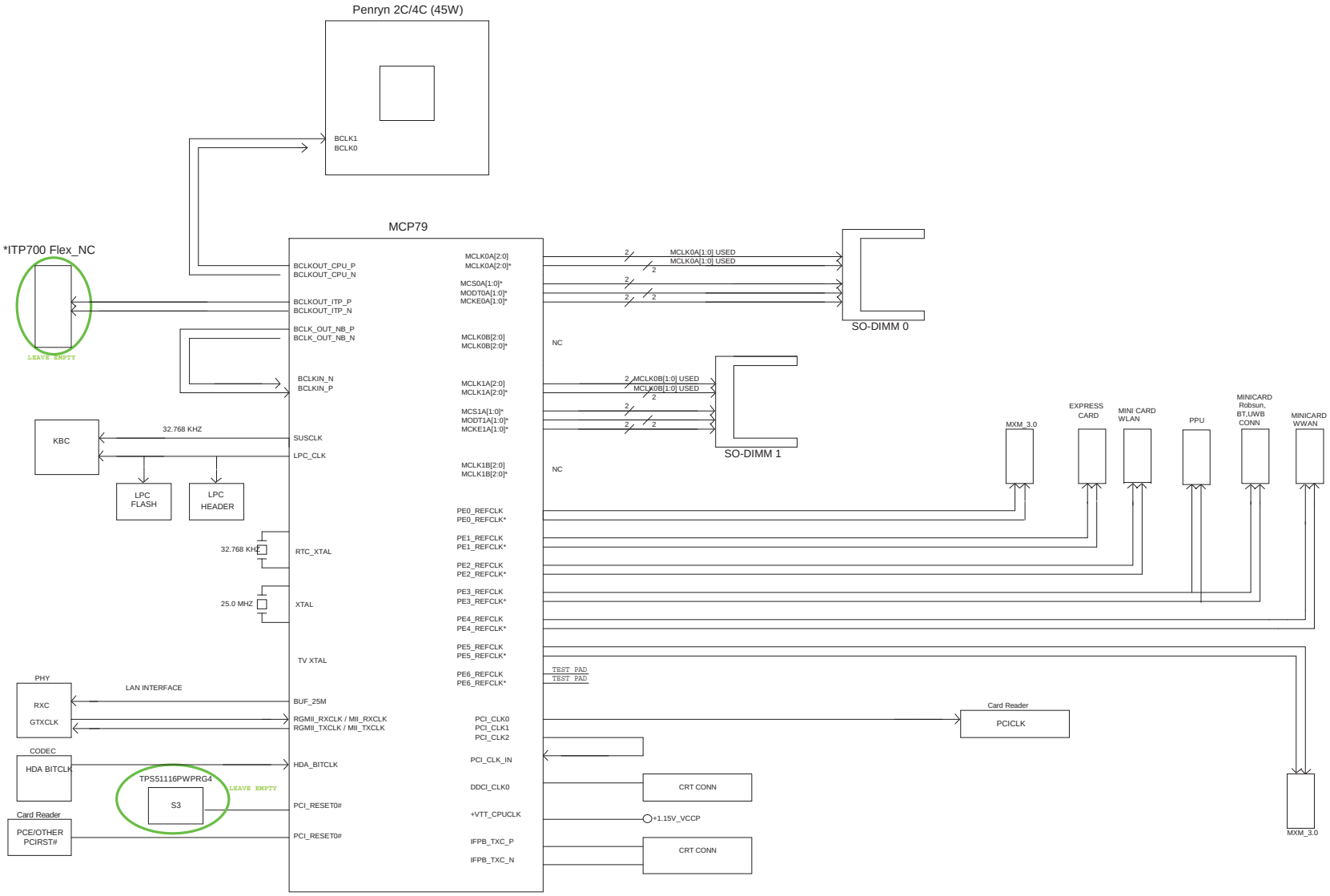

Title: CLOCK MAP

Size: B | Document Number: | Rev: A00

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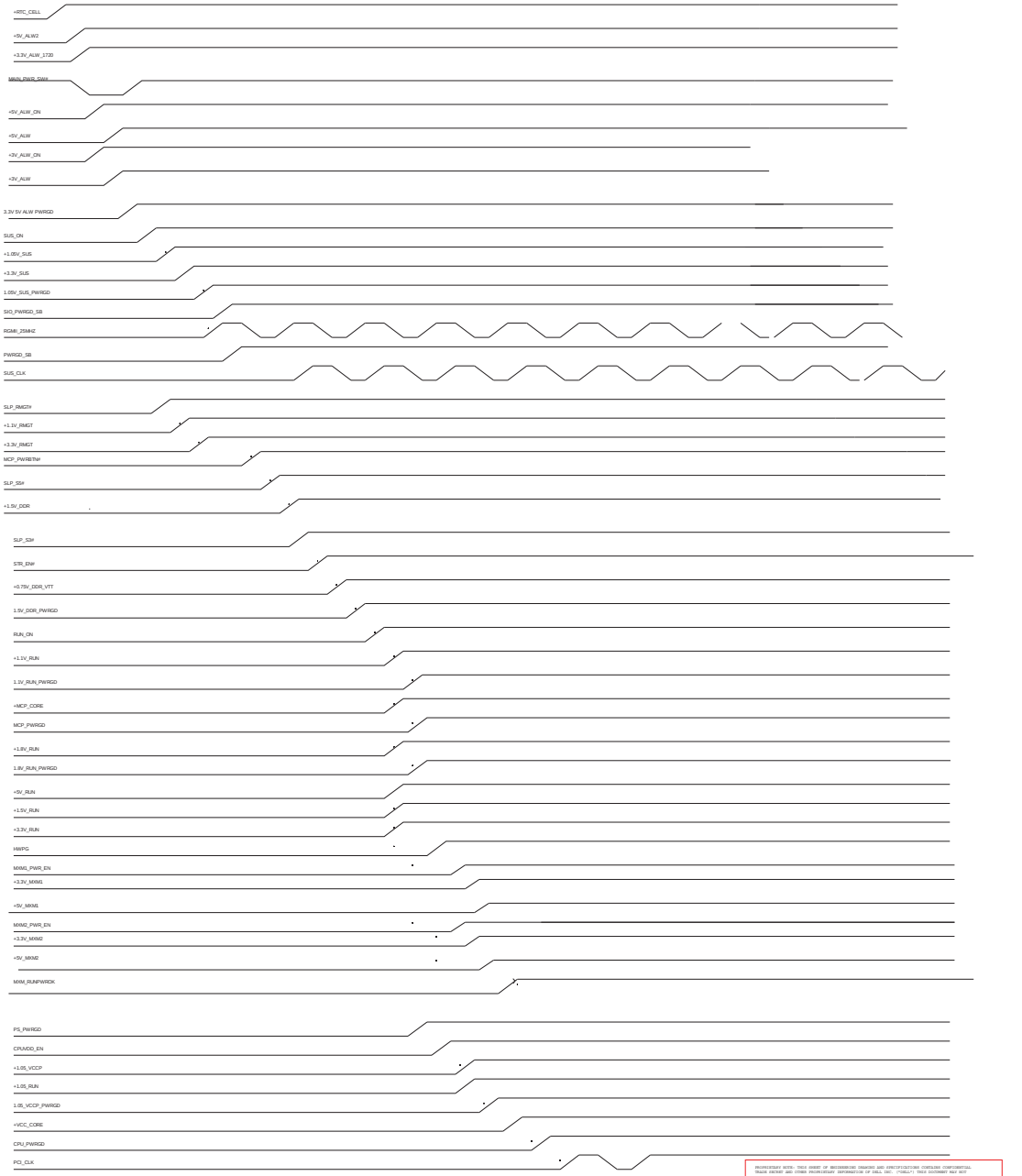
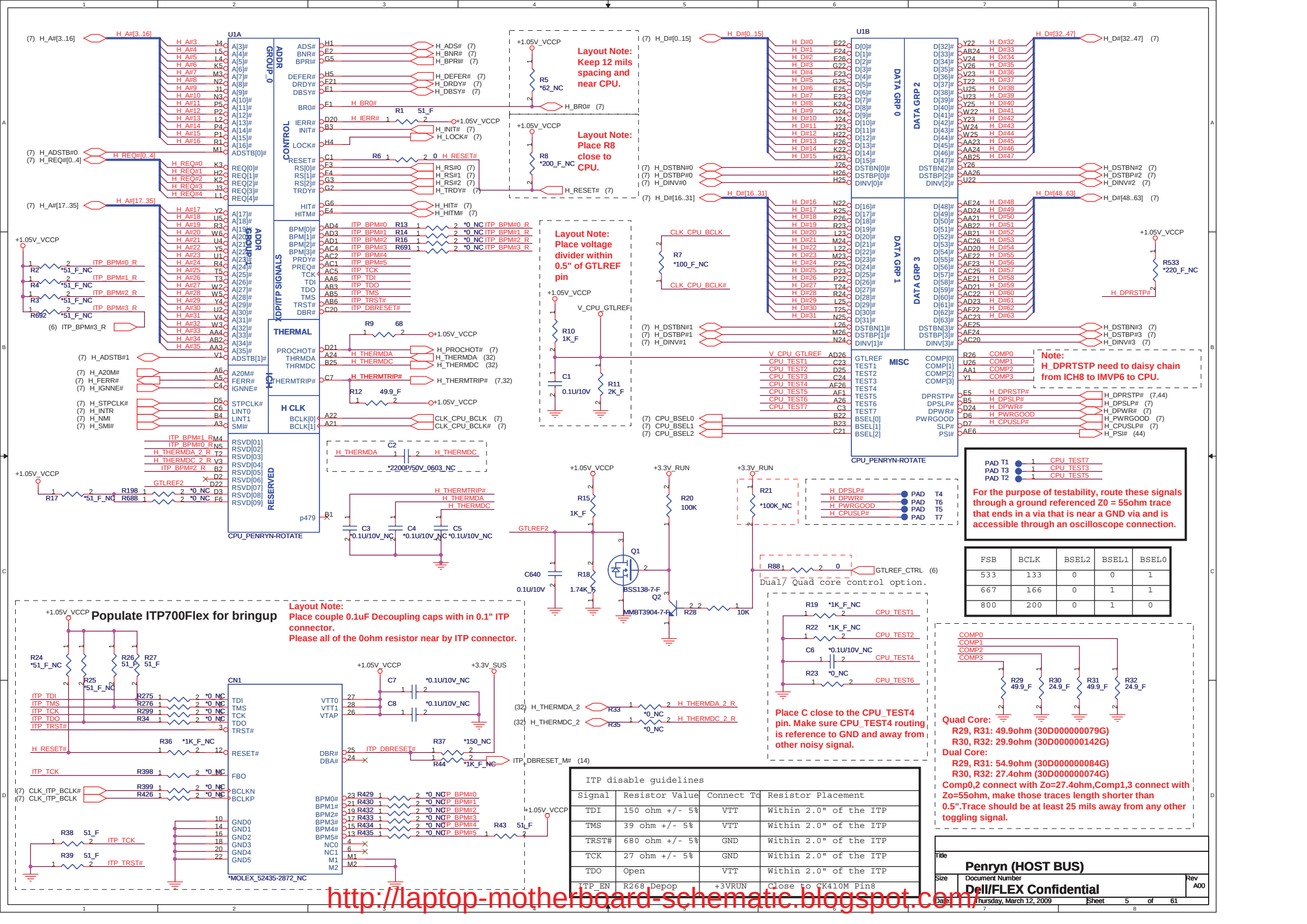
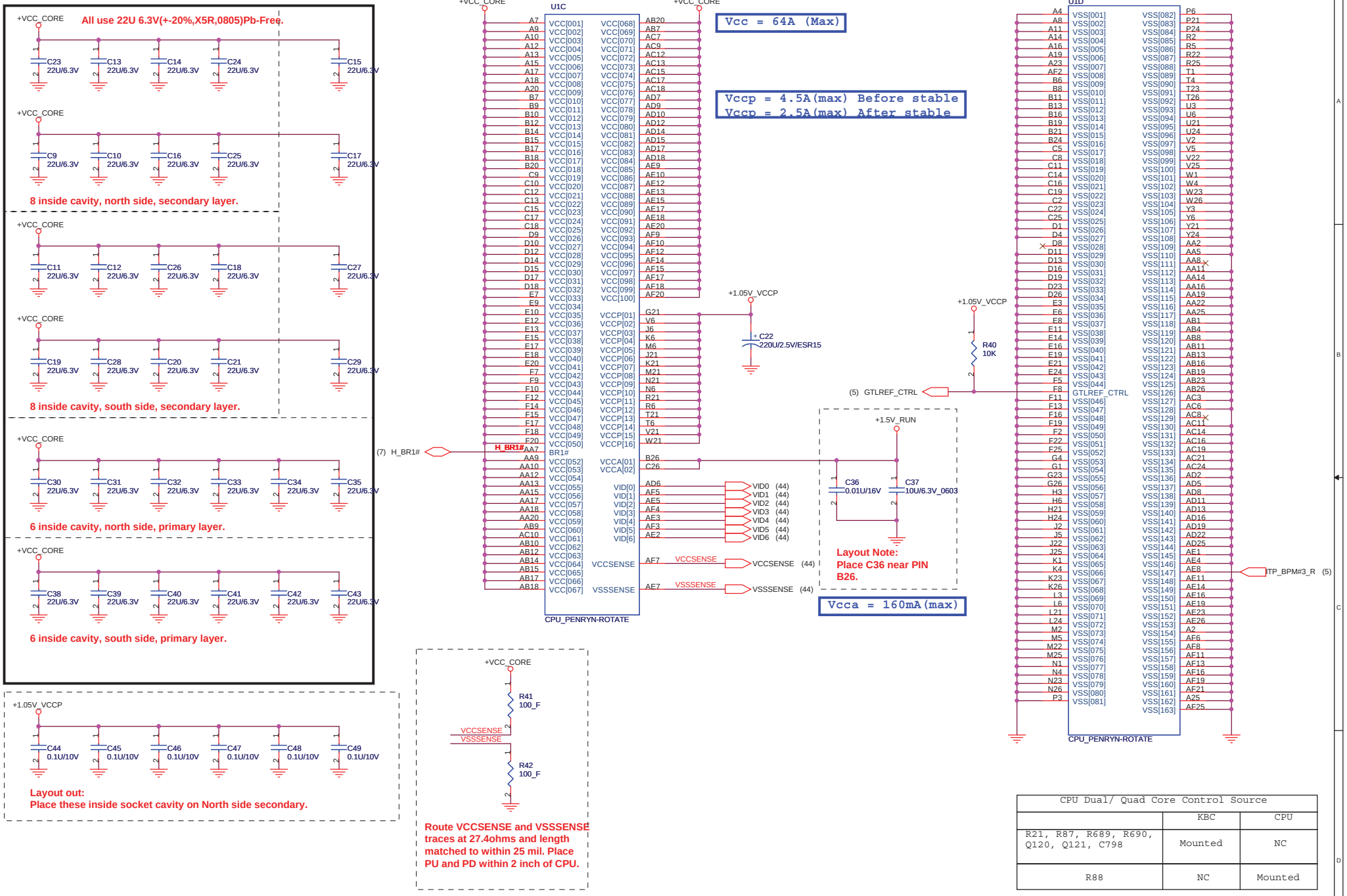
Quicksilver Power Up Sequence.



POWER SEQUENCING

DELL CONFIDENTIAL





CPU Dual/ Quad Core Control Source		
	KBC	CPU
R21, R87, R689, R690, Q120, Q121, C798	Mounted	NC
R88	NC	Mounted

Title: Penryn (POWER/NC)

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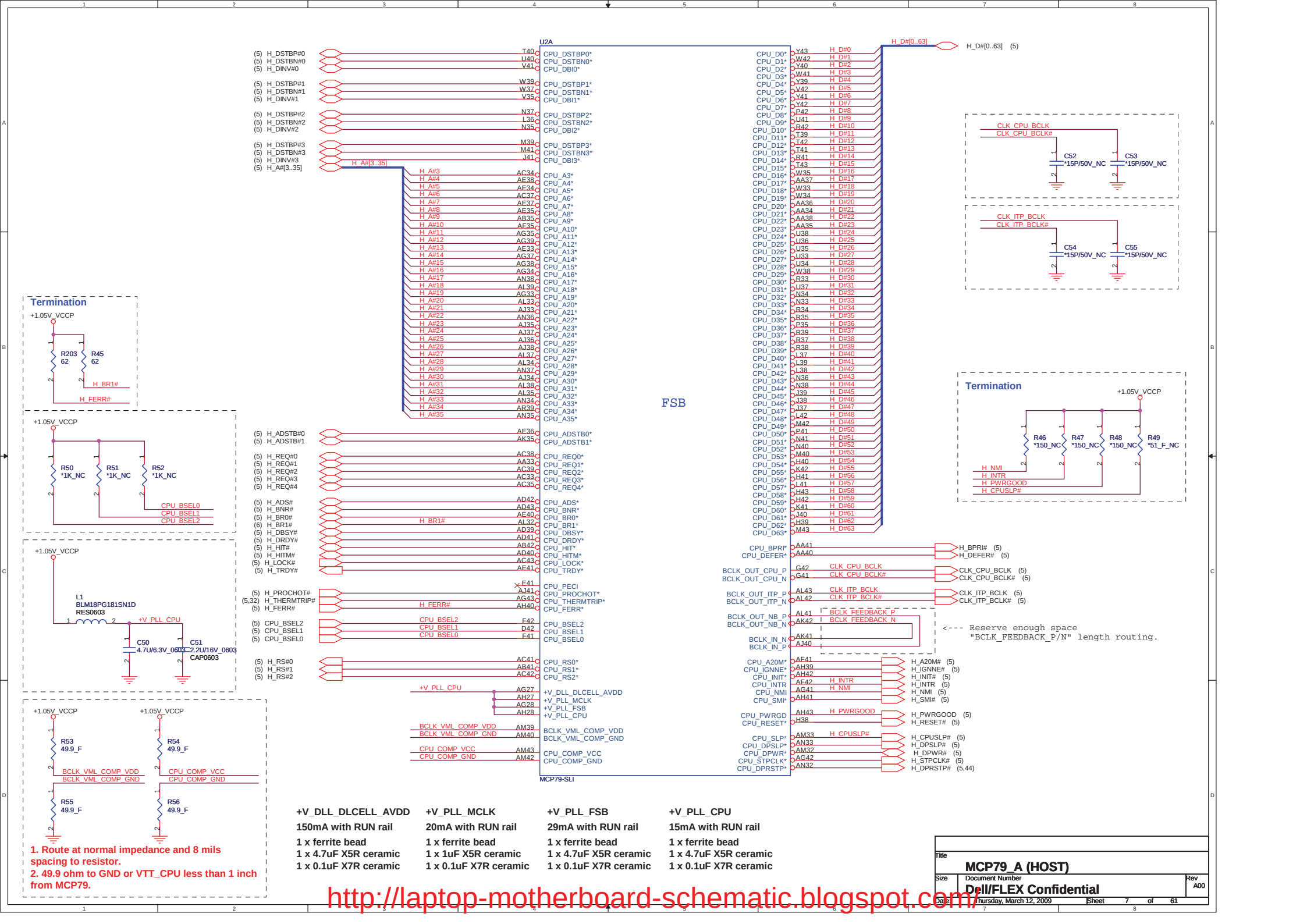

+V_DLL_DLCELL_AVDD
150mA with RUN rail
1 x ferrite bead
1 x 4.7uF X5R ceramic
1 x 0.1uF X7R ceramic

+V_PLL_MCLK
20mA with RUN rail
1 x ferrite bead
1 x 1uF X5R ceramic
1 x 0.1uF X7R ceramic

+V_PLL_FSB
29mA with RUN rail
1 x ferrite bead
1 x 4.7uF X5R ceramic
1 x 0.1uF X7R ceramic

+V_PLL_CPU
15mA with RUN rail
1 x ferrite bead
1 x 4.7uF X5R ceramic
1 x 0.1uF X7R ceramic

1. Route at normal impedance and 8 mils spacing to resistor.
2. 49.9 ohm to GND or VTT_CPU less than 1 inch from MCP79.

Title	MCP79_A (HOST)
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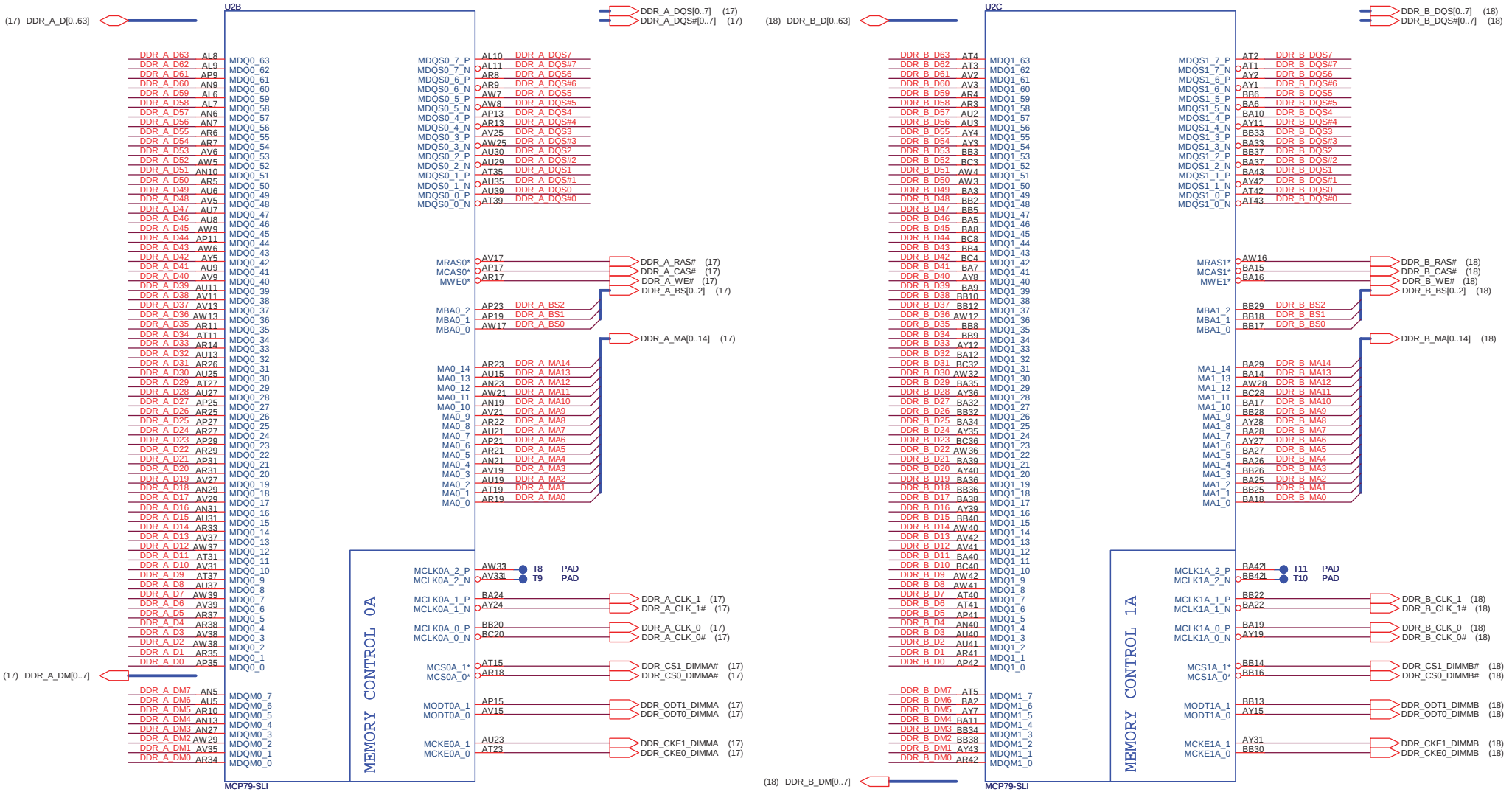

Layout Notice:

Memory Data Signal Group

MCP79 BGA Breakout (<175ps): Route at 50 ohm impedance and 1.5x dielectric height spacing.

After Breakout: Route at 40 ohm impedance and 4x(Microstrip) or 3x(Stripline) dielectric spacing.

DIMM Fan-in (<90ps): Route at 40 ohm impedance and 1.5x dielectric height spacing.

Memory Data Strobes

Route strobes differentially at 66 ohm impedance (42 ohm SE) and 5x dielectric height spacing to other signals.

Memory Clock Signal Group

MCP79 BGA Breakout (<90ps): Route at 50 ohm SE / 100 ohm differential impedance.

After Breakout: Route at 40 ohm SE / 66 ohm differential impedance and 5x dielectric height spacing to other signals.

Memory Address/Command/Control Signal Group

MCP79 BGA Breakout (<90ps): Route at 50 ohm impedance and 1.5x dielectric height spacing.

After Breakout: Route at 40 ohm impedance and 2x dielectric height to other signals and 3x dielectric spacing to other non-associated signals.

DIMM Fan-in (<90ps): Route at 40 ohm impedance and 1.5x dielectric height spacing.

Title	MCP79_B (DDR3)	
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+V_VPLL
39mA with RUN rail

+V_PLL_XREF_XS
17mA with RUN rail

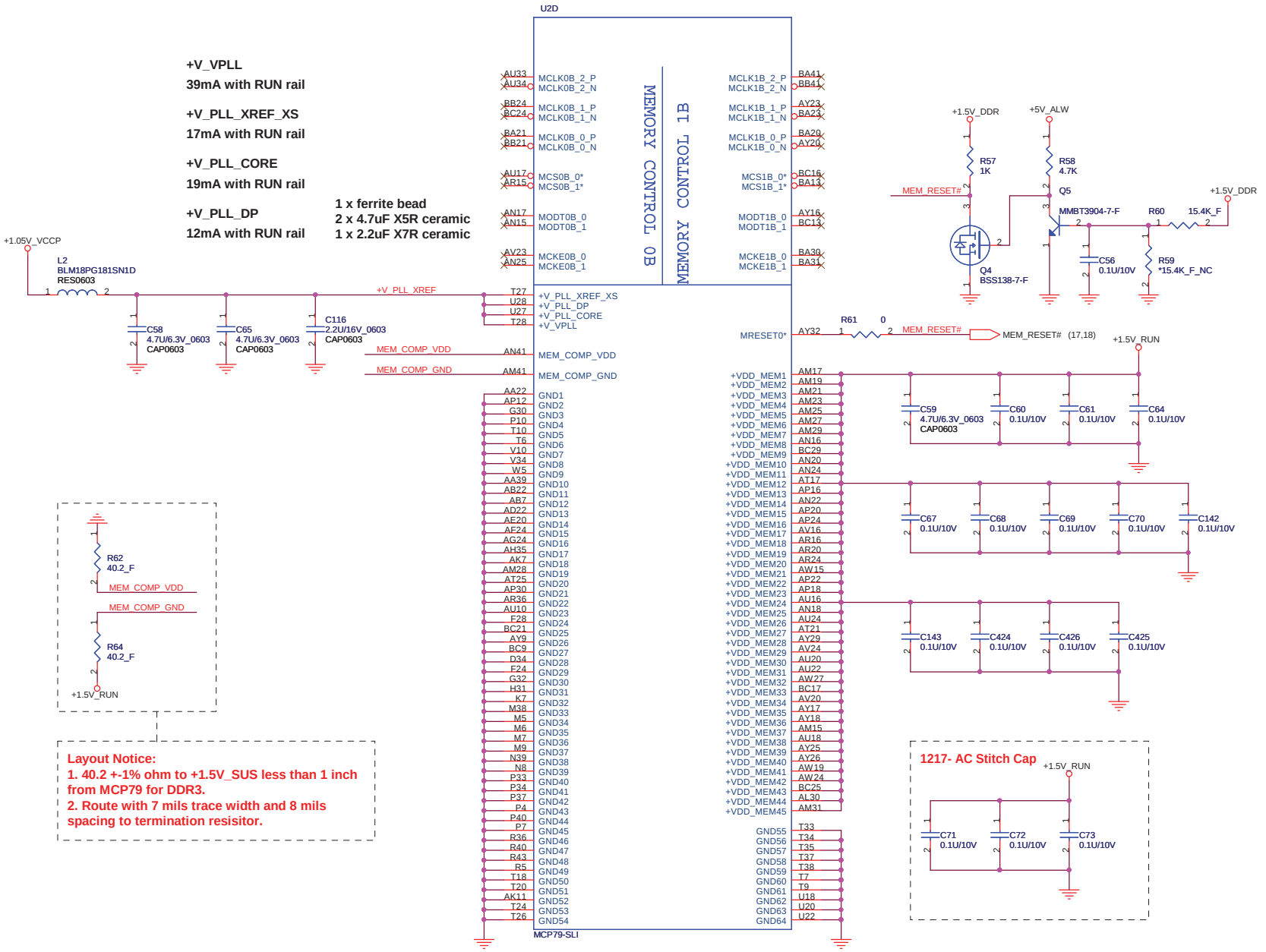
+V_PLL_CORE
19mA with RUN rail

+V_PLL_DP
12mA with RUN rail

1 x ferrite bead
2 x 4.7uF X5R ceramic
1 x 2.2uF X7R ceramic

4.3A with ALW rail for S0
318mA for S0 Idle

1 x 10uF ceramic
9 x 0.1uF X7R ceramic



Title	MCP79_C (MEM POWER)	
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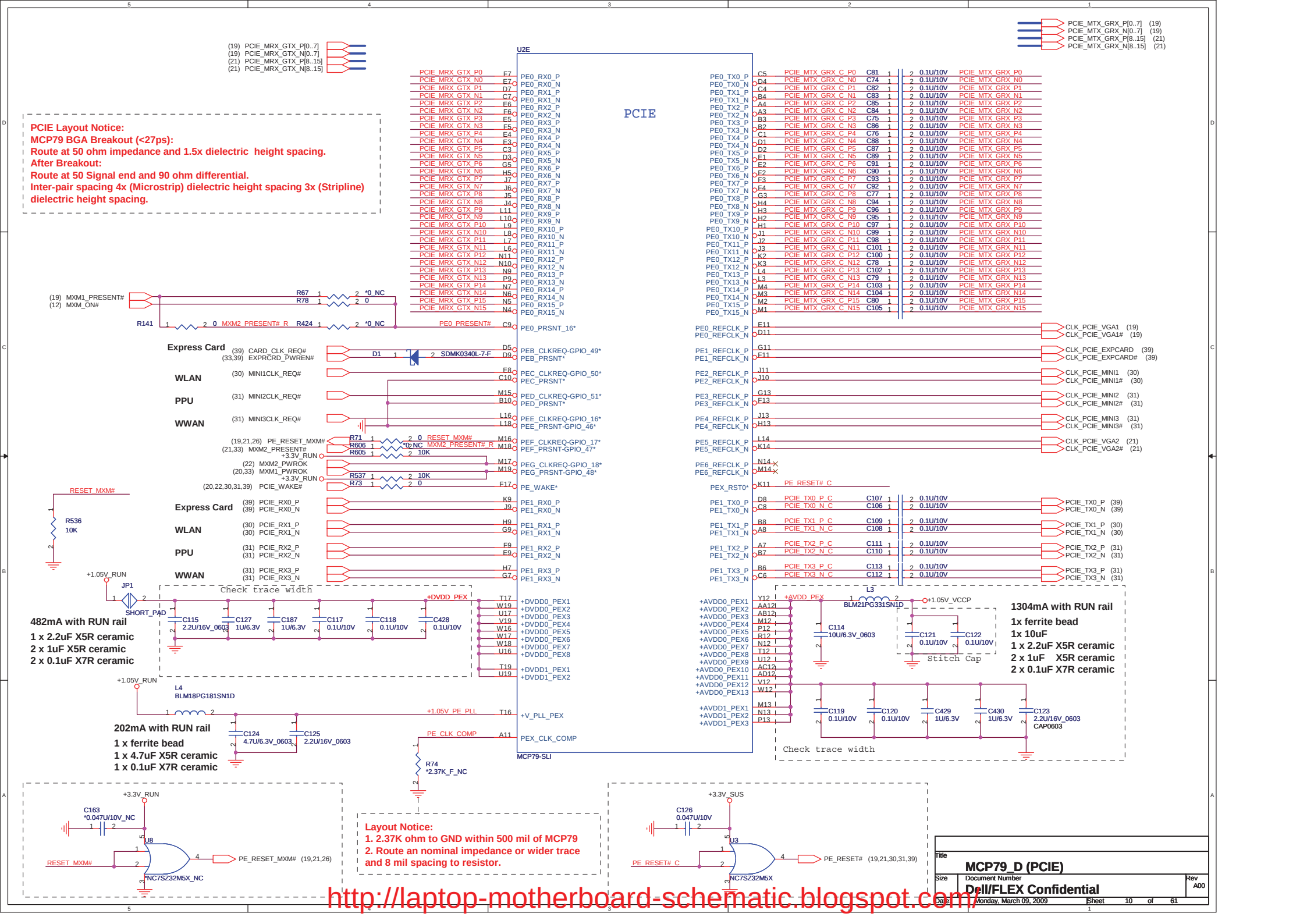

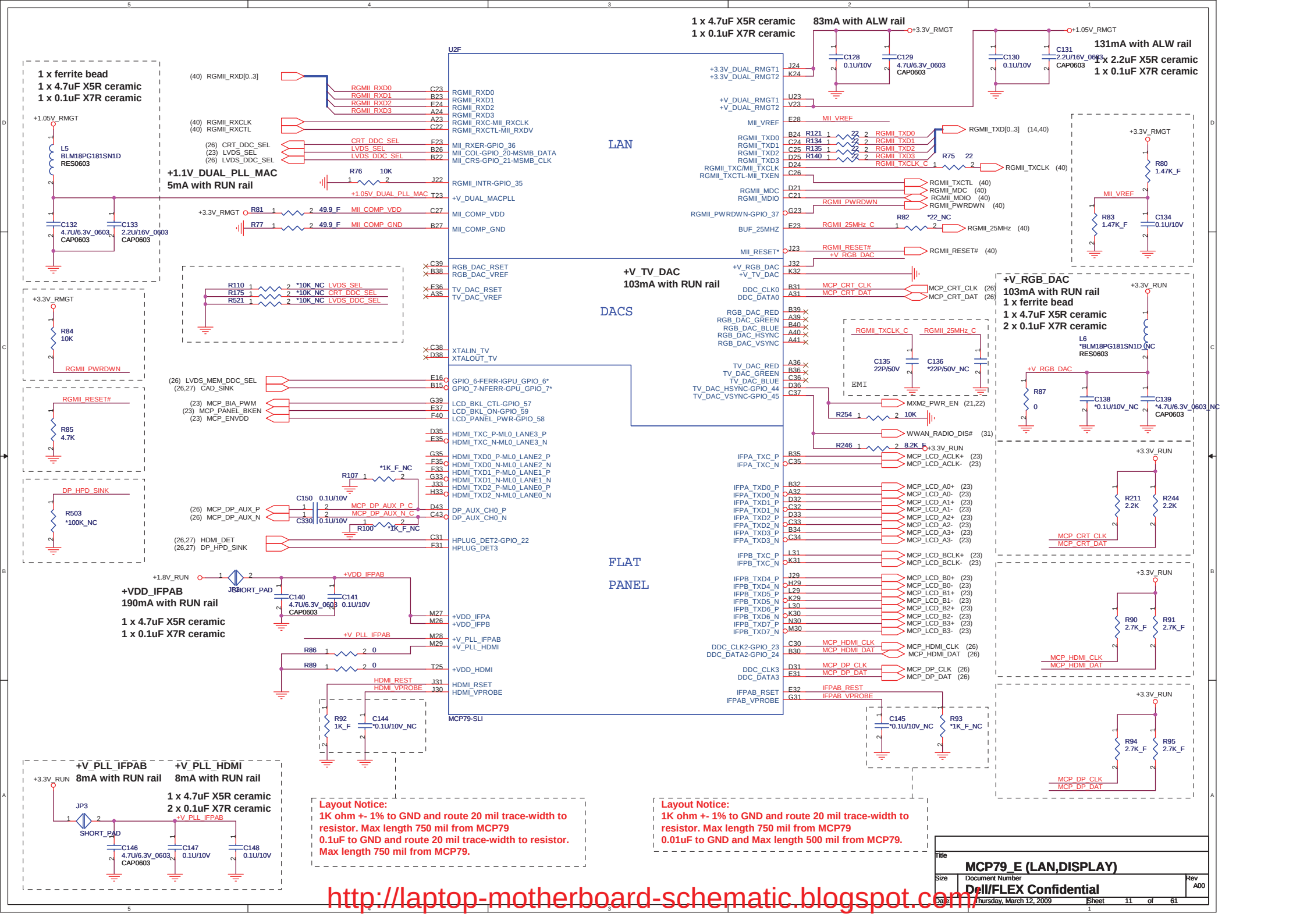

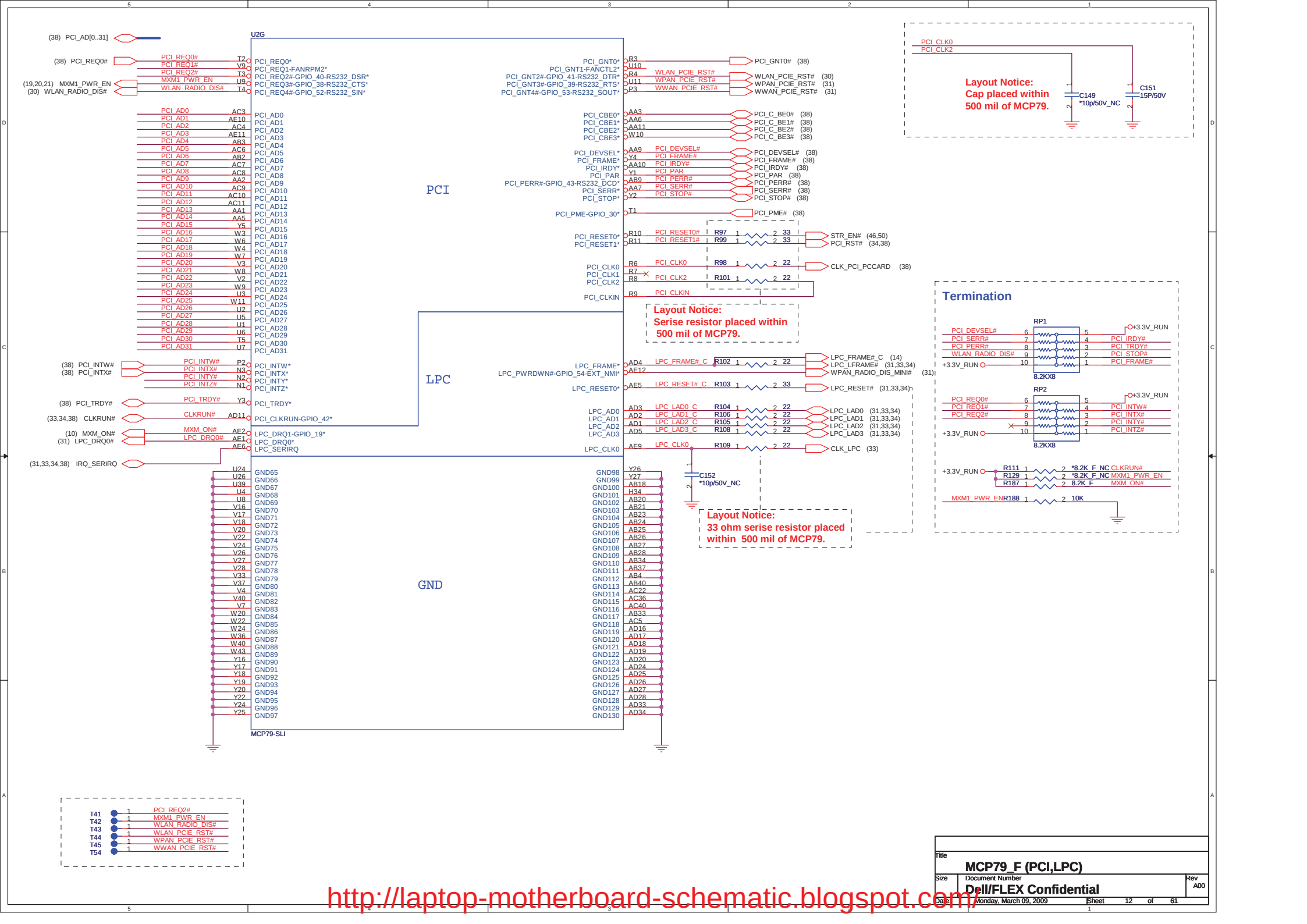

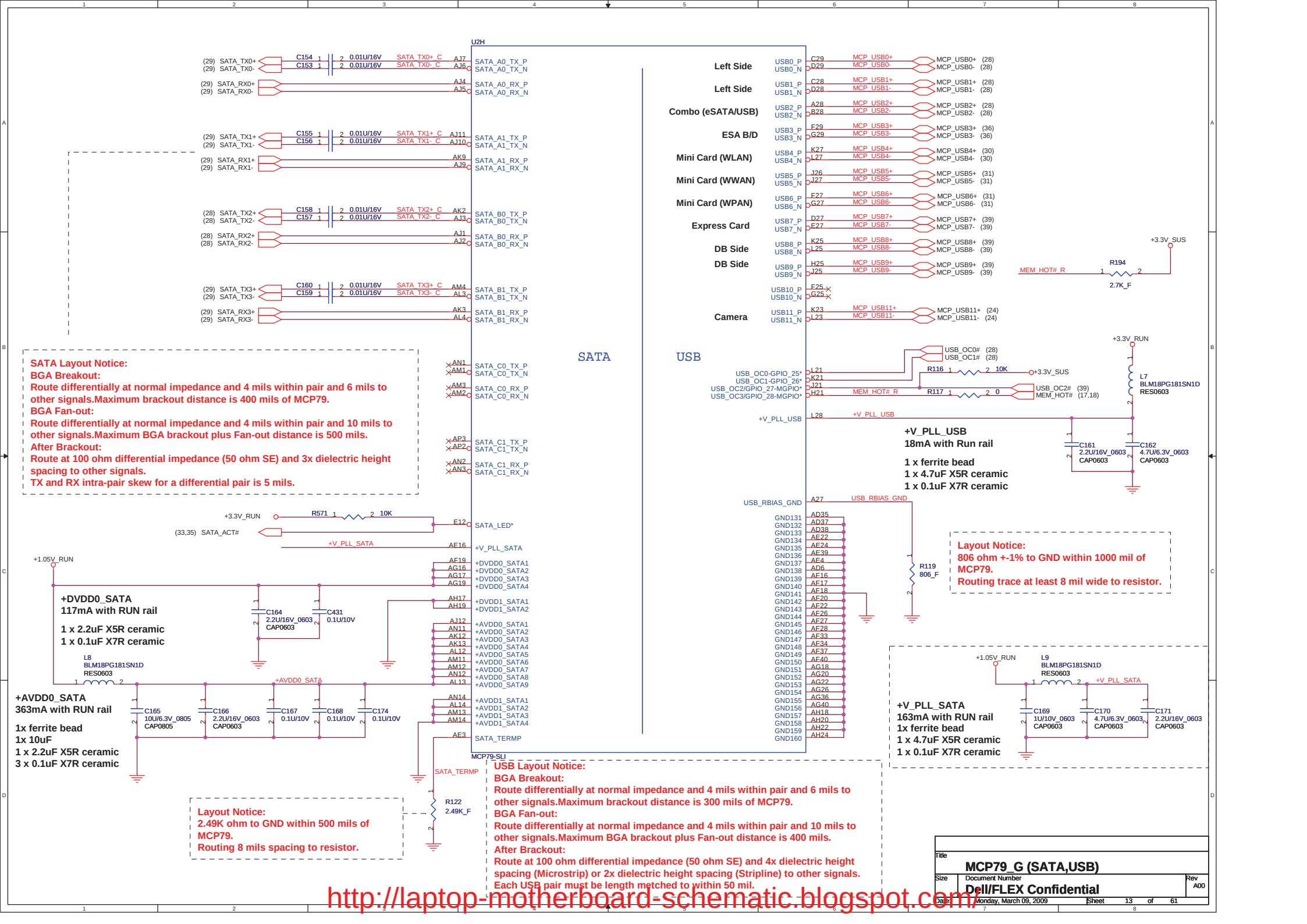

+V_DUAL_HDA 1 x 4.7uF X5R ceramic
7mA with ALW rail 2 x 0.1uF X7R ceramic

+V_PLL_NV_H
20mA with RUN rail
+V_PLL_SP_SPREF
17mA with RUN rail
1 x ferrite bead
1 x 4.7uF X5R ceramic
2 x 0.1uF X7R ceramic

U2I

HDA

MISC

MCP79-SLI

MCP79 Strapping

Boot BIOS Strapping

	HDA_SDATA_OUT	LPC_FRAME#
LPC BIOS	0	0
PCI BIOS	0	1
SPI BIOS(CS0)	1	0
SPI BIOS(CS1)	1	1

SIO Clock Select

	HDA_SYNC
14.318MHz	0
24MHz	1

SPI CLK Frequency Select

	SPI_DO	SPI_CLK
31MHz	0	0
41MHz	0	1
25MHz	1	0
1MHz	1	1

CLEAR CMOS ONLY

	RTC_RST#
CLEAR	0
NORMAL	1

Boot Mode Select

User Mode	0
Safe Mode	1

Networking Select

MII	0
RGMII	1

25MHz Clock

32KHz Clock

Layout Notice:
Place cystal within 1000 mil of MCP79.

Remember to connect to Power circuit

For MCP79 A01

Title: MCP79_H (HDA,MISC)
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17.756A with RUN rail for S0
2850mA for S0 Idle

1 x 10uF ceramic
2 x 2.2uF X5R ceramic
3 x 1uF X5R ceramic
3 x 0.22uF X5R ceramic
12 x 0.1uF X7R ceramic

+MCP_CORE

C190 10U/10V_0805 CAP0805
C191 2.2U/16V_0603 CAP0603
C192 1U/6.3V
C193 1U/6.3V
C194 1U/6.3V
C198 2.2U/16V_0603 CAP0603
C199 0.22U/10V
C200 0.22U/10V
C201 0.22U/10V
C203 0.1U/10V
C189 0.1U/10V
C205 0.1U/10V
C206 0.1U/10V
C207 0.1U/10V
C211 0.1U/10V
C212 0.1U/10V
C213 0.1U/10V
C215 0.1U/10V
C216 0.1U/10V
C434 0.1U/10V
C433 0.1U/10V
C438 0.1U/10V
C435 0.1U/10V
C437 0.1U/10V

U2J

PWR

+VDD_CORE1 +VDD_CORE2 +VDD_CORE3 +VDD_CORE4 +VDD_CORE5 +VDD_CORE6 +VDD_CORE7 +VDD_CORE8 +VDD_CORE9 +VDD_CORE10 +VDD_CORE11 +VDD_CORE12 +VDD_CORE13 +VDD_CORE14 +VDD_CORE15 +VDD_CORE16 +VDD_CORE17 +VDD_CORE18 +VDD_CORE19 +VDD_CORE20 +VDD_CORE21 +VDD_CORE22 +VDD_CORE23 +VDD_CORE24 +VDD_CORE25 +VDD_CORE26 +VDD_CORE27 +VDD_CORE28 +VDD_CORE29 +VDD_CORE30 +VDD_CORE31 +VDD_CORE32 +VDD_CORE33 +VDD_CORE34 +VDD_CORE35 +VDD_CORE36 +VDD_CORE37 +VDD_CORE38 +VDD_CORE39 +VDD_CORE40 +VDD_CORE41 +VDD_CORE42 +VDD_CORE43 +VDD_CORE44 +VDD_CORE45 +VDD_CORE46 +VDD_CORE47 +VDD_CORE48 +VDD_CORE49 +VDD_CORE50 +VDD_CORE51 +VDD_CORE52 +VDD_CORE53 +VDD_CORE54 +VDD_CORE55 +VDD_CORE56 +VDD_CORE57 +VDD_CORE58 +VDD_CORE59 +VDD_CORE60 +VDD_CORE61 +VDD_CORE62 +VDD_CORE63 +VDD_CORE64 +VDD_CORE65 +VDD_CORE66 +VDD_CORE67 +VDD_CORE68 +VDD_CORE69 +VDD_CORE70 +VDD_CORE71 +VDD_CORE72 +VDD_CORE73 +VDD_CORE74 +VDD_CORE75 +VDD_CORE76 +VDD_CORE77 +VDD_CORE78 +VDD_CORE79 +VDD_CORE80 +VDD_CORE81

+VTT_CPU
1139mA for ALW rail

+VTT_CPUCLK
43mA for ALW rail

1 x 10uF ceramic
1 x 2.2uF X5R ceramic
3 x 0.1uF X7R ceramic

+1.05V_VCCP

C195 0.1U/10V
C196 2.2U/16V_0603 CAP0603
C197 10U/10V_0805 CAP0805
C202 0.1U/10V
C208 0.1U/10V
C209 0.1U/10V
C210 0.1U/10V
C218 0.1U/10V
C219 0.1U/10V
C314 0.1U/10V
C422 0.1U/10V
C423 0.1U/10V

+3.3V_RUN_MCP
450mA with RUN rail

1 x 4.7uF X5R ceramic
4 x 0.1uF X7R ceramic

JP5 SHORT_PAD
C220 0.1U/10V
C221 0.1U/10V
C222 0.1U/10V
C223 0.1U/10V
C224 4.7U/6.3V_0603 CAP0603

+3.3V_DUAL
16mA with ALW rail

JP6 SHORT_PAD
C225 0.1U/10V
C226 4.7U/6.3V_0603 CAP0603

1 x 4.7uF X5R ceramic
1 x 0.1uF X7R ceramic

+3.3V_DUAL_USB
450mA with ALW rail

+VDD_AUXC
105mA with ALW rail

JP7 SHORT_PAD
C230 0.1U/10V
C231 0.1U/10V

2 x 0.1uF X7R ceramic

These are for backdrive issue.

+3.3V_RUN
R165 2.7K_F
R166 2.7K_F
(14) MCP_SMB_SCL_R
MCP_SMB_SCL
MCP_SMB_SCL (30,31,39)
Q6 2N7002W-7-F
(14) MCP_SMB_SDA_R
MCP_SMB_SDA
MCP_SMB_SDA (30,31,39)
Q7 2N7002W-7-F

HDCP

U4 *AT24C16BN-SH-T_NC
R167 *10K_NC
R168 *10K_NC
R169 *10K_NC
C232 *0.1U/10V_NC
MCP_SMB_SDA
MCP_SMB_SCL

+RTC_CELL
C227 4.7U/6.3V_0603
C228 4.7U/6.3V_0603
C229 0.1U/10V
+VBAT

0.06mA with ALW rail for S0
2 x 4.7uF X5R ceramic
1 X 0.1uF X7R ceramc

Title: MCP79_I (POWER)
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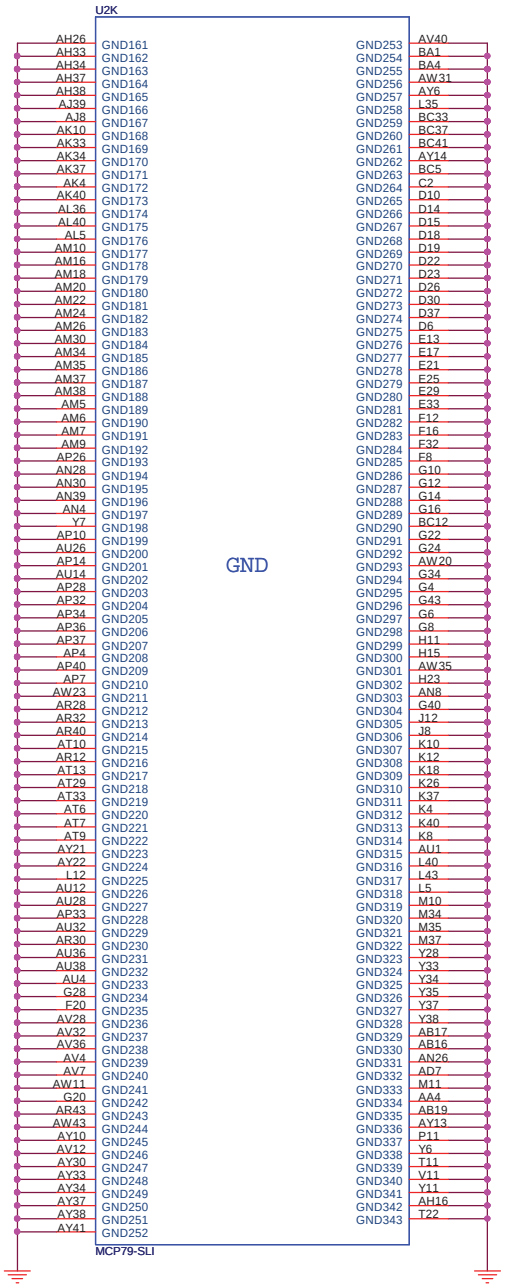

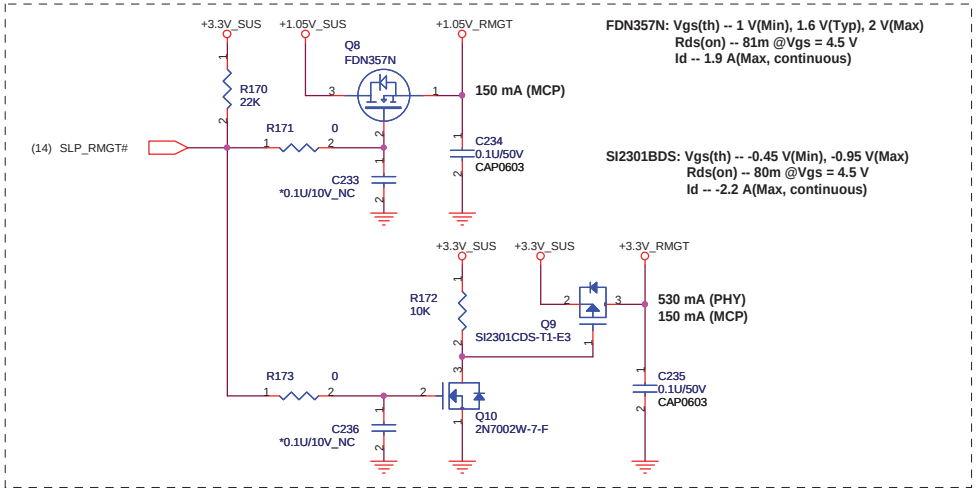

Title	MCP79_J (GND)	
Size	Document Number: Dell/FLEX Confidential	Rev: A00
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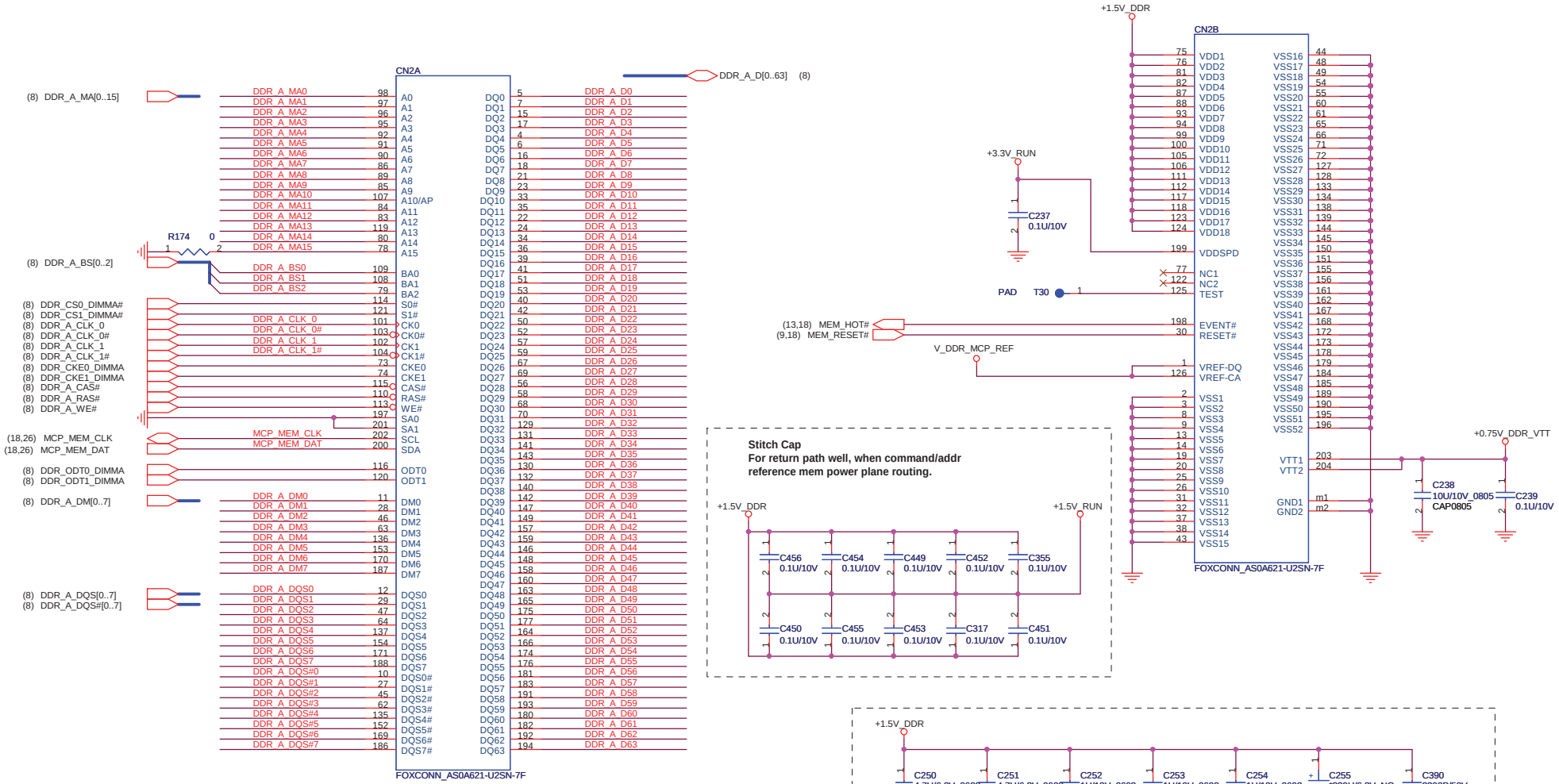

3/21 Neo: Update symbol.

SM_MEM BUS ADDRESS	
SO-DIMM0	1010 000
SO-DIMM1	1010 001

Title	DDR3 SO-DIMM1(204P)		
Size	Document Number		Rev A00
	Dell/FLEX Confidential		
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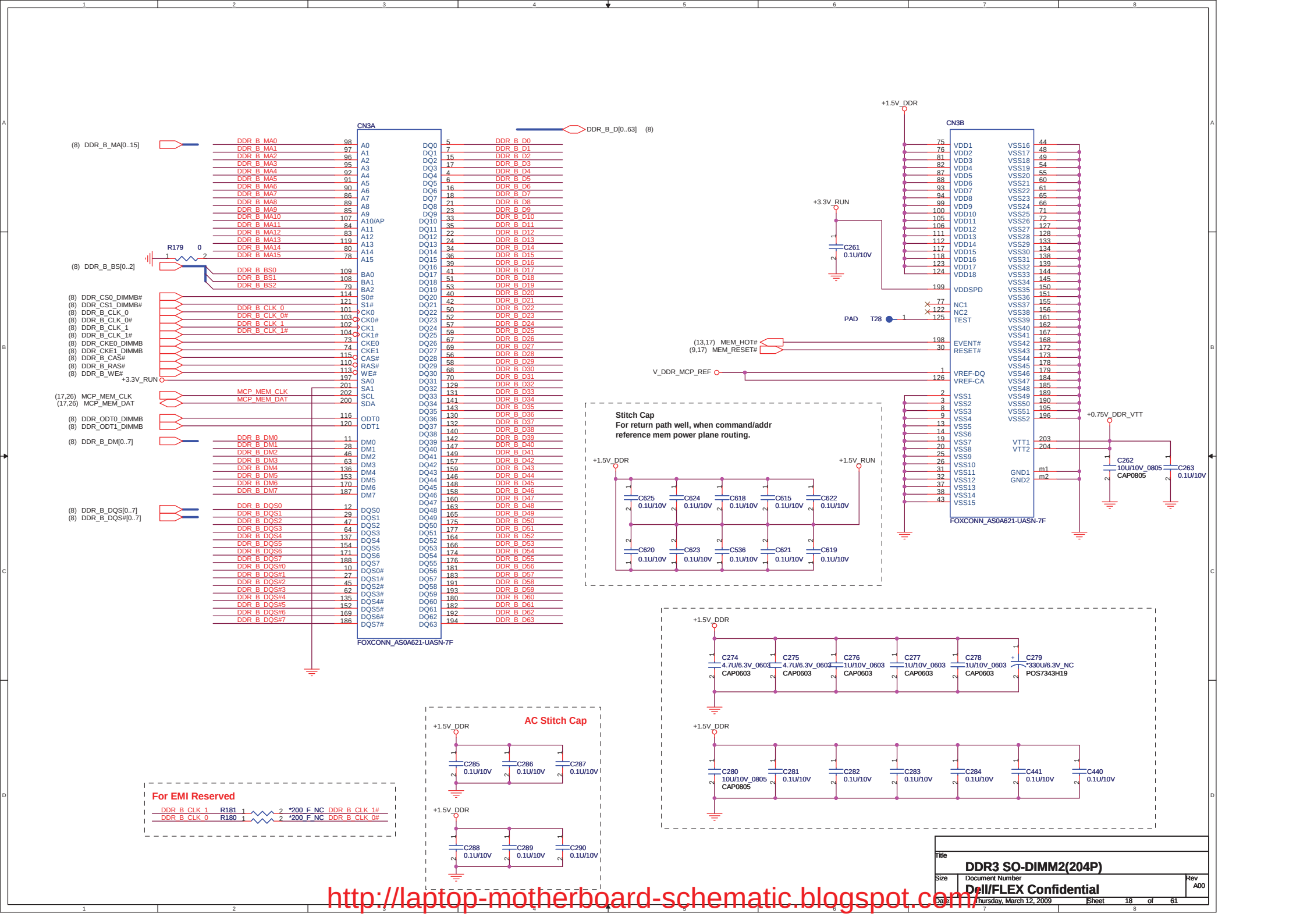
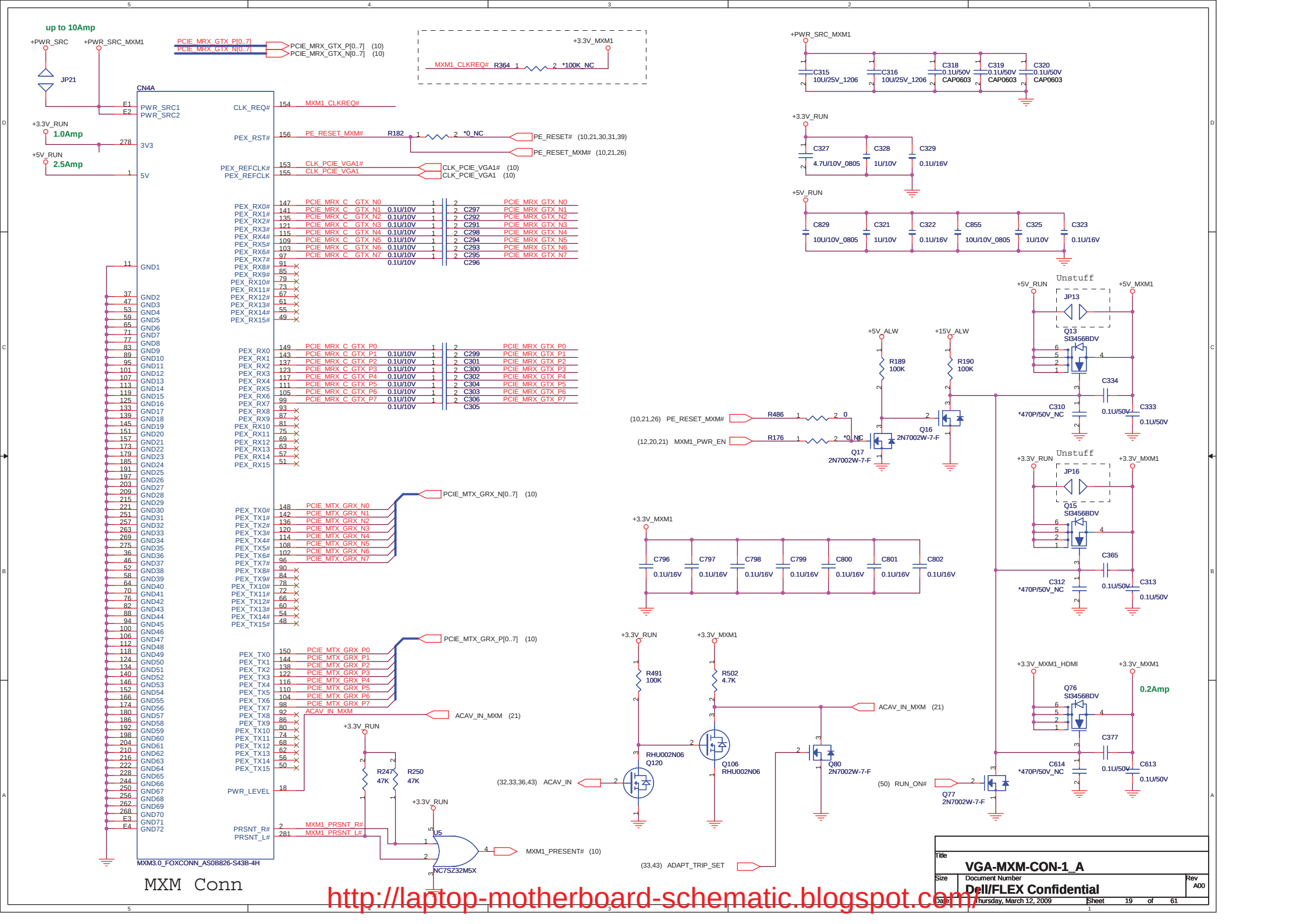
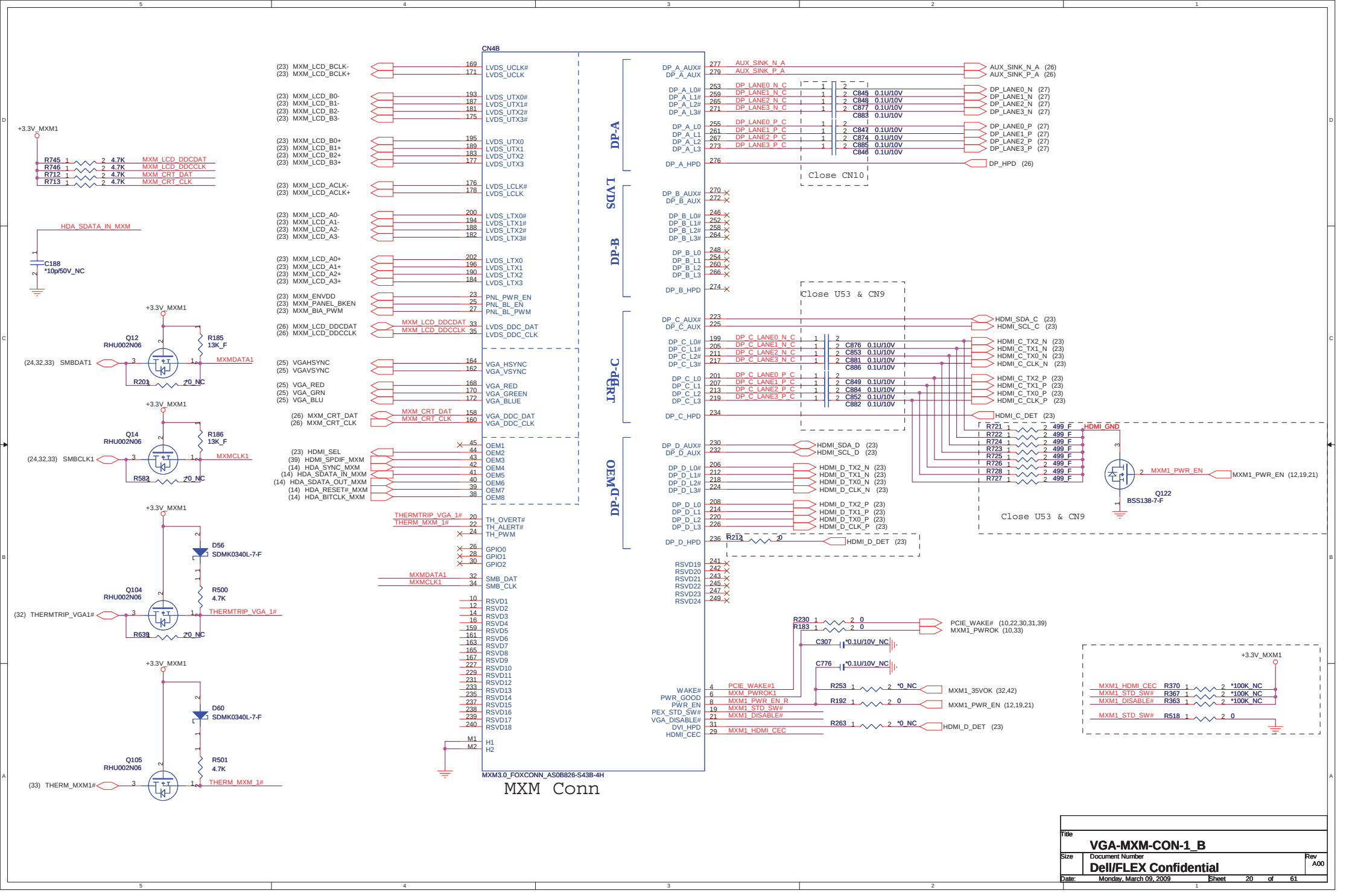
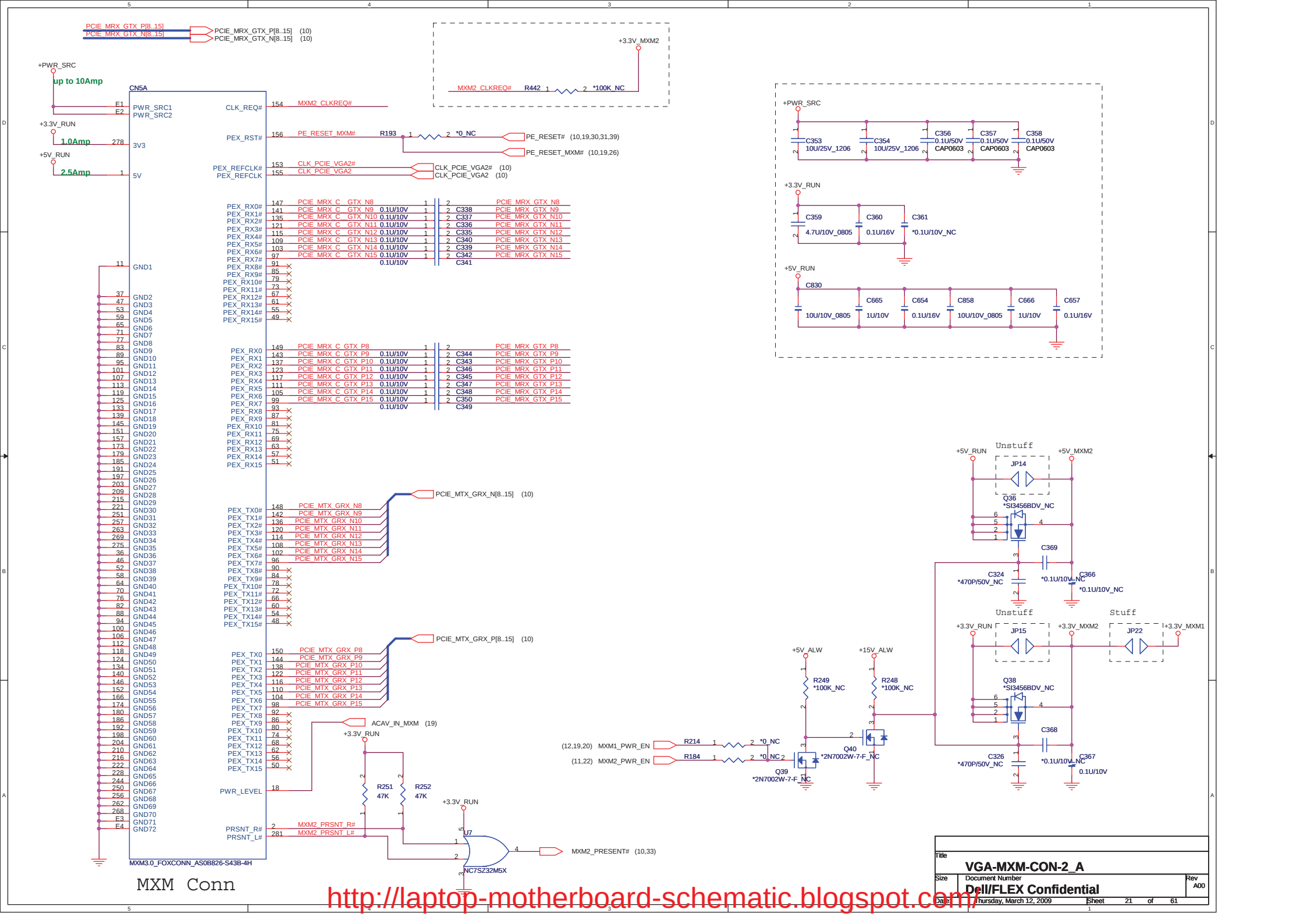
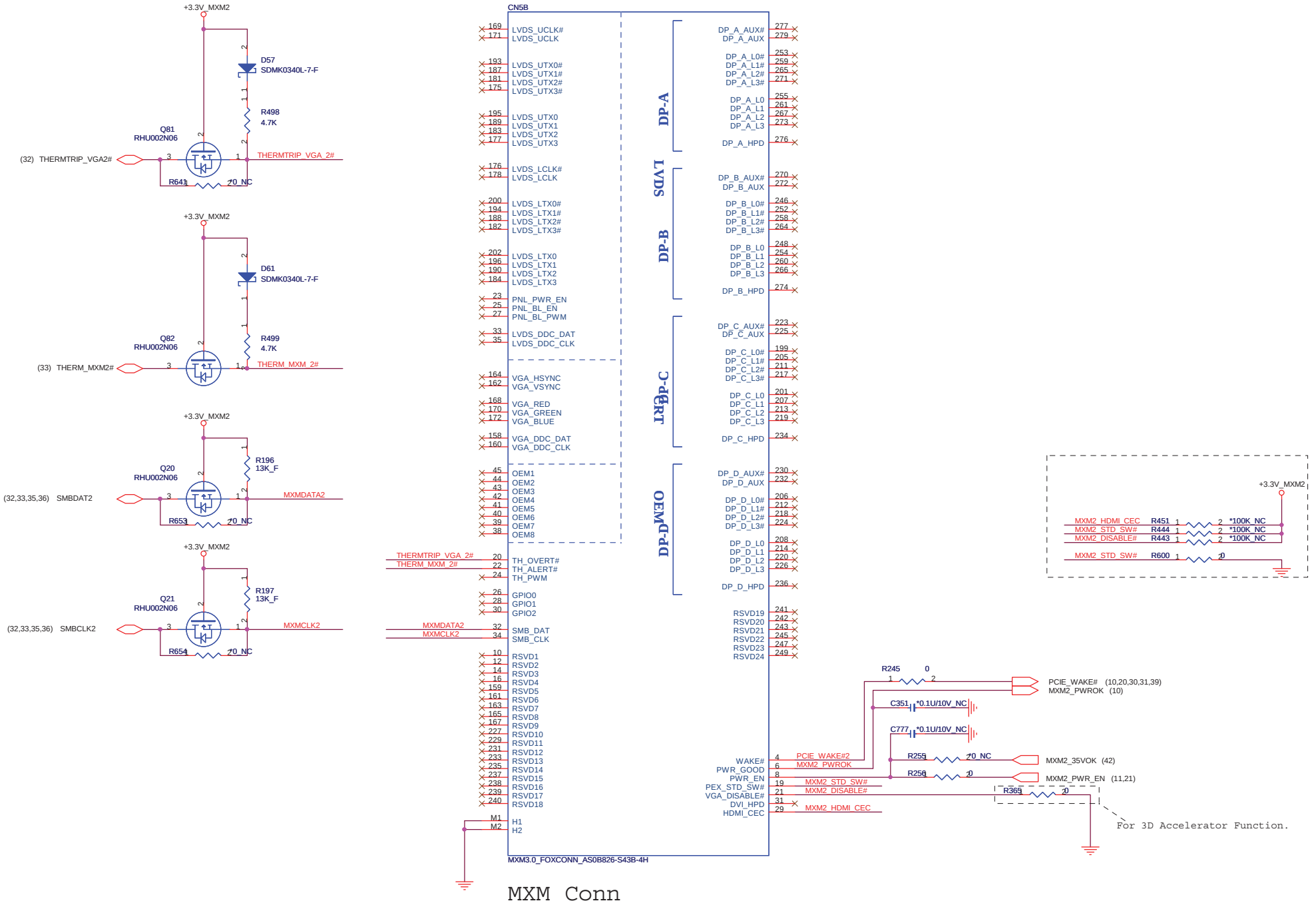

CN3A
FOXCONN_AS0A621-UASN-7F
CN3B
FOXCONN_AS0A621-UASN-7F
Stitch Cap
For return path well, when command/addr reference mem power plane routing.
AC Stitch Cap
For EMI Reserved
DDR3 SO-DIMM2(204P)
Dell/FLEX Confidential
Thursday, March 12, 2009
http://laptop-motherboard-schematic.blogspot.com/






PCIE_MRX_GTX_P[8..15]
PCIE_MRX_GTX_N[8..15]
PCIE_MRX_GTX_P[8..15] (10)
PCIE_MRX_GTX_N[8..15] (10)
+3.3V_MXM2
MXM2_CLKREQ# R442 1 2 *100K_NC
+PWR_SRC
up to 10Amp
+3.3V_RUN
1.0Amp
+5V_RUN
2.5Amp
CN5A
PWR_SRC1
PWR_SRC2
3V3
5V
CLK_REQ#
PEX_RST#
PEX_REFCLK#
PEX_REFCLK
MXM2_CLKREQ#
PE_RESET_MXM# R193 1 2 *0_NC
PE_RESET# (10,19,30,31,39)
PE_RESET_MXM# (10,19,26)
CLK_PCIE_VGA2#
CLK_PCIE_VGA2
CLK_PCIE_VGA2# (10)
CLK_PCIE_VGA2 (10)
PEX_RX0# PEX_RX1# PEX_RX2# PEX_RX3# PEX_RX4# PEX_RX5# PEX_RX6# PEX_RX7# PEX_RX8# PEX_RX9# PEX_RX10# PEX_RX11# PEX_RX12# PEX_RX13# PEX_RX14# PEX_RX15#
PCIE_MRX_C_GTX_N8 PCIE_MRX_C_GTX_N9 PCIE_MRX_C_GTX_N10 PCIE_MRX_C_GTX_N11 PCIE_MRX_C_GTX_N12 PCIE_MRX_C_GTX_N13 PCIE_MRX_C_GTX_N14 PCIE_MRX_C_GTX_N15
0.1U/10V
C338 C337 C336 C335 C340 C339 C342 C341
PCIE_MRX_GTX_N8 PCIE_MRX_GTX_N9 PCIE_MRX_GTX_N10 PCIE_MRX_GTX_N11 PCIE_MRX_GTX_N12 PCIE_MRX_GTX_N13 PCIE_MRX_GTX_N14 PCIE_MRX_GTX_N15
PEX_RX0 PEX_RX1 PEX_RX2 PEX_RX3 PEX_RX4 PEX_RX5 PEX_RX6 PEX_RX7 PEX_RX8 PEX_RX9 PEX_RX10 PEX_RX11 PEX_RX12 PEX_RX13 PEX_RX14 PEX_RX15
PCIE_MRX_C_GTX_P8 PCIE_MRX_C_GTX_P9 PCIE_MRX_C_GTX_P10 PCIE_MRX_C_GTX_P11 PCIE_MRX_C_GTX_P12 PCIE_MRX_C_GTX_P13 PCIE_MRX_C_GTX_P14 PCIE_MRX_C_GTX_P15
0.1U/10V
C344 C343 C346 C345 C347 C348 C350 C349
PCIE_MRX_GTX_P8 PCIE_MRX_GTX_P9 PCIE_MRX_GTX_P10 PCIE_MRX_GTX_P11 PCIE_MRX_GTX_P12 PCIE_MRX_GTX_P13 PCIE_MRX_GTX_P14 PCIE_MRX_GTX_P15
PEX_TX0# PEX_TX1# PEX_TX2# PEX_TX3# PEX_TX4# PEX_TX5# PEX_TX6# PEX_TX7# PEX_TX8# PEX_TX9# PEX_TX10# PEX_TX11# PEX_TX12# PEX_TX13# PEX_TX14# PEX_TX15#
PCIE_MTX_GRX_N8 PCIE_MTX_GRX_N9 PCIE_MTX_GRX_N10 PCIE_MTX_GRX_N11 PCIE_MTX_GRX_N12 PCIE_MTX_GRX_N13 PCIE_MTX_GRX_N14 PCIE_MTX_GRX_N15
PCIE_MTX_GRX_N[8..15] (10)
PEX_TX0 PEX_TX1 PEX_TX2 PEX_TX3 PEX_TX4 PEX_TX5 PEX_TX6 PEX_TX7 PEX_TX8 PEX_TX9 PEX_TX10 PEX_TX11 PEX_TX12 PEX_TX13 PEX_TX14 PEX_TX15
PCIE_MTX_GRX_P8 PCIE_MTX_GRX_P9 PCIE_MTX_GRX_P10 PCIE_MTX_GRX_P11 PCIE_MTX_GRX_P12 PCIE_MTX_GRX_P13 PCIE_MTX_GRX_P14 PCIE_MTX_GRX_P15
PCIE_MTX_GRX_P[8..15] (10)
ACAV_IN_MXM (19)
+3.3V_RUN
PWR_LEVEL
R251 47K
R252 47K
PRSNT_R#
PRSNT_L#
MXM2_PRSNT_R#
MXM2_PRSNT_L#
+3.3V_RUN
U7
NC7SZ32M5X
MXM2_PRESENT# (10,33)
GND1 GND2 GND3 GND4 GND5 GND6 GND7 GND8 GND9 GND10 GND11 GND12 GND13 GND14 GND15 GND16 GND17 GND18 GND19 GND20 GND21 GND22 GND23 GND24 GND25 GND26 GND27 GND28 GND29 GND30 GND31 GND32 GND33 GND34 GND35 GND36 GND37 GND38 GND39 GND40 GND41 GND42 GND43 GND44 GND45 GND46 GND47 GND48 GND49 GND50 GND51 GND52 GND53 GND54 GND55 GND56 GND57 GND58 GND59 GND60 GND61 GND62 GND63 GND64 GND65 GND66 GND67 GND68 GND69 GND70 GND71 GND72
MXM3.0_FOXCONN_AS0B826-S43B-4H
MXM Conn
+PWR_SRC
C353 10U/25V_1206
C354 10U/25V_1206
C356 0.1U/50V CAP0603
C357 0.1U/50V CAP0603
C358 0.1U/50V CAP0603
+3.3V_RUN
C359 4.7U/10V_0805
C360 0.1U/16V
C361 *0.1U/10V_NC
+5V_RUN
C830 10U/10V_0805
C665 1U/10V
C654 0.1U/16V
C858 10U/10V_0805
C666 1U/10V
C657 0.1U/16V
+5V_RUN
Unstuff
+5V_MXM2
JP14
Q36 *SI3456BDV_NC
C369
C324 *470P/50V_NC
C366 *0.1U/10V_NC
Unstuff
Stuff
+3.3V_RUN
JP15
+3.3V_MXM2
JP22
+3.3V_MXM1
Q38 *SI3456BDV_NC
C368
C326 *470P/50V_NC
C367 *0.1U/10V_NC
0.1U/10V
+5V_ALW
+15V_ALW
R249 *100K_NC
R248 *100K_NC
(12,19,20) MXM1_PWR_EN
(11,22) MXM2_PWR_EN
R214 1 2 *0_NC
R184 1 2 *0_NC
Q40 *2N7002W-7-F_NC
Q39 *2N7002W-7-F_NC
Title
VGA-MXM-CON-2_A
Size
Document Number
Dell/FLEX Confidential
Rev A00
Date: Thursday, March 12, 2009
Sheet 21 of 61
http://laptop-motherboard-schematic.blogspot.com/



MXM Conn

Title	VGA-MXM-CON-2_B
Size	Document Number: Dell/FLEX Confidential
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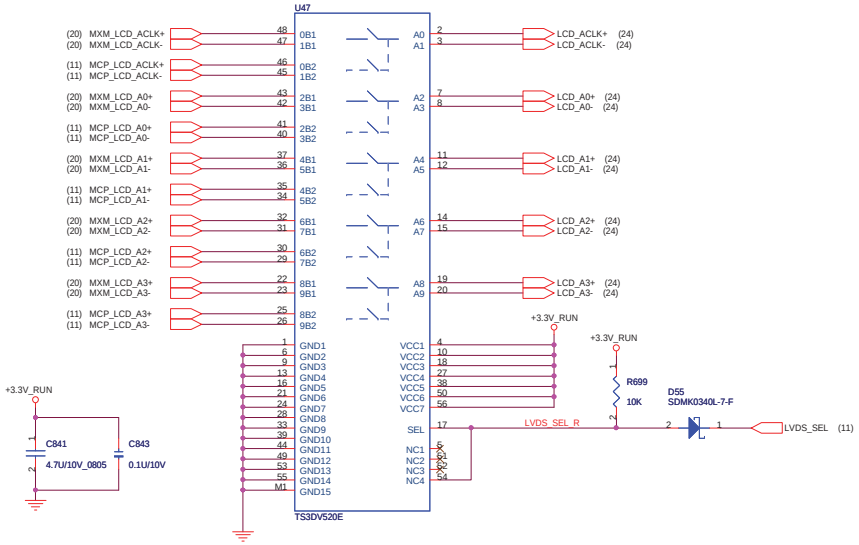
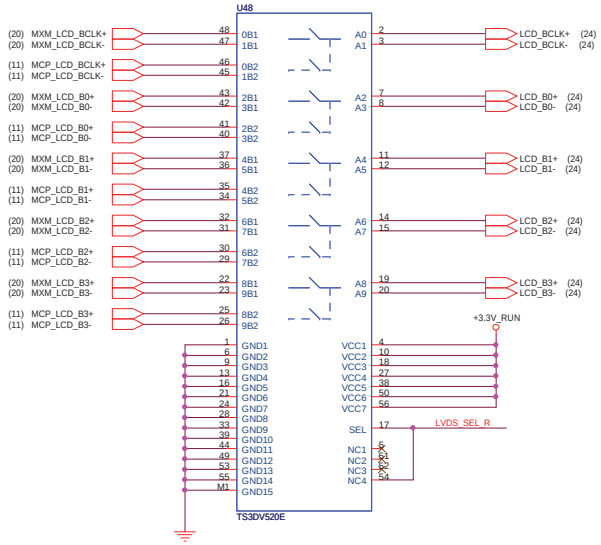
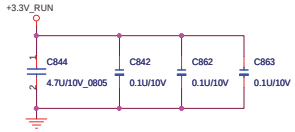
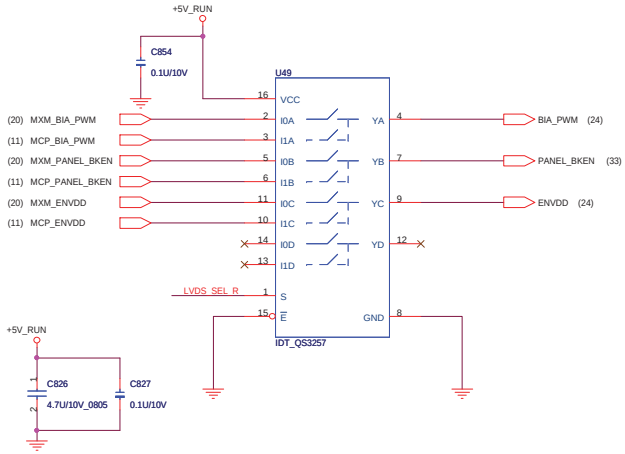






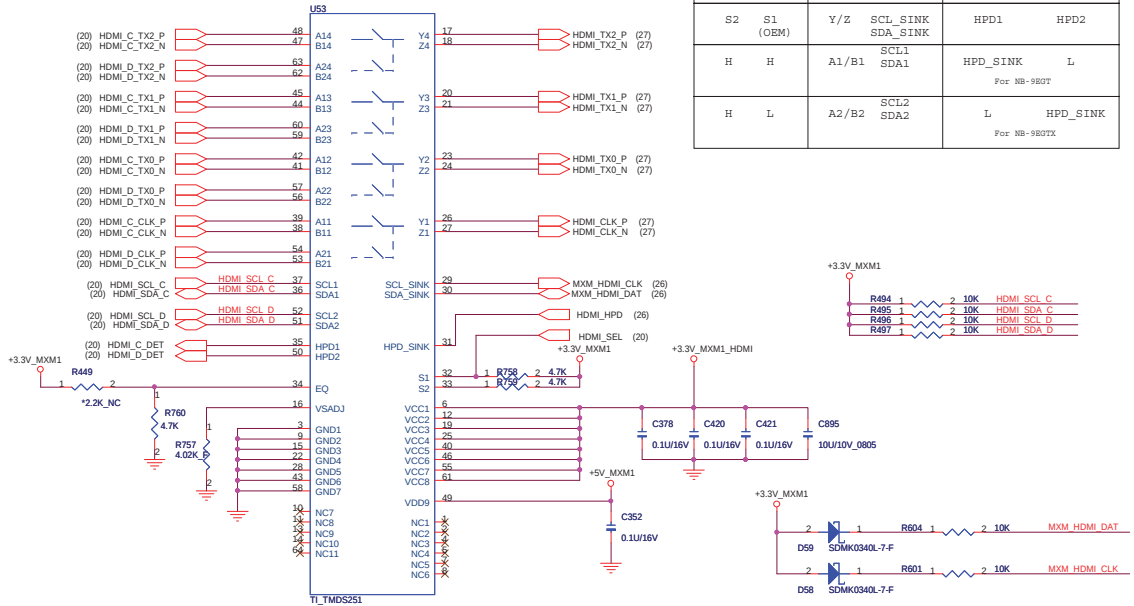
MCP_LVDS_SEL	LVDS SOURCE
L	MXM
H	MCP



HDMI PORT C&D MUX

Close CN9

CONTROL BITS		I/O SELECTED	HOT PLUG DETECT STATUS	
S2	S1 (OEM)	Y/Z SCL_SINK SDA_SINK	HPD1	HPD2
H	H	A1/B1 SCL1 SDA1	HPD_SINK For NB-9EGT	L
H	L	A2/B2 SCL2 SDA2	L For NB-9EGTX	HPD_SINK



Title: LVDS/ HDMI SELECTION
Size: Document Number: Dell/FLEX Confidential
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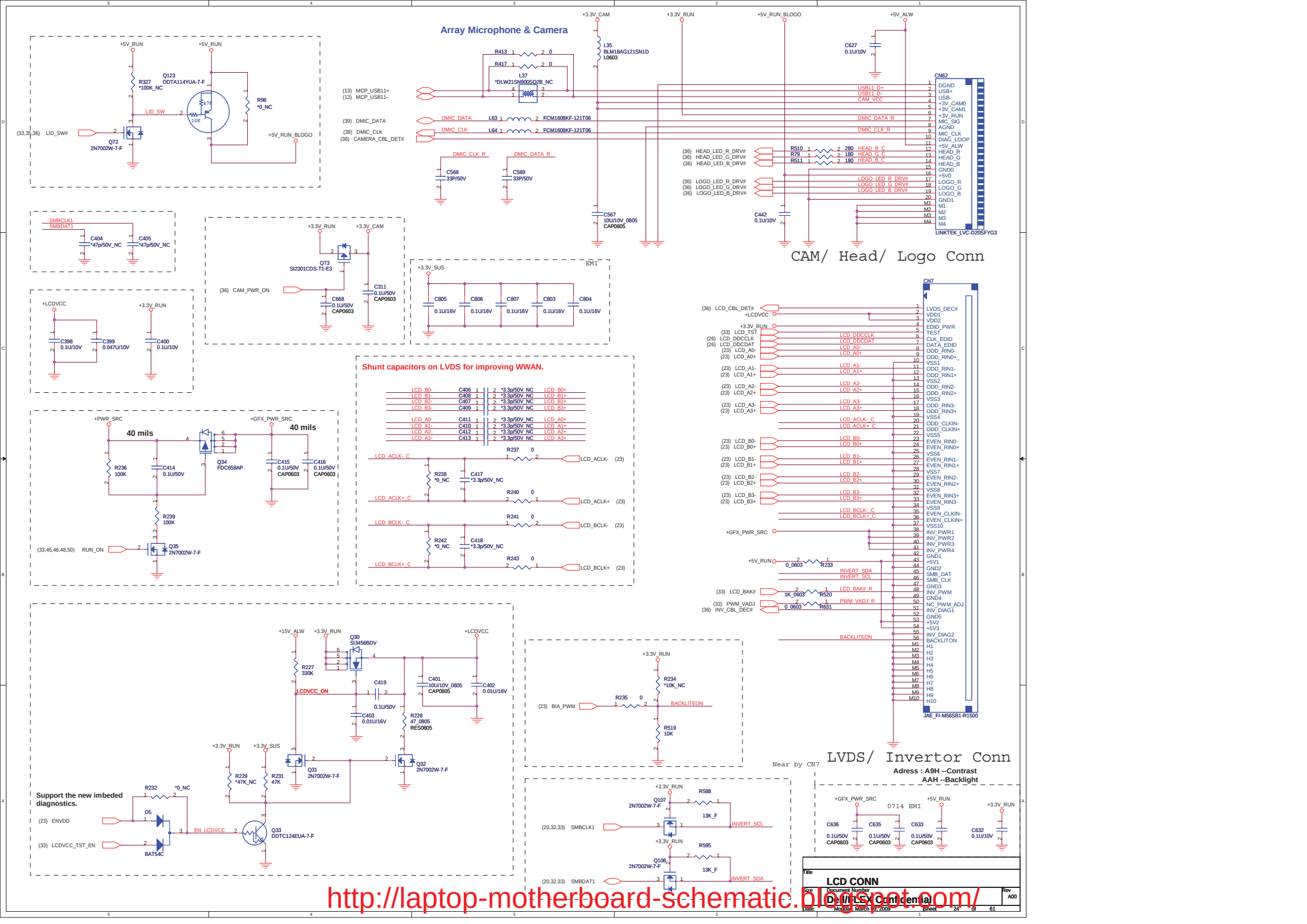
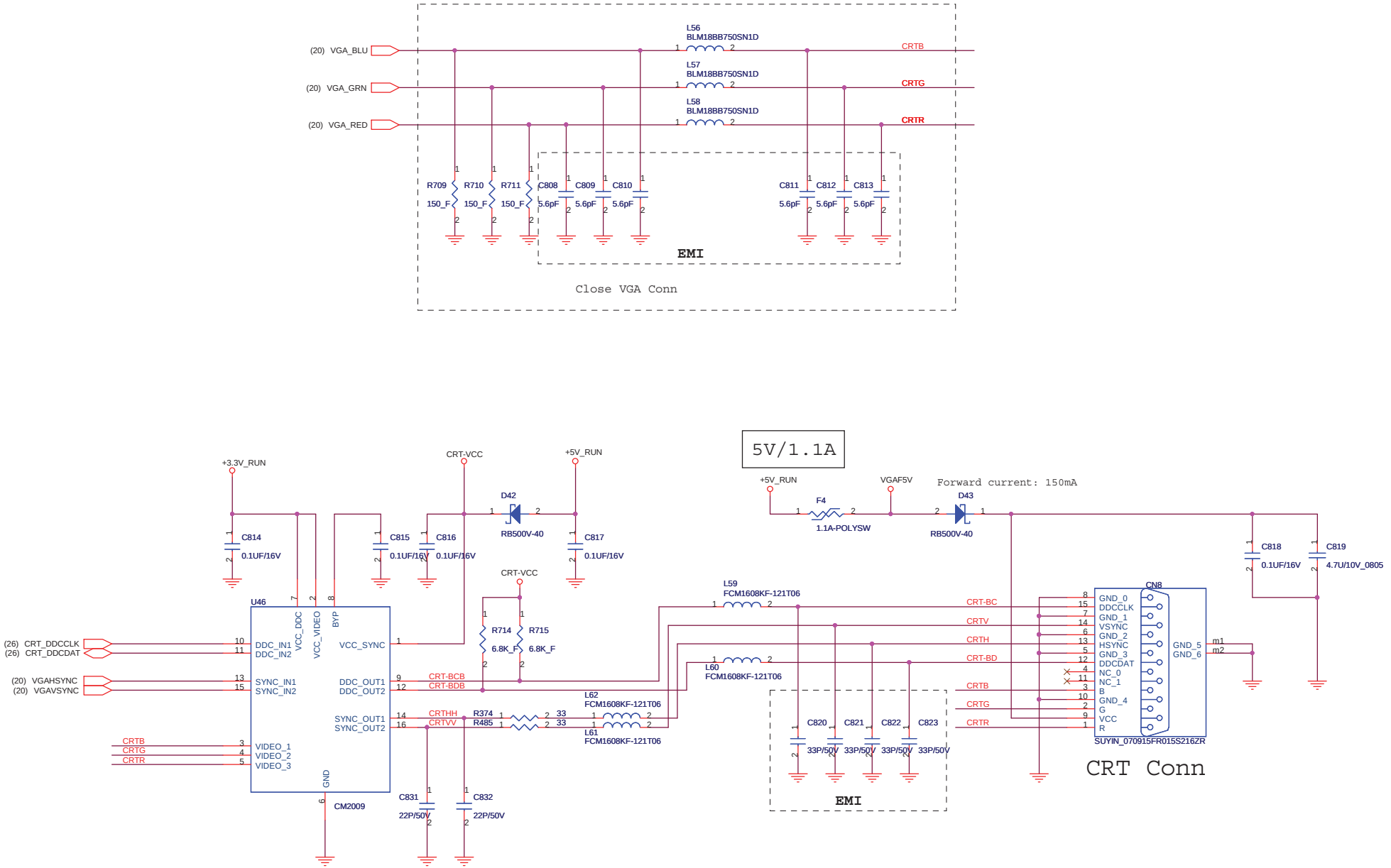

Array Microphone & Camera
CAM/ Head/ Logo Conn
LVDS/ Invertor Conn
Shunt capacitors on LVDS for improving WWAN.
Support the new imbeded diagnostics.
Near by CN7
Adress : A9H --Contrast
AAH --Backlight
LCD CONN
Dell/Intel Confidential
http://laptop-motherboard-schematic.blogspot.com/



Title	CRT CONN	
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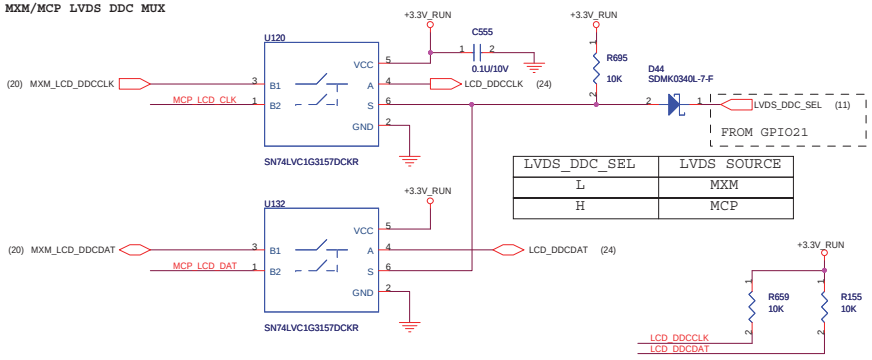
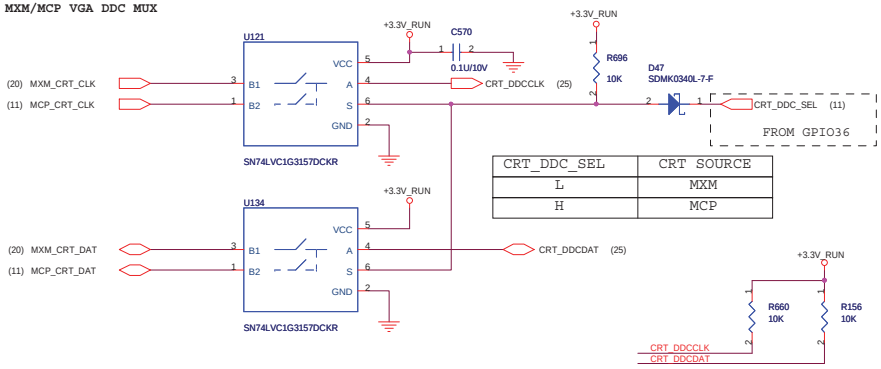
MXM/MCP LVDS DDC MUX



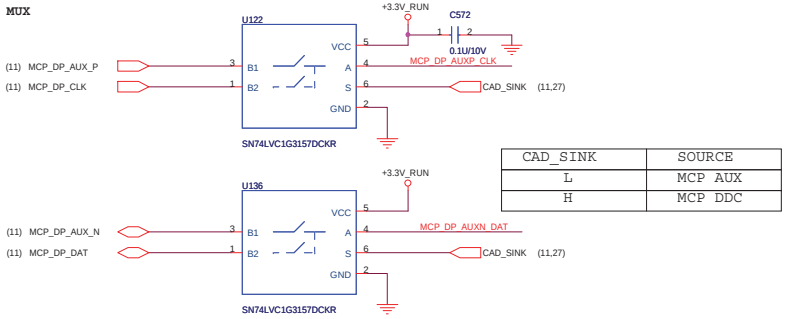
LVDS_DDC_SEL	LVDS SOURCE
L	MXM
H	MCP

MXM/MCP VGA DDC MUX



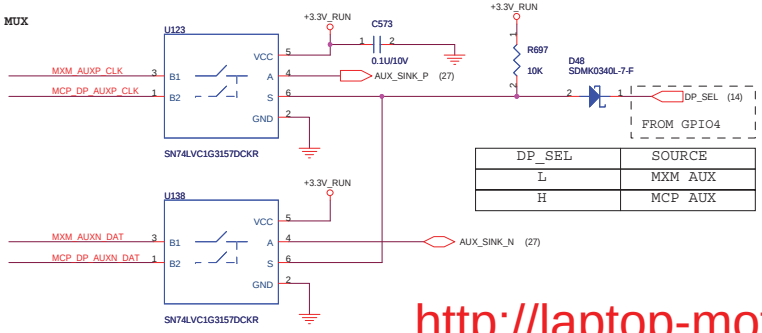
CRT_DDC_SEL	CRT SOURCE
L	MXM
H	MCP

MCP AUX/DDC MUX



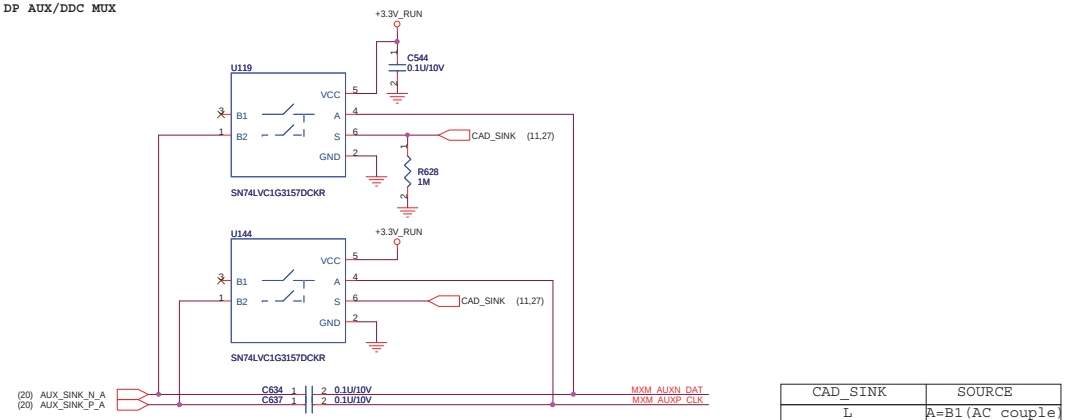
CAD_SINK	SOURCE
L	MCP AUX
H	MCP DDC

MXM/MCP DP AUX MUX



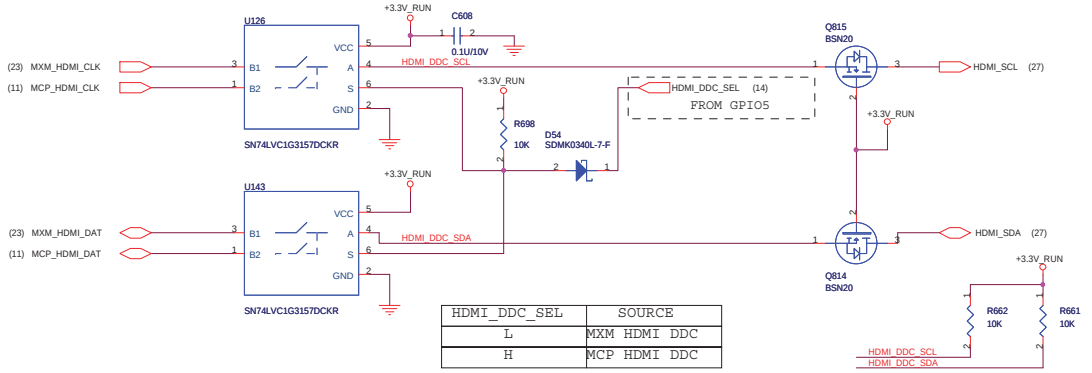
DP_SEL	SOURCE
L	MXM AUX
H	MCP AUX

MXM DP AUX/DDC MUX



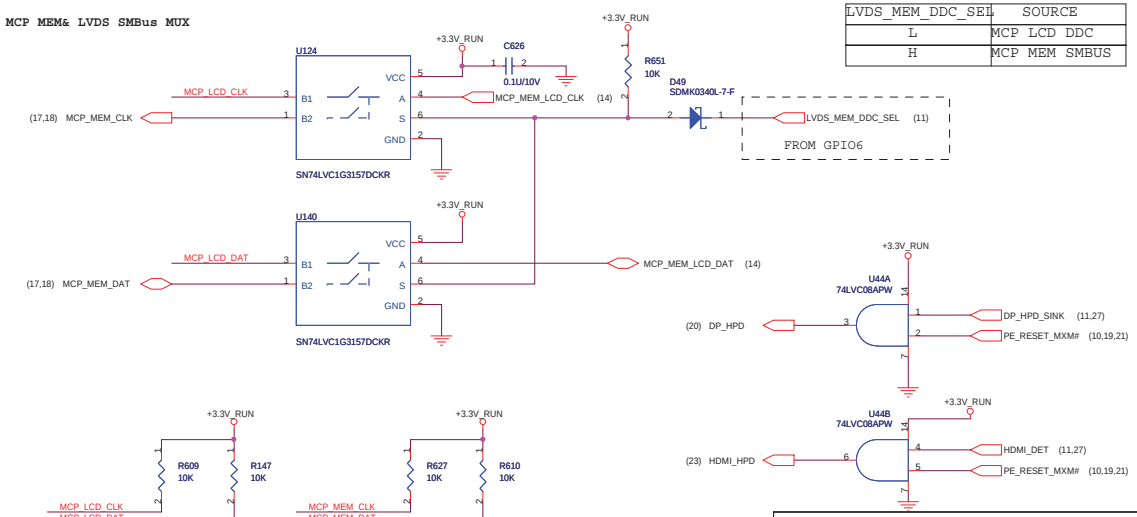
CAD_SINK	SOURCE
L	A=B1(AC couple)
H	A=B2 (DDC)

MXM/MCP HDMI DDC MUX



HDMI_DDC_SEL	SOURCE
L	MXM HDMI DDC
H	MCP HDMI DDC

MCP MEM& LVDS SMBus MUX



LVDS_MEM_DDC_SEL	SOURCE
L	MCP LCD DDC
H	MCP MEM SMBUS

Title: **MXM& MCP DDC/ AUX MUX**

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Reserve For EMI

(23) HDMI_CLK_P
(23) HDMI_CLK_N
HDMI_CLK_P
HDMI_CLK_N
L18
*DLW21SN900SQ2B_NC
HDMI_CLK_P_C
HDMI_CLK_N_C
R277 0
R279 0

(23) HDMI_TX0_P
(23) HDMI_TX0_N
HDMI_TX0_P
HDMI_TX0_N
L19
*DLW21SN900SQ2B_NC
HDMI_TX0_P_C
HDMI_TX0_N_C
R278 0
R282 0

(23) HDMI_TX1_P
(23) HDMI_TX1_N
HDMI_TX1_P
HDMI_TX1_N
L20
*DLW21SN900SQ2B_NC
HDMI_TX1_P_C
HDMI_TX1_N_C
R283 0
R285 0

(23) HDMI_TX2_P
(23) HDMI_TX2_N
HDMI_TX2_P
HDMI_TX2_N
L21
*DLW21SN900SQ2B_NC
HDMI_TX2_P_C
HDMI_TX2_N_C
R286 0
R287 0

Reserve For EMI

(20) DP_LANE3_N
(20) DP_LANE3_P
DP_LANE3_N
DP_LANE3_P
L22
*DLW21SN900SQ2B_NC
DP_LANE3_N_R
DP_LANE3_P_R
R288 0
R289 0

(20) DP_LANE2_N
(20) DP_LANE2_P
DP_LANE2_N
DP_LANE2_P
L23
*DLW21SN900SQ2B_NC
DP_LANE2_N_R
DP_LANE2_P_R
R291 0
R290 0

(20) DP_LANE1_N
(20) DP_LANE1_P
DP_LANE1_N
DP_LANE1_P
L24
*DLW21SN900SQ2B_NC
DP_LANE1_N_R
DP_LANE1_P_R
R292 0
R293 0

(20) DP_LANE0_N
(20) DP_LANE0_P
DP_LANE0_N
DP_LANE0_P
L25
*DLW21SN900SQ2B_NC
DP_LANE0_N_R
DP_LANE0_P_R
R294 0
R295 0

(26) AUX_SINK_N
(26) AUX_SINK_P
AUX_SINK_N
AUX_SINK_P
L26
*DLW21SN900SQ2B_NC
AUX_SINK_N_R
AUX_SINK_P_R
R296 0
R297 0

HDMI CONNECTOR

+5V_RUN
+5V_RUN
D21 RB500V-40
D15 RB500V-40
R280 2.2K
R281 2.2K
T35 PAD
T36 PAD
(26) HDMI_SCL
(26) HDMI_SDA
HDMI_SCL
HDMI_SDA
HDMI_CEC
(11,26) HDMI_DET
VGAF5V
HDMI_DET
R63 1K
L11 BLM18PG181SN1D
R284 100K
C427 100p/50V
D16 RB500V-40
C432 180p/50V
C839 0.1U/10V
CN9
HDMI_TX2_P_C
HDMI_TX2_N_C
HDMI_TX1_P_C
HDMI_TX1_N_C
HDMI_TX0_P_C
HDMI_TX0_N_C
HDMI_CLK_P_C
HDMI_CLK_N_C
D2+
D2_Shield
D2-
D1+
D1_Shield
D1-
D0+
D0_Shield
D0-
CK+
CK_Shield
CK-
CE_Remote
NC
DDC_CLK
DDC_DATA
GND
+5V
HP_DET
M1 M2 M3 M4
TYCO_1-1775040-8

EMI1
YSD-48425A-025

DISPLAY PORT CONNECTOR

+3.3V_DP_PWR1
R191 100K
AUX_SINK_N_R
AUX_SINK_P_R
R200 100K
(11,26) DP_HPD_SINK
R65 1K
L12 BLM18PG181SN1D
D33 RB500V-40
R513 100K
C611 *100p/50V_NC
C612 220P/50V
+3.3V_RUN
+3.3V_DP_PWR1
F5 1.1A-POLYSW
R549 0_0603
D17 *RB500V-40_NC
C840 0.1U/10V
+3.3V_DP_PWR
CN10
HPD
AUXN
AUXP
LANE3N
LANE3P
LANE2N
LANE2P
LANE1N
LANE1P
LANE0N
LANE0P
PWR
PWR_RET
GND1
GND2
MODE
GND3
GND4
GND5
GND6
H1 H2 H3 H4
M1 M2 M3 M4
MOLEX_47272-0001
CAD_SINK (11,26)

Title: HDMI & DP CONN
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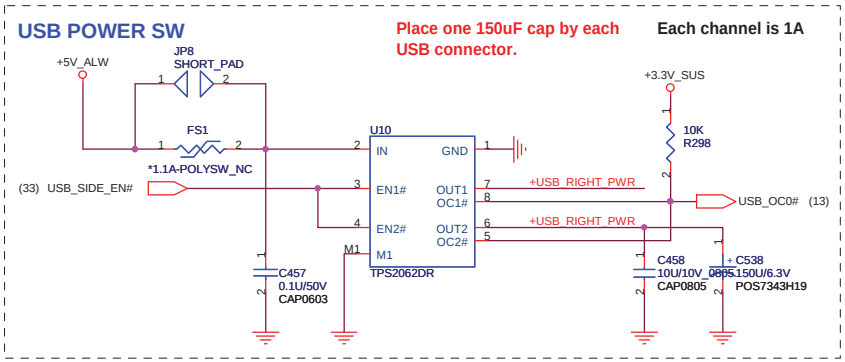

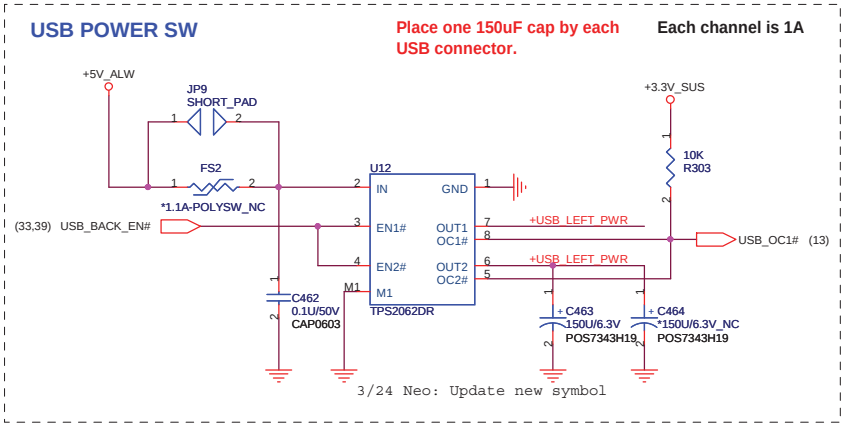

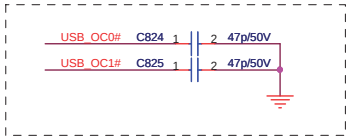

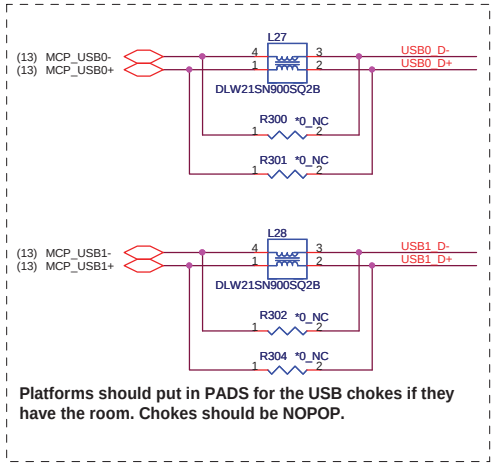

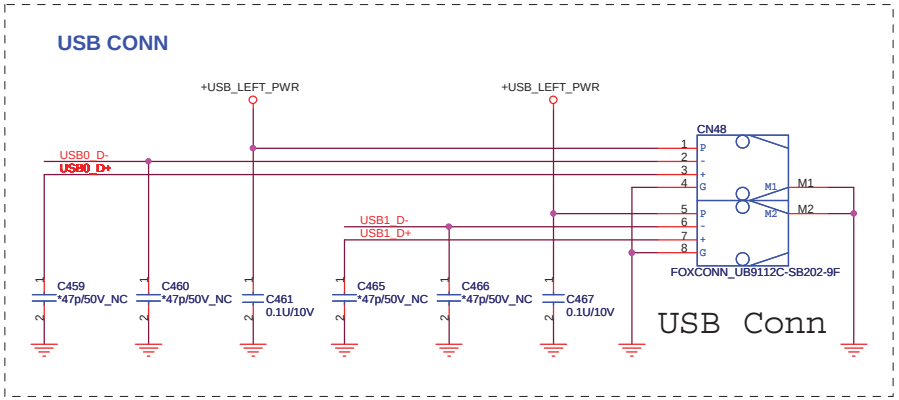

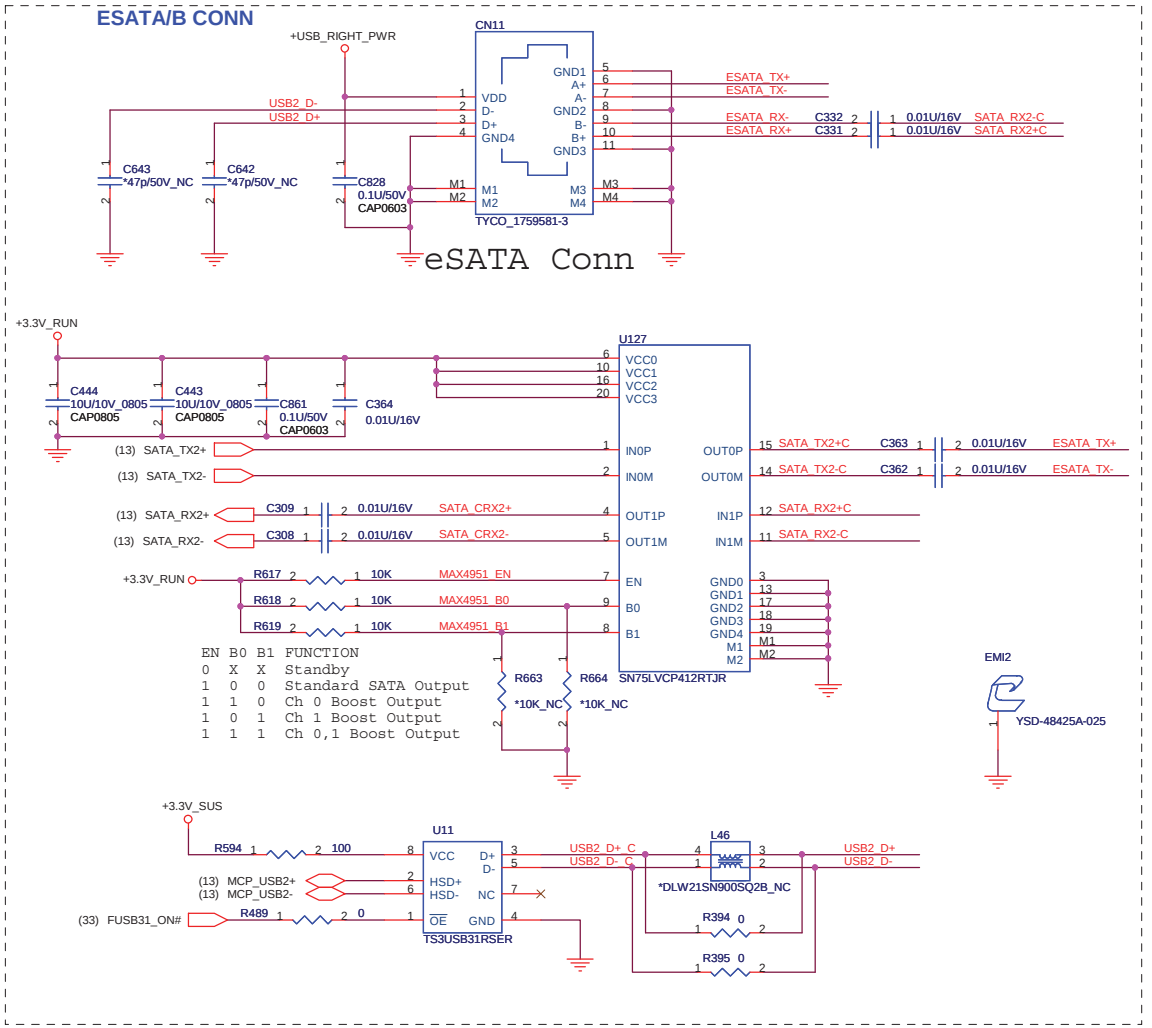

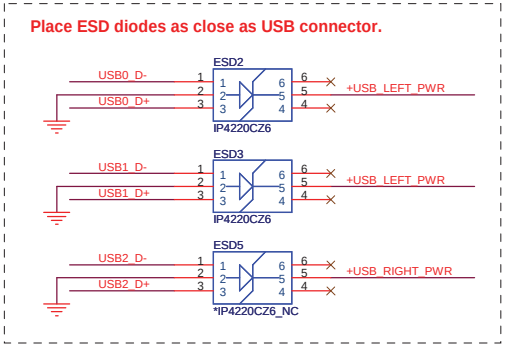

Title: USBx2 & eSATA
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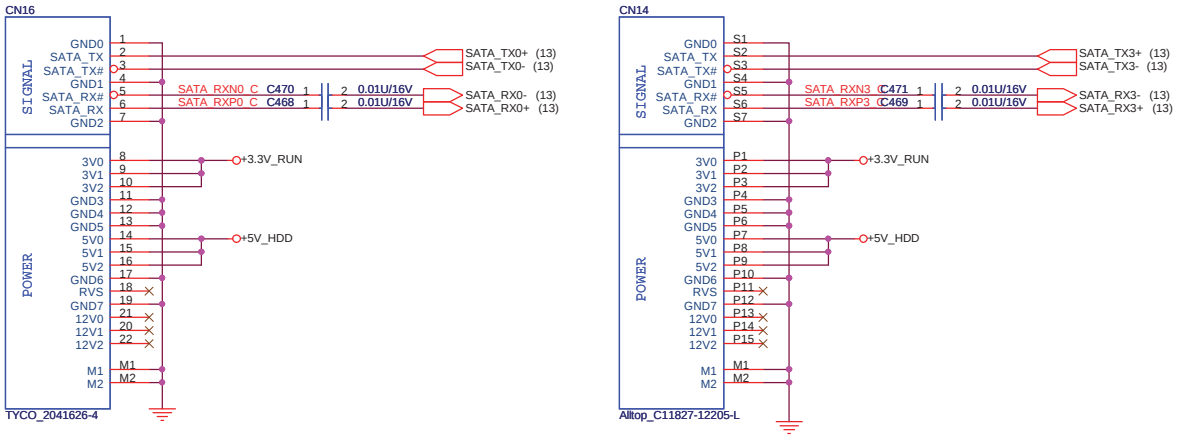
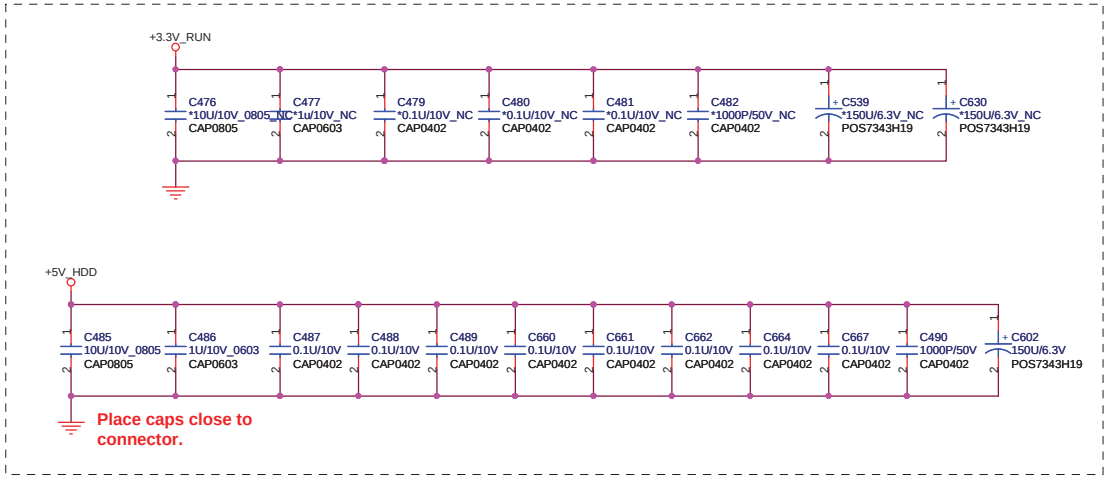
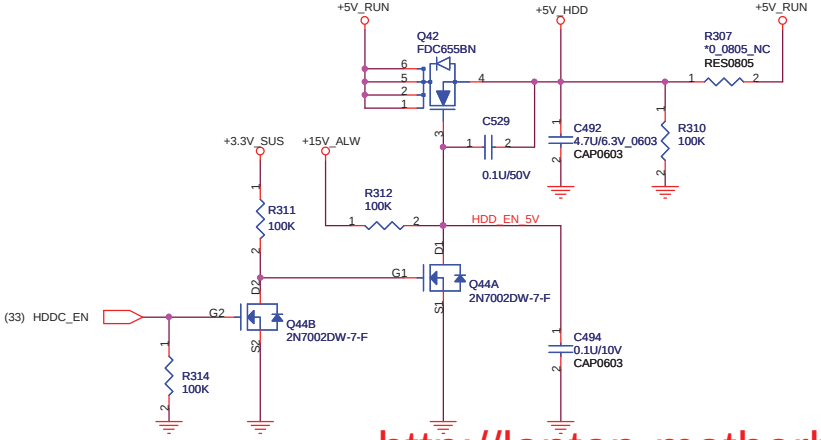
SATA Connector



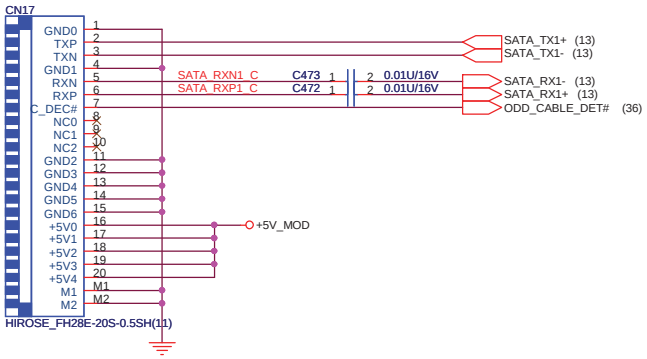
Master HDD Conn

Slave HDD Conn

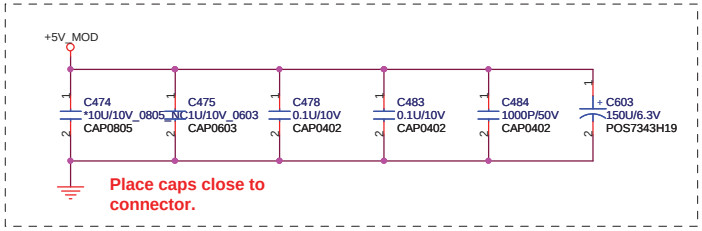


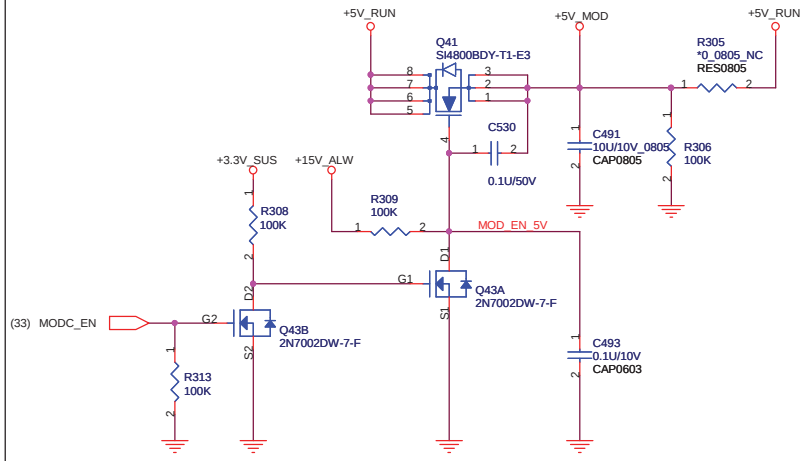


ODD Connector



ODD Conn





Title	HDDx2 & CD ROM	
Size	Document Number: Dell/FLEX Confidential	Rev: A00
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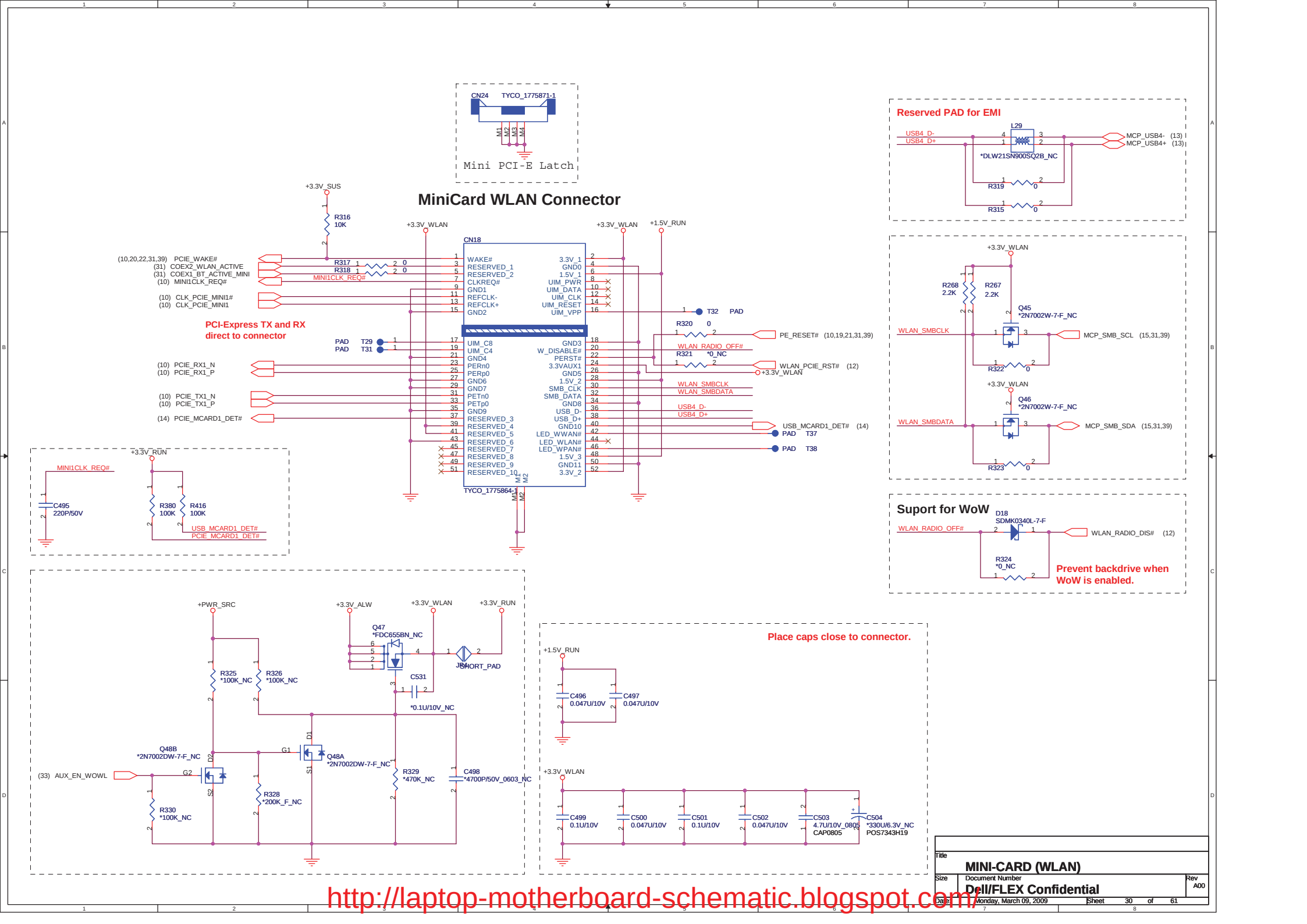
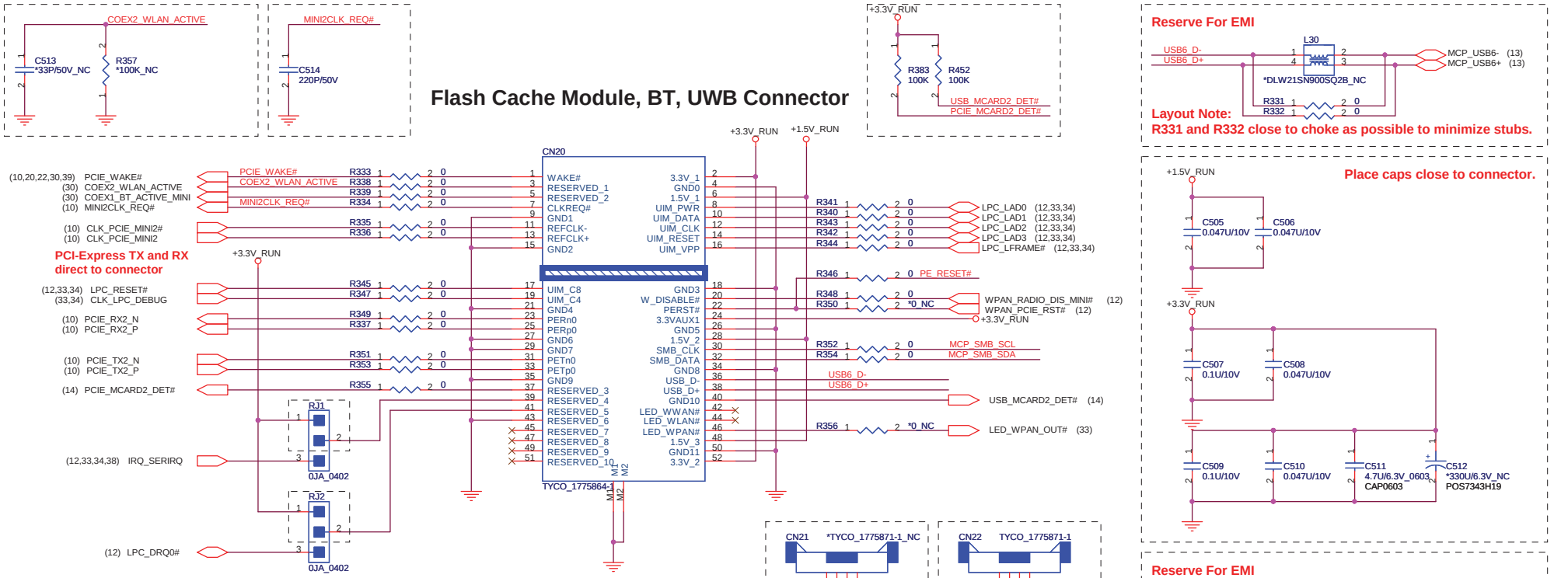


Flash Cache Module, BT, UWB Connector

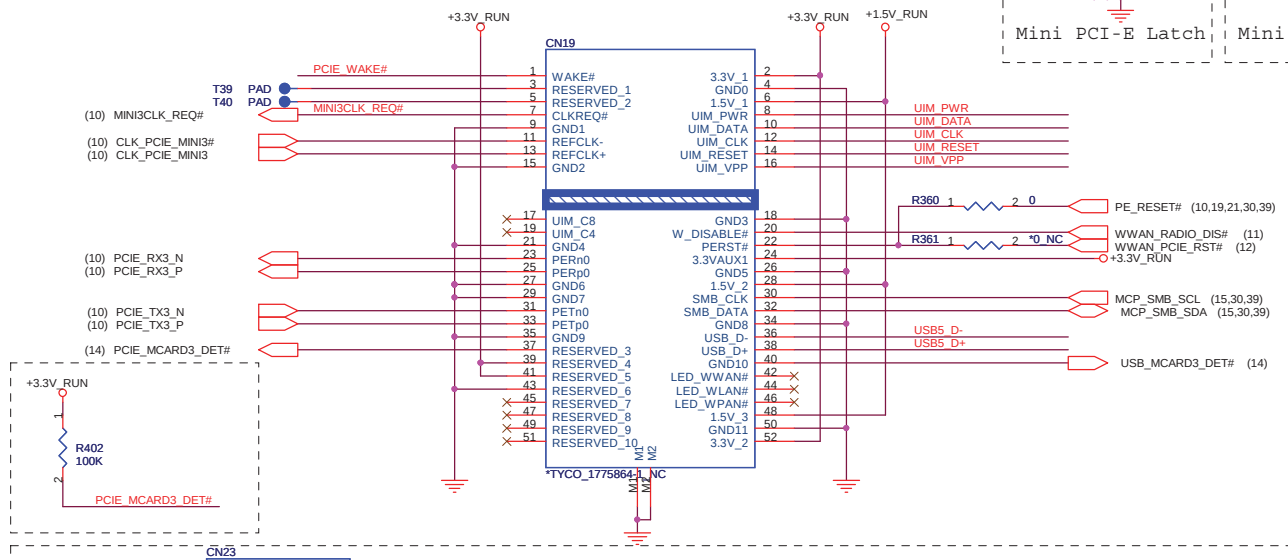


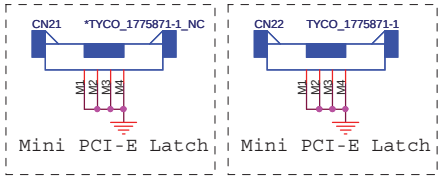
Reserve For EMI

Layout Note:
R331 and R332 close to choke as possible to minimize stubs.

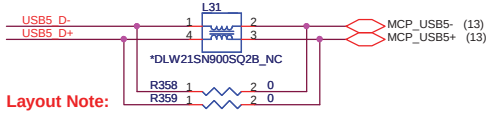
Place caps close to connector.

MiniCard WWAN Connector



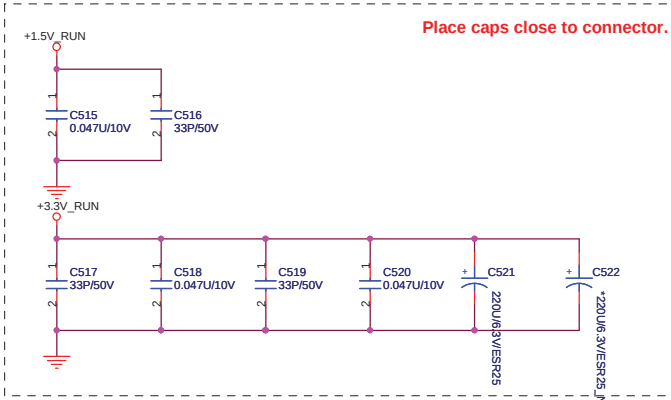


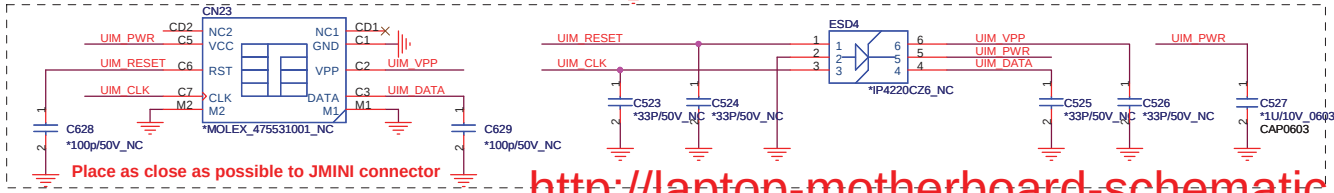
Reserve For EMI



Layout Note:
R358 and R359 close to choke as possible to minimize stubs.

Place caps close to connector.





Title	MINI-CARD (WPAN,WWAN)	
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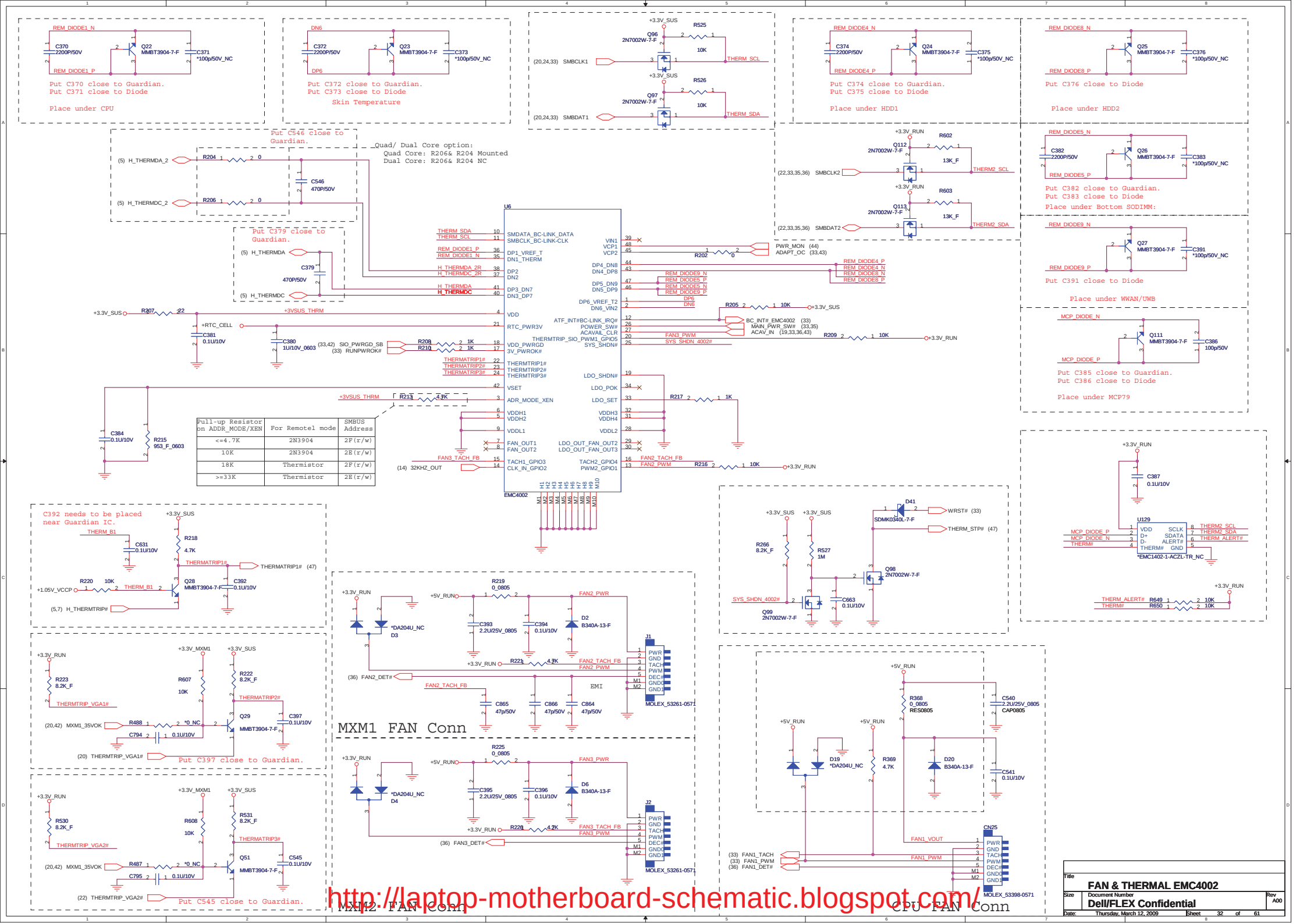
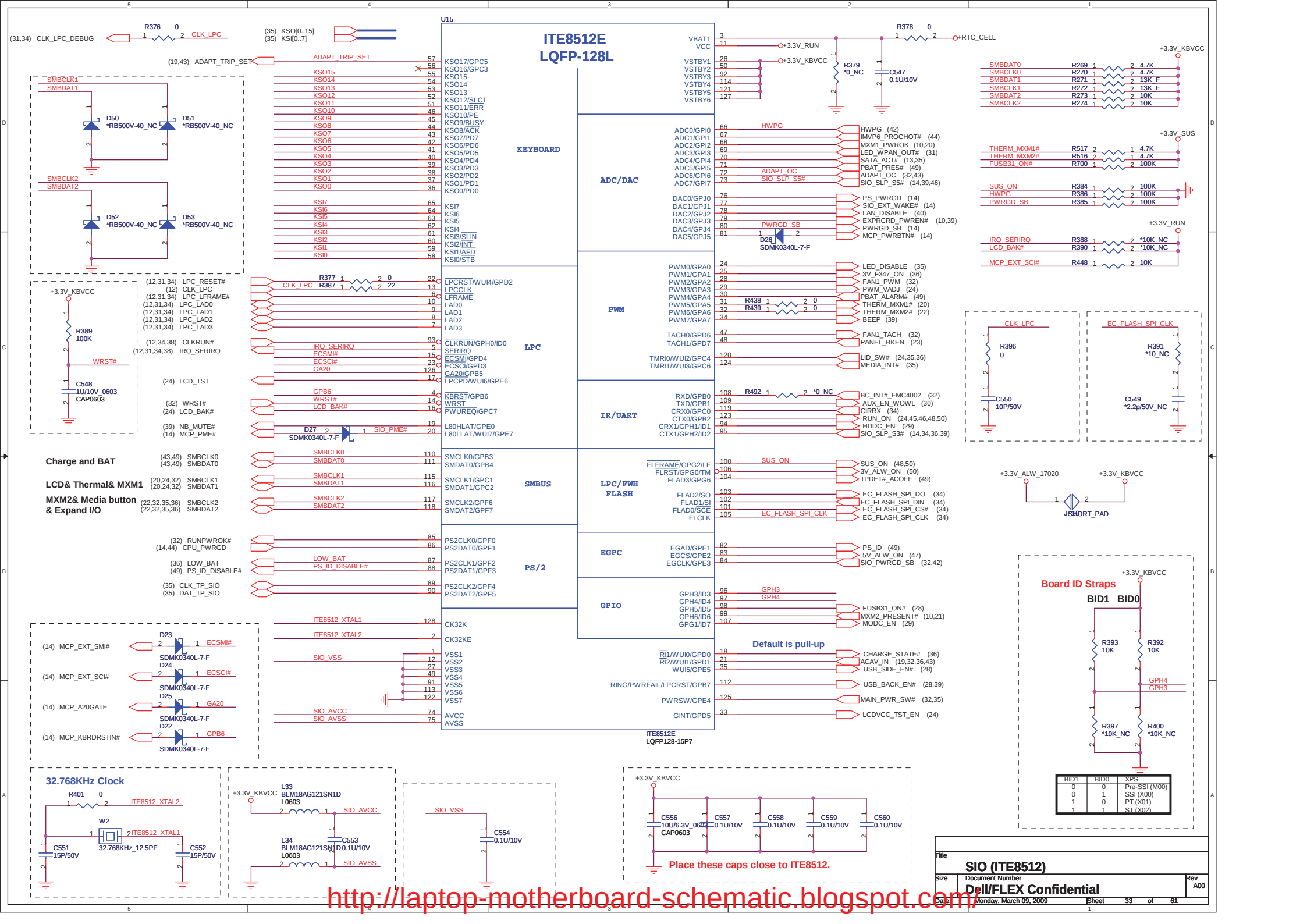
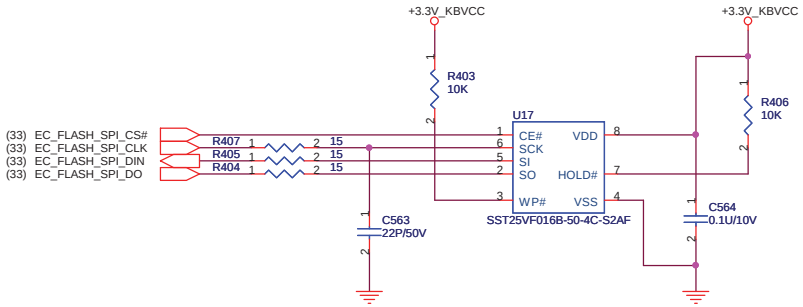
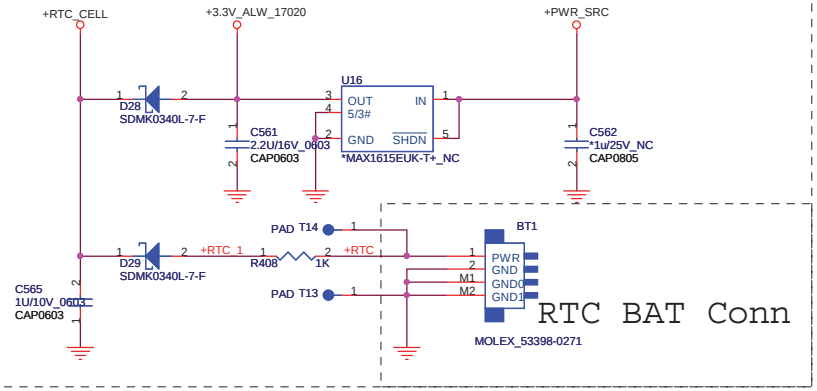




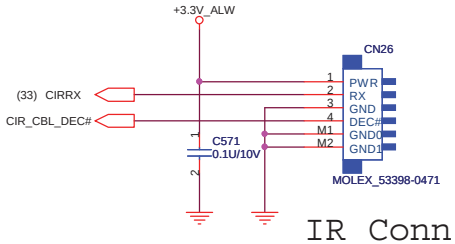
16Mbit (2M Byte), SPI

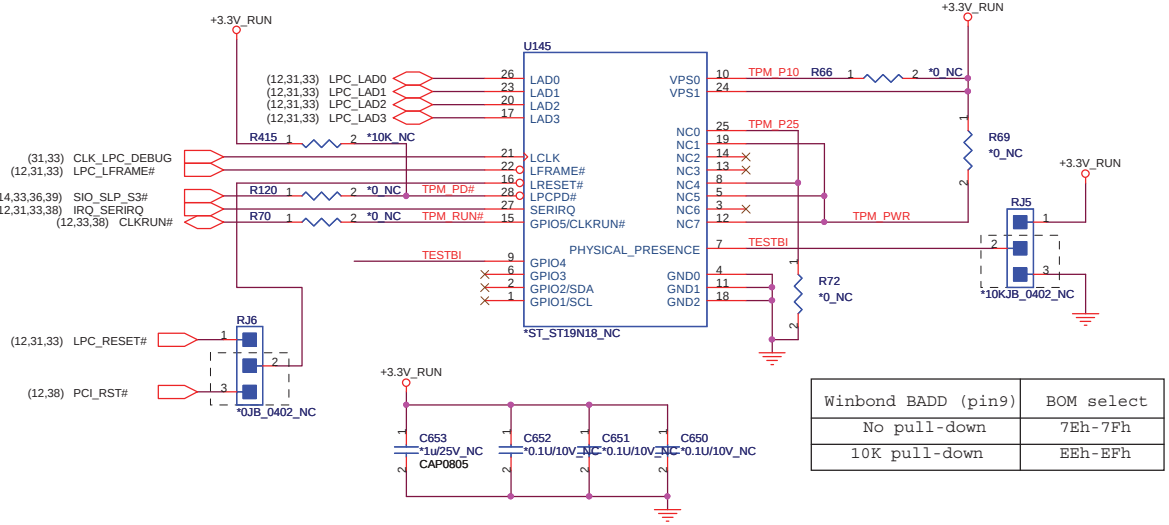


RTC BATTERY



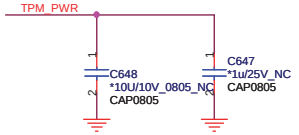
to Consumer IR





Winbond BADD (pin9)	BOM select
No pull-down	7Eh-7Fh
10K pull-down	EEh-EFh

TPM Vendor	BOM select
ST	Mounted: R66 NA: R69, R70, R72, C647, C648
Winbond	NA: R66 Mounted: R69, R70, R72, C647, C648



Title	FLASH/ RTC/ CIR	
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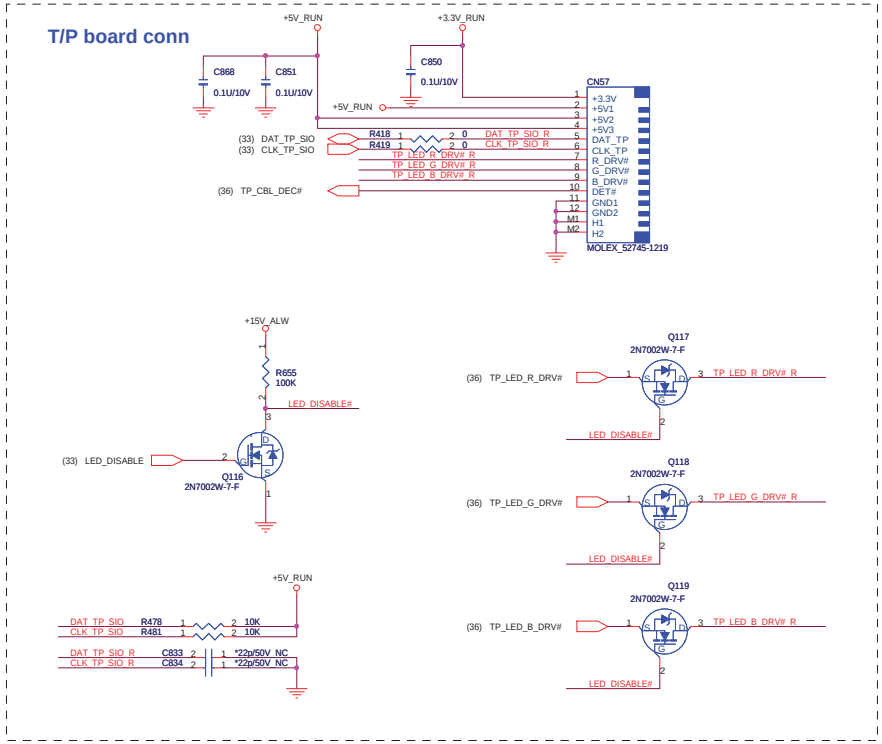

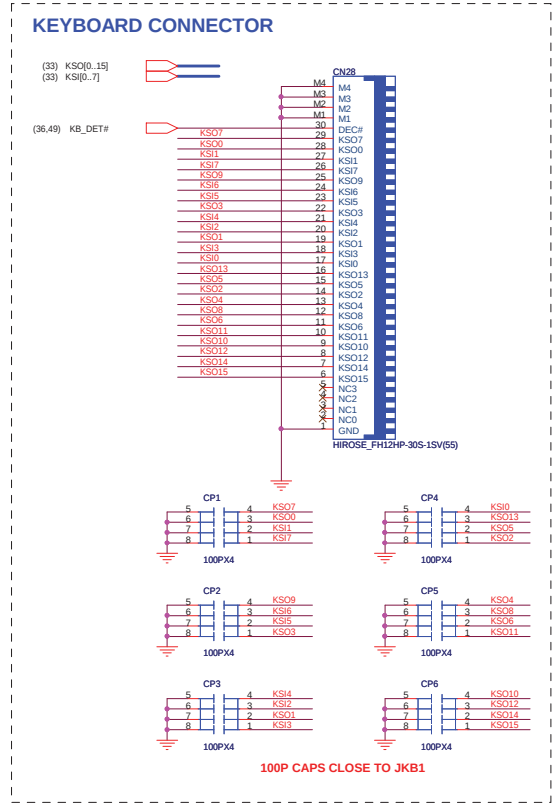

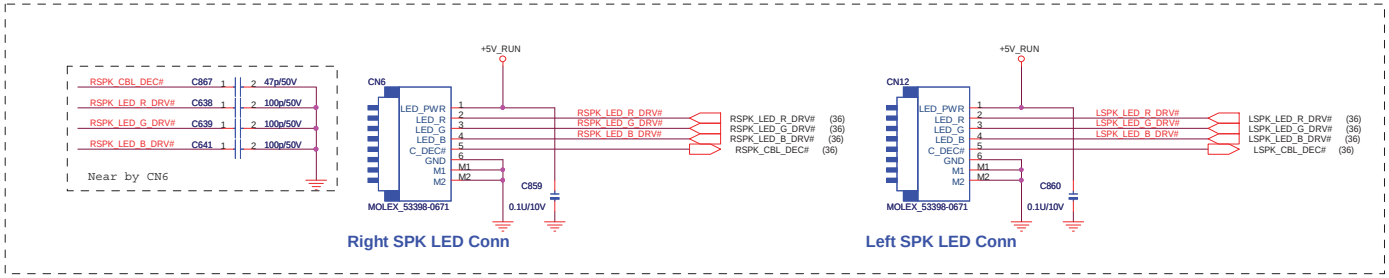

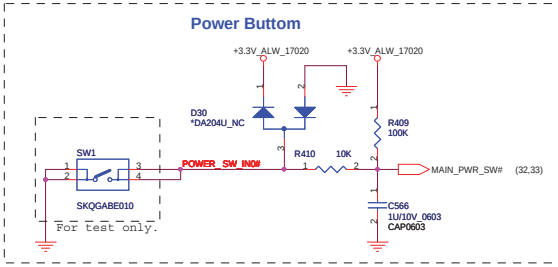

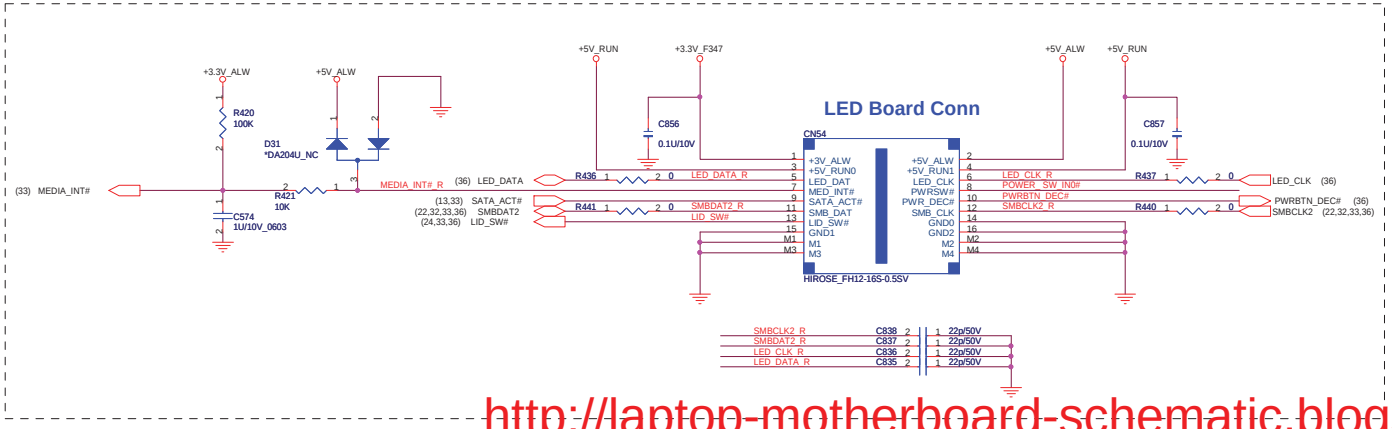

Title	KB/ DAUGHTER BOARD CONN	
Size	Document Number: Dell/FLEX Confidential	Rev: A00
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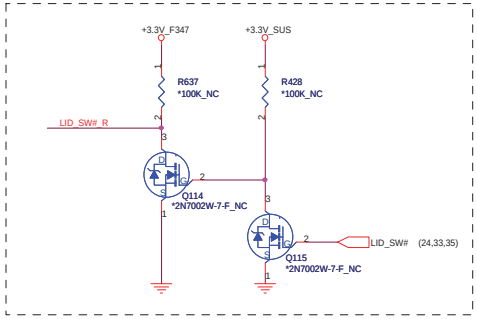
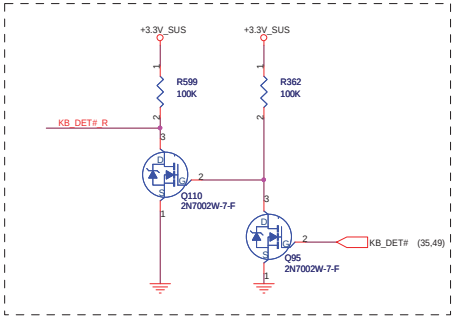
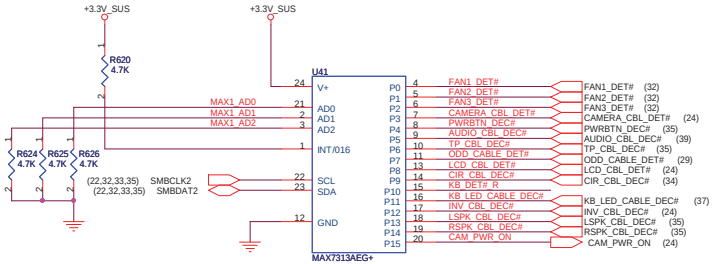
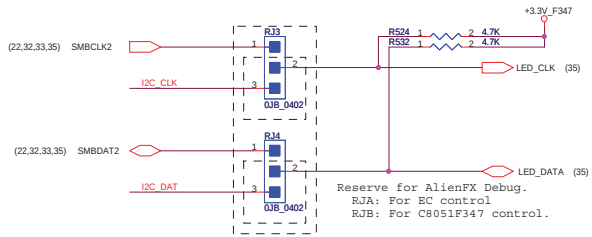
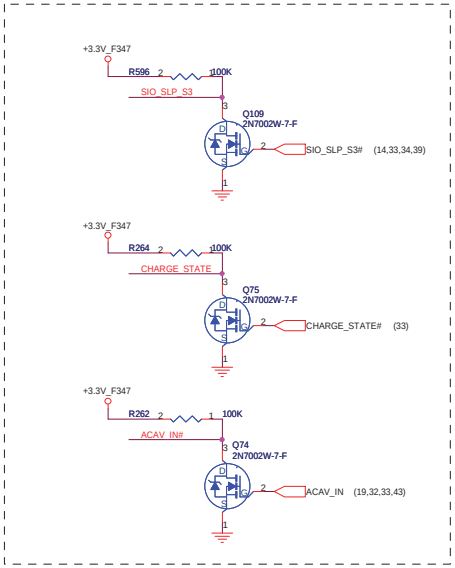
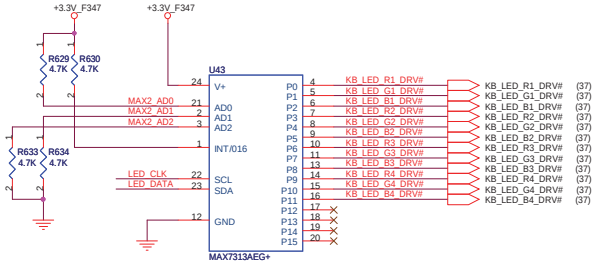


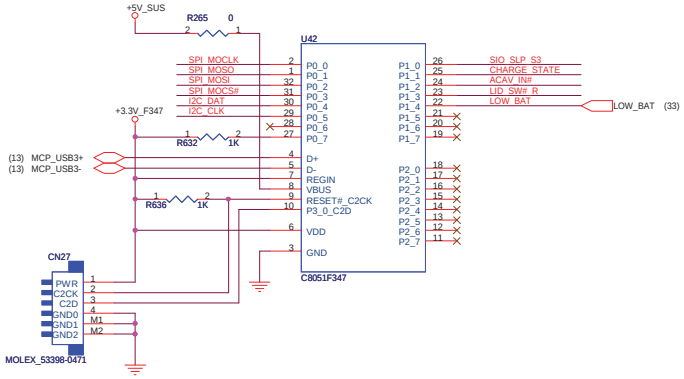


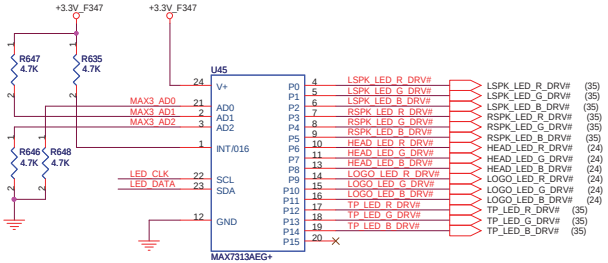










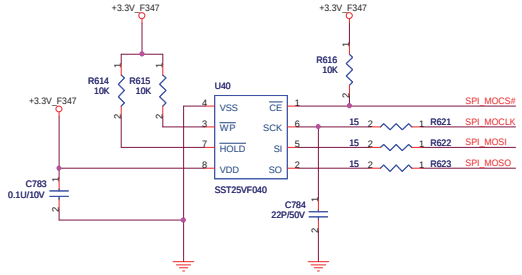


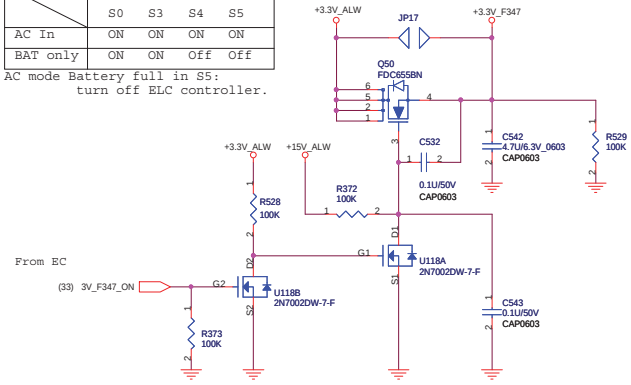
+3.3V_F347 behavior

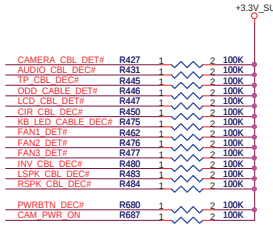
	State			
	S0	S3	S4	S5
AC In	ON	ON	ON	ON
BAT only	ON	ON	Off	Off

AC mode Battery full in S5:
turn off ELC controller.

Reference	AD2	AD1	AD0	MAX7313 #
U41	0	0	0	Cable Detect#
U43	0	0	1	KB LED
U45	0	1	0	SPK& Head& Logo& T/P LED
---	0	1	1	LED Board
---	1	0	0	Media Board
---	1	0	1	Media Board







DEVICE	SMBUS ADDRESS
MAXIM - LED	0100 000b
MAXIM - GPIO	0100 001b
I2C EEPROM (U40)	1010 000b

Title: LIGHT FX-1
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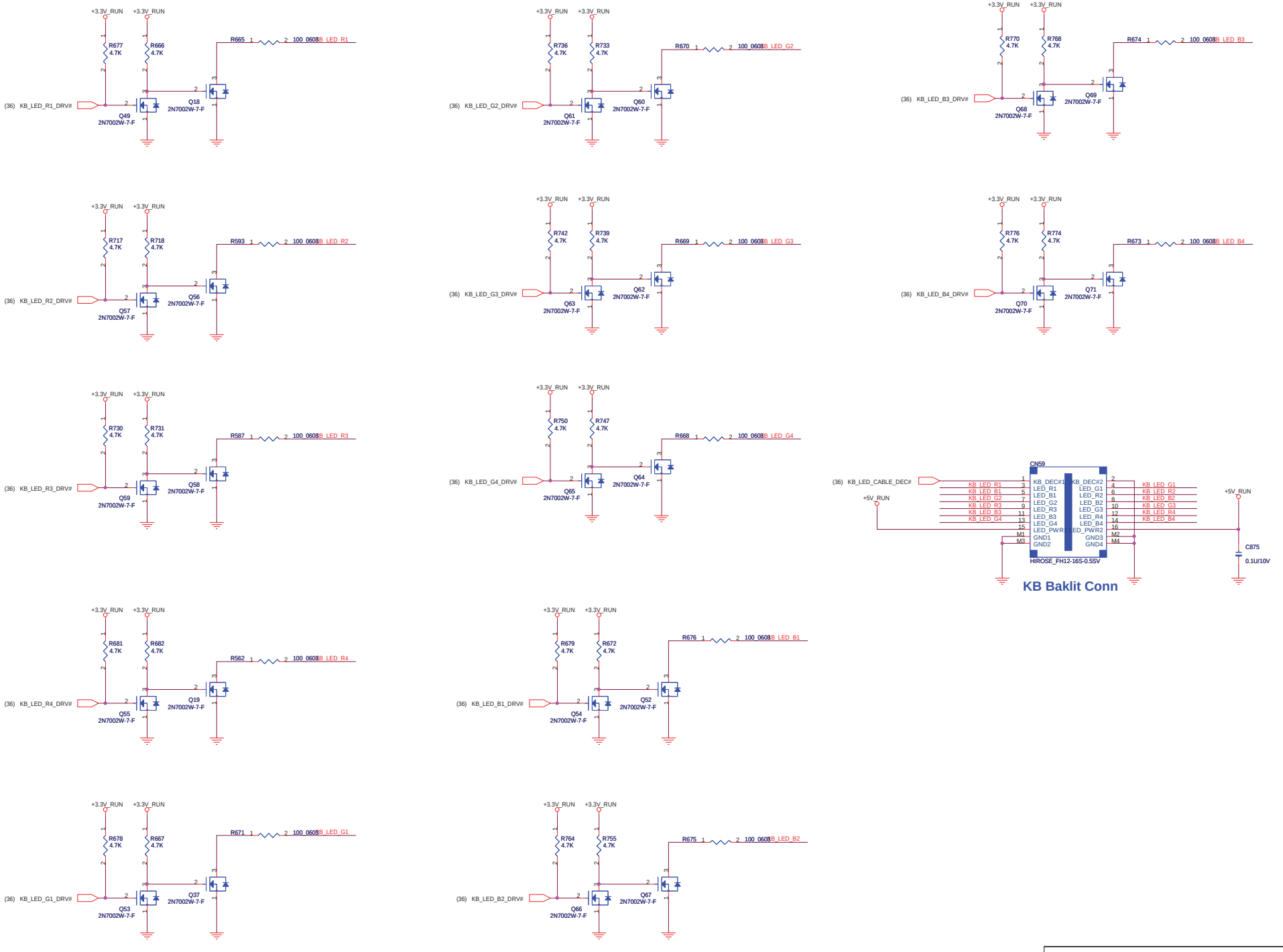

Title	LIGHT FX-2/ LID	
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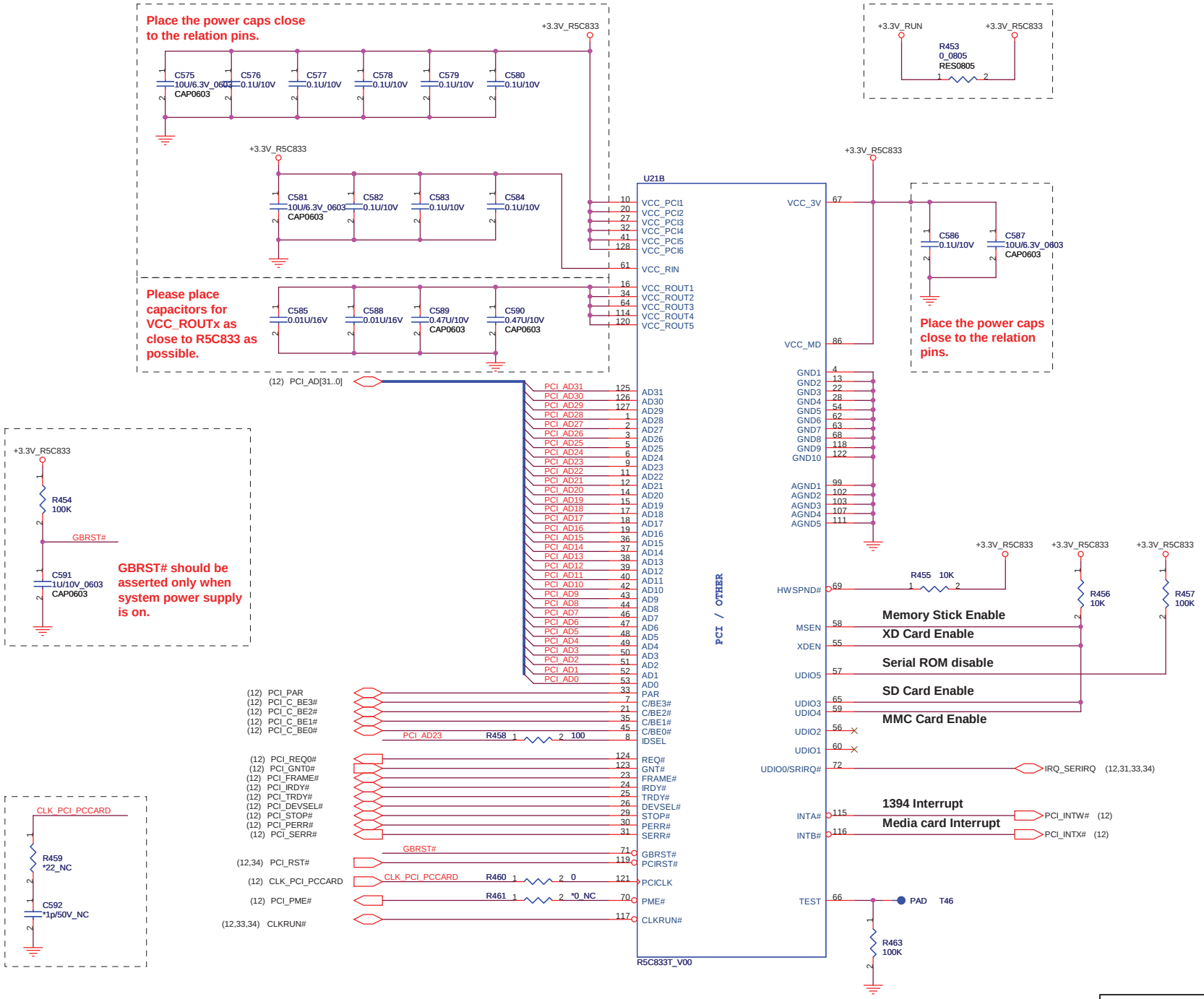

Title: CardReader (5C833)

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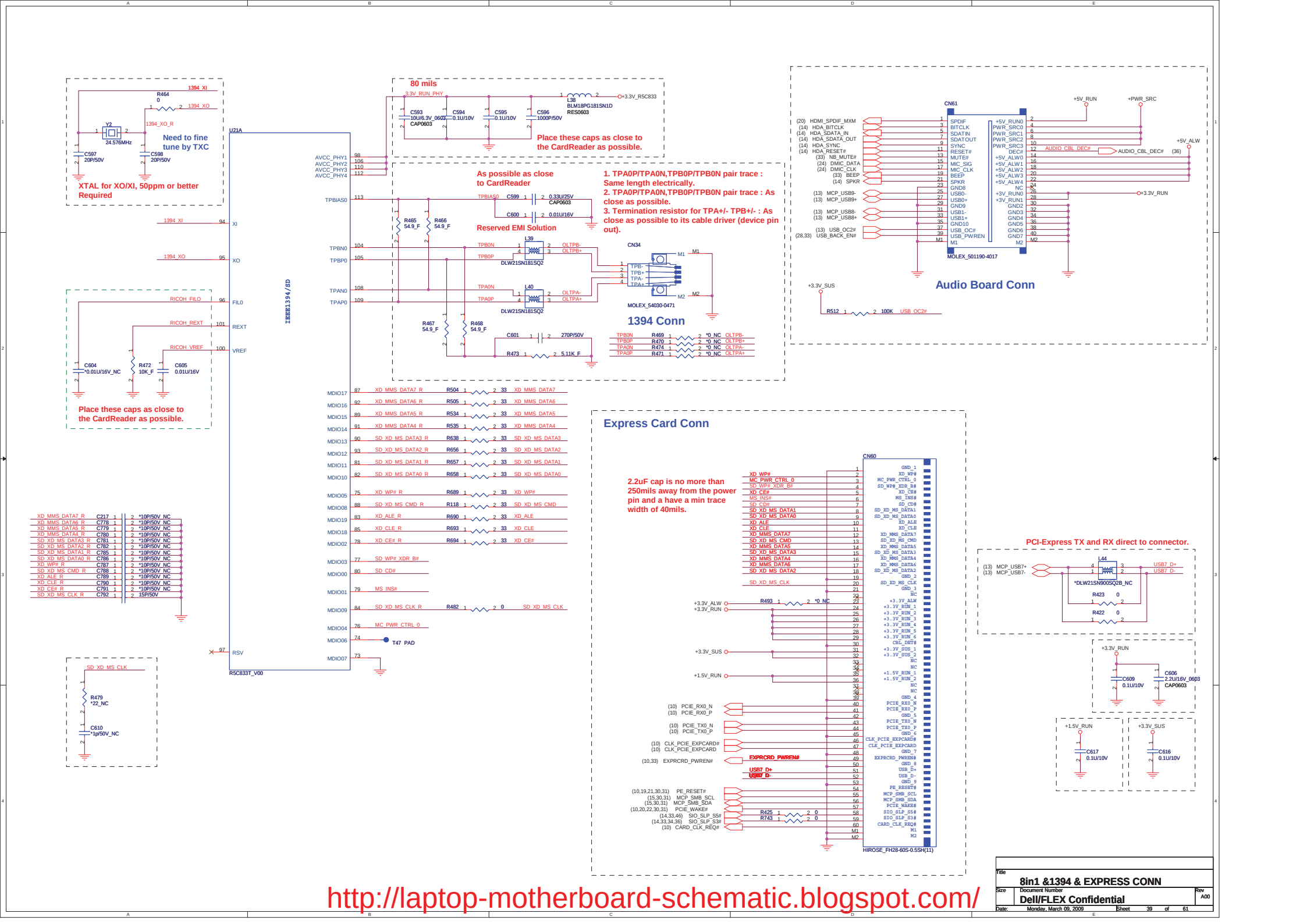
1394_XI
R464
0
1394_XO
1394_XO_R
Y2
24.576MHz
Need to fine tune by TXC
C597
20P/50V
C598
20P/50V
XTAL for XO/XI, 50ppm or better Required
U21A
1394_XI
1394_XO
RICOH_FILO
RICOH_REXT
RICOH_VREF
C604
*0.01U/16V_NC
R472
10K_F
C605
0.01U/16V
Place these caps as close to the CardReader as possible.
R5C833T_V00
80 mils
3.3V_RUN_PHY
C593
10U/6.3V_0603
CAP0603
C594
0.1U/10V
C595
0.1U/10V
C596
1000P/50V
L38
BLM18PG181SN1D
RES0603
+3.3V_R5C833
Place these caps as close to the CardReader as possible.
As possible as close to CardReader
1. TPA0P/TPA0N,TPB0P/TPB0N pair trace : Same length electrically.
2. TPA0P/TPA0N,TPB0P/TPB0N pair trace : As close as possible.
3. Termination resistor for TPA+/- TPB+/- : As close as possible to its cable driver (device pin out).
Reserved EMI Solution
C599
0.33U/25V
CAP0603
C600
0.01U/16V
R465
54.9_F
R466
54.9_F
L39
DLW21SN181SQ2
L40
DLW21SN181SQ2
CN34
MOLEX_54030-0471
1394 Conn
R467
54.9_F
R468
54.9_F
C601
270P/50V
R473
5.11K_F
R469
R470
R474
R471
*0_NC
CN61
MOLEX_501190-4017
Audio Board Conn
+5V_RUN
+PWR_SRC
+5V_ALW
+3.3V_RUN
+3.3V_SUS
R512
100K
USB_OC2#
Express Card Conn
2.2uF cap is no more than 250mils away from the power pin and a have a min trace width of 40mils.
CN60
HIROSE_FH28-60S-0.5SH(11)
R493
*0_NC
R479
*22_NC
C610
*1p/50V_NC
T47 PAD
PCI-Express TX and RX direct to connector.
L44
*DLW21SN900SQ2B_NC
R423
0
R422
0
C609
0.1U/10V
C606
2.2U/16V_0603
CAP0603
C617
0.1U/10V
C616
0.1U/10V
R425
R743
http://laptop-motherboard-schematic.blogspot.com/
Title
8in1 &1394 & EXPRESS CONN
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Layout Note:
1.Use 50 ohm impedance for all trace.
2. Trace length matched to a tolerance of 9.8mm in order to keep the skew between signals less than 0.07ns.
3.The receive and transmit signals kept away from each other and other analog and clock signals to reduce crosstalk.

+3.3V_RMGT +3.3V_PHY
JP11
SHORT_PAD
C685 10U/10V_0805 CAP0805

+3.3V_PHY
R540 1.5K_F
RGMII_MDIO

Reserved EMI
RGMII_RXCLK
C695 22P/50V

PHY_XTALI
R542 *22_NC
C696 *1p/50V_NC

PHY_XTALI
C894 47p/50V

+3.3V_PHY
R551 *4.7K_NC
PHY_RESET#
C704 *1p/50V_NC

(11) RGMII_TXCLK
(11) RGMII_TXCTL
(11,14) RGMII_TXD0
(11) RGMII_TXD1
(11) RGMII_TXD2
(11) RGMII_TXD3

(11) RGMII_RXCLK
(11) RGMII_RXCTL
RGMII_RXCLK R538 22 RGMII_RXCLK_C
RGMII_RXCTL R539 22 RGMII_RXCTL_C

(11) RGMII_RXD0
(11) RGMII_RXD1
(11) RGMII_RXD2
(11) RGMII_RXD3
R683 22
R684 22
R685 22
R686 22

Layout Note:
Locate these resistor close to PHY

(11) RGMII_MDC
(11) RGMII_MDIO
RGMII_MDIO

(11) RGMII_25MHz
R541 *0_NC PHY_XTALI

T48 PAD PHY_XTALO
T49 PAD
T50 PAD
T52 PAD
T51 PAD
T53 PAD

R544 0
+3.3V_PHY R545 10K
(11) RGMII_PWRDWN
(33) LAN_DISABLE
R546 0
R547 *0_NC
(11) RGMII_RESET#
R548 0 PHY_RESET#

U33
B5071A2KFBG
PHY
100 BALL BGA

GTXCLK A7
TX_EN A8
TX_ER A9
TXD[0] C7
TXD[1] C8
TXD[2] B6
TXD[3] B7
TXD[4] B8
TXD[5] B9
TXD[6] B10
TXD[7] A10
TXC C6

RXC A2
RX_DV B2
RX_ER A1
COL D5
CRS E5
RXD[0] D4
RXD[1] D3
RXD[2] C3
RXD[3] C4
RXD[4] C5
RXD[5] B5
RXD[6] B4
RXD[7] B3
MDC E3
MDIO E4
XTALI F1
XTALO F2
CLK_125 B1

TDI D6
TMS D8
TCK D7
TDO F10
TRST E10
MODE_SEL[1] D2
MODE_SEL[0] H5
LOWPWR F5
TEST0 H8
TEST1 H9
RESET E4

NC_1 A3
NC_2 A4
NC_3 E6
NC_4 E7
NC_5 E8
NC_6 E9
NC_7 F6
NC_8 F7
NC_9 F8
NC_10 F9
NC_11 G2
NC_12 G4

TRD[0]+ K1 TRD0+ TRD0+ (41)
TRD[0]- K2 TRD0- TRD0- (41)
TRD[1]+ K4 TRD1+ TRD1+ (41)
TRD[1]- K3 TRD1- TRD1- (41)
TRD[2]+ K5 TRD2+ TRD2+ (41)
TRD[2]- K6 TRD2- TRD2- (41)
TRD[3]+ K8 TRD3+ TRD3+ (41)
TRD[3]- K7 TRD3- TRD3- (41)

LED[1] G7 SPD10LED# SPD10LED# (41)
LED[2] G6 SPD100LED# SPD100LED# (41)
LED[3] H6 PHY_ACTLED PHY_ACTLED (41)
LED[4] G10 PHY_LED[4]

REGOUT[1] F3 +1.2V_PHY
DVDD_1 C10
DVDD_2 D1
DVDD_3 D10

AVDDL_1 J3 PHY_AVDDL
AVDDL_2 J4
VREF C1

PLLVDD E1 PHY_PLLVDD

REGOUT[2] H3 +2.5V_PHY
AVDD_2 J8
AVDD_1 J2

BIASVDD J1 BIASVDD
XTALVDD G1 XTALVDD
RDAC H1 R543 1.24K_F

OVDD1 A5
OVDD2 A6
REGSUPPLY[1] G3 +3.3V_PHY
REGSUPPLY[2] H2 3.3V

GND_1 C2
GND_2 C9
GND_3 D9

AGND_1 J5
AGND_2 J6
AGND_3 J7
PLLGND E2

NC_13 G5
NC_14 G8
NC_15 G9
NC_16 H4
NC_17 H7
NC_18 H10 R550 *10K_NC +3.3V_PHY
NC_19 J10
NC_20 J9
NC_21 K10
NC_22 K9

Pull-High: Address 1
NC : Address 0

Pace 0.1u close PHY
+3.3V_PHY
C697 0.1U/10V
C698 0.1U/10V

Layout Note:
Locate the RDAC resistor as close to the RDAC pin as possible and keep the trace between the pin and resistor and short and wide as possible.

Pace 0.1u close DVDD pins
Pace 10u close pin F3 "REGOUT[1]"
+1.2V_PHY
1.2V
C686 0.1U/10V
C687 0.1U/10V
C688 0.1U/10V
C689 10U/10V_0805 CAP0805

Pace close AVDDL pins
1.2V PHY_AVDDL
C690 0.1U/10V
C691 0.1U/10V
C692 10U/10V_0805 CAP0805
L50 BLM18AG601SN1D

1.2V PHY_PLLVDD
C693 0.1U/10V
C694 10U/10V_0805 CAP0805
L51 BLM18AG601SN1D

Pace 10u close pin H3 "REGOUT[2]"
+2.5V_PHY
2.5V
C699 0.1U/10V
C700 0.1U/10V
C701 10U/10V_0805 CAP0805

2.5V BIASVDD
C702 0.1U/10V
L52 BLM18AG601SN1D

2.5V XTALVDD
C703 0.1U/10V
L53 BLM18AG601SN1D

EMI Reserve
PHY_XTALI
Y3
25MHz_12PF
PHY_XTALO
C204 10p/50V
C214 10p/50V

+3.3V_PHY
C765 0.1U/10V
C764 0.1U/10V
SPD10LED# C644 100p/50V
SPD100LED# C645 100p/50V
PHY_ACTLED C646 100p/50V
EMI

Auto-Negotiate
10/100/1000BASE-T
SPD10LED#
PHY_LED[4]
PHY_ACTLED
R552 4.7K
R553 *4.7K_NC
R554 *4.7K_NC

Title: **PHY(B5071)**
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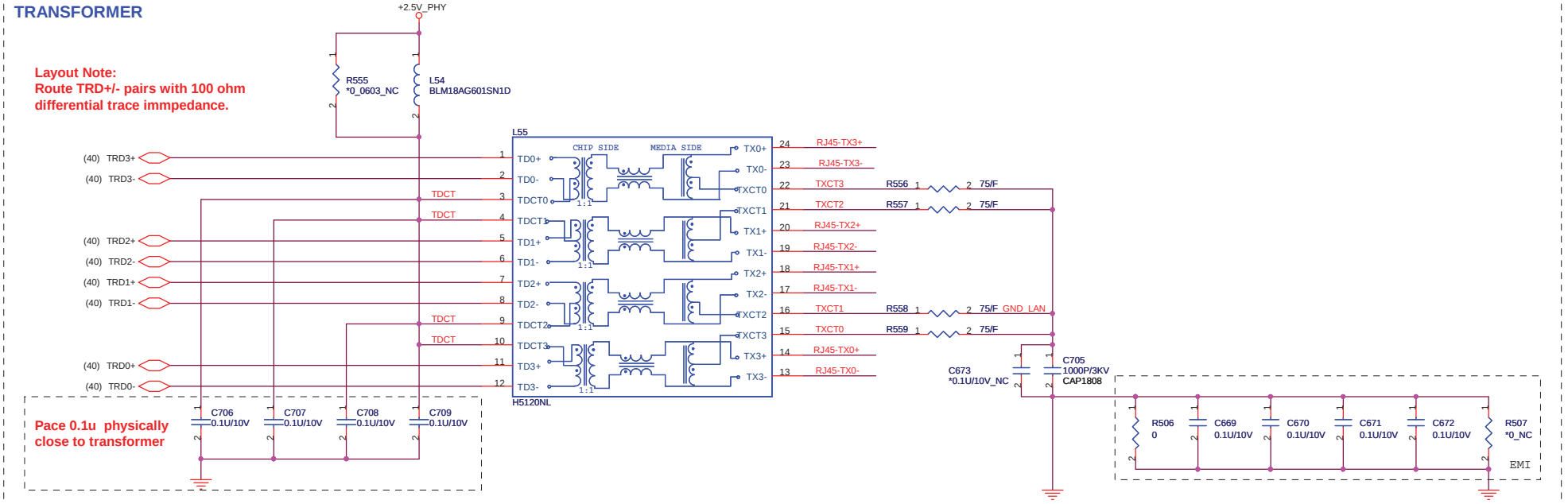
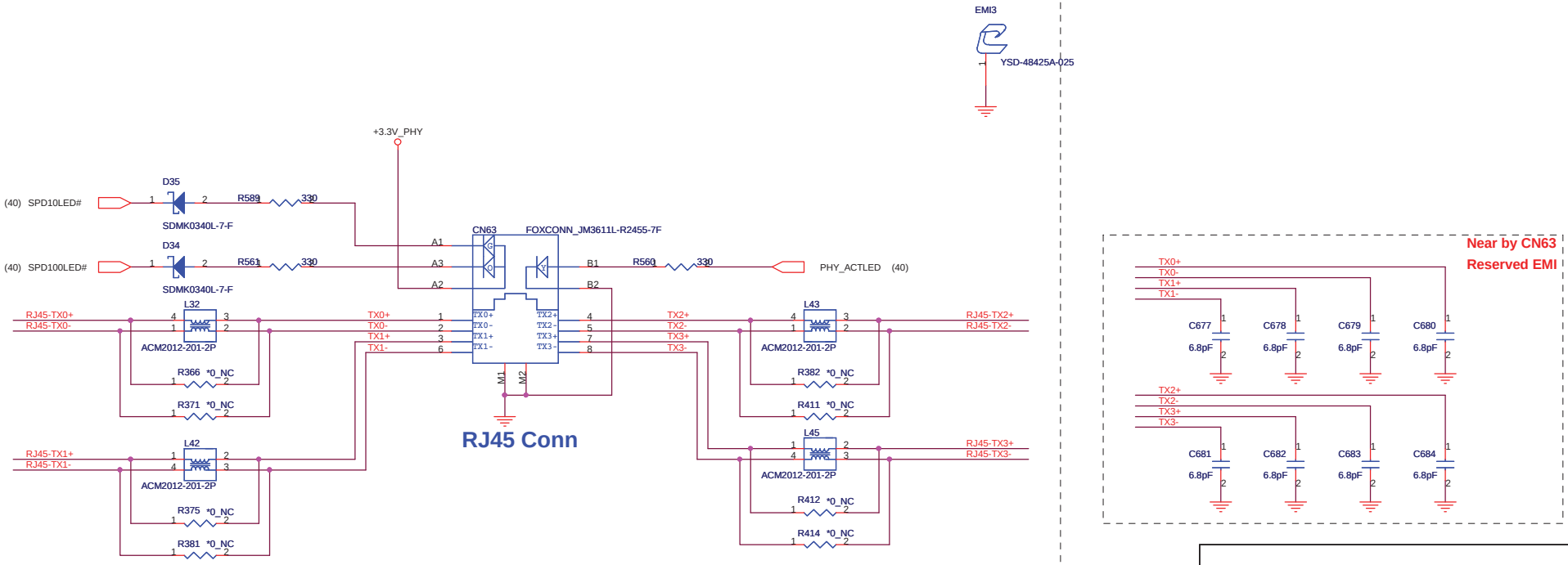
TRANSFORMER

Layout Note:
Route TRD+/- pairs with 100 ohm differential trace immpedance.



RJ-45 Connector



Title	RJ-45/TRANSFORM	
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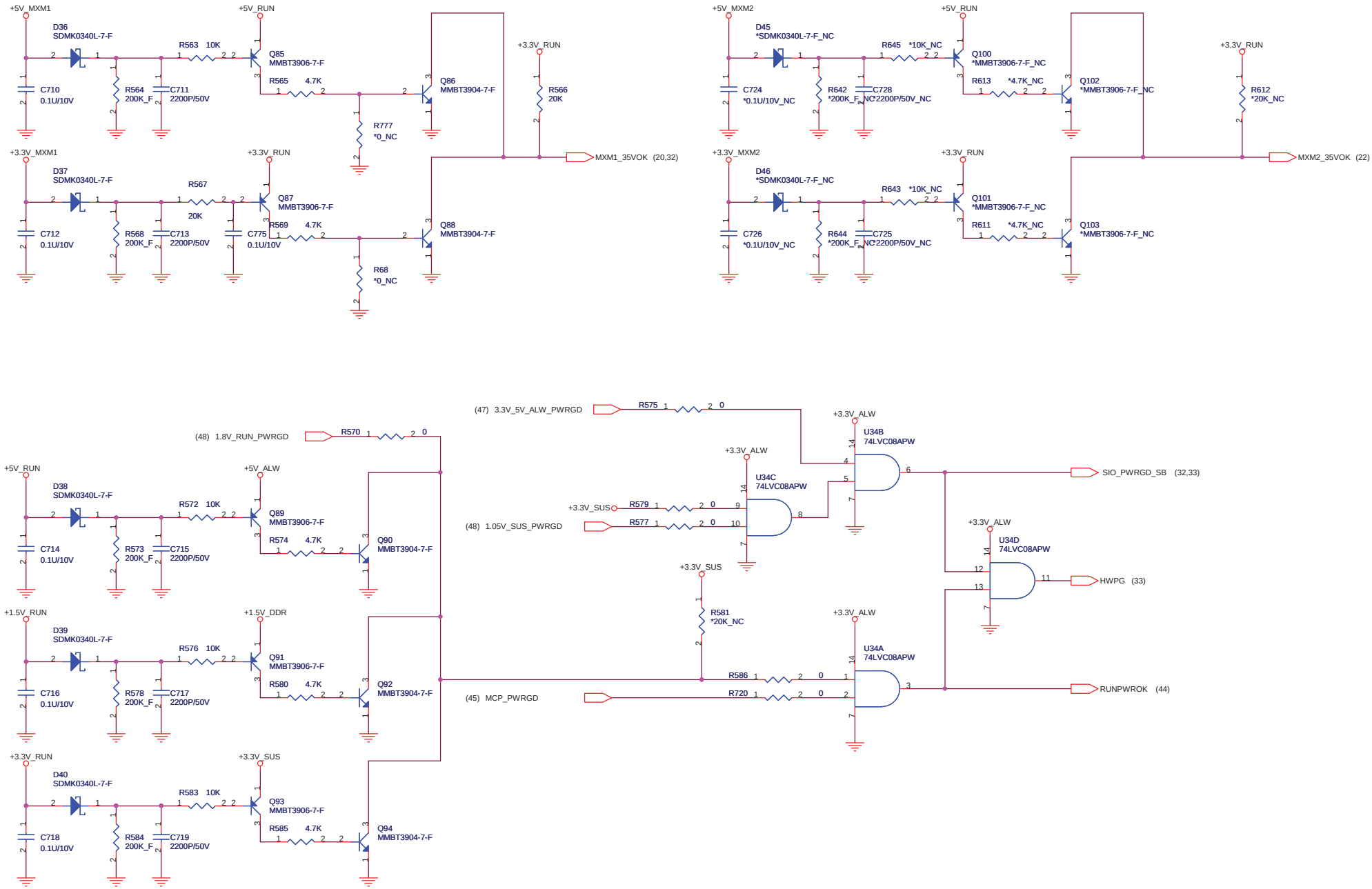

Title	System Reset Circuit	
Size	Document Number	Rev
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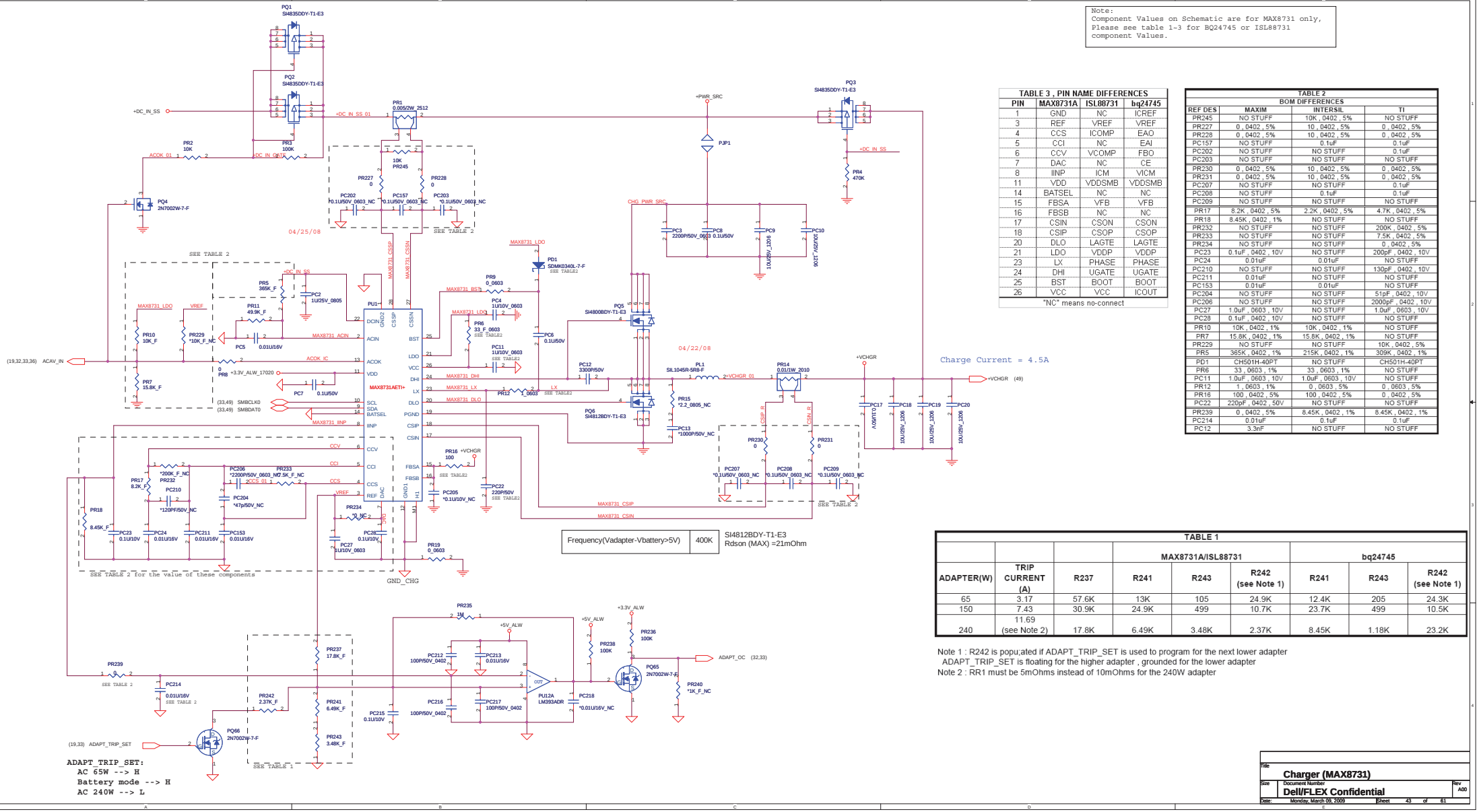


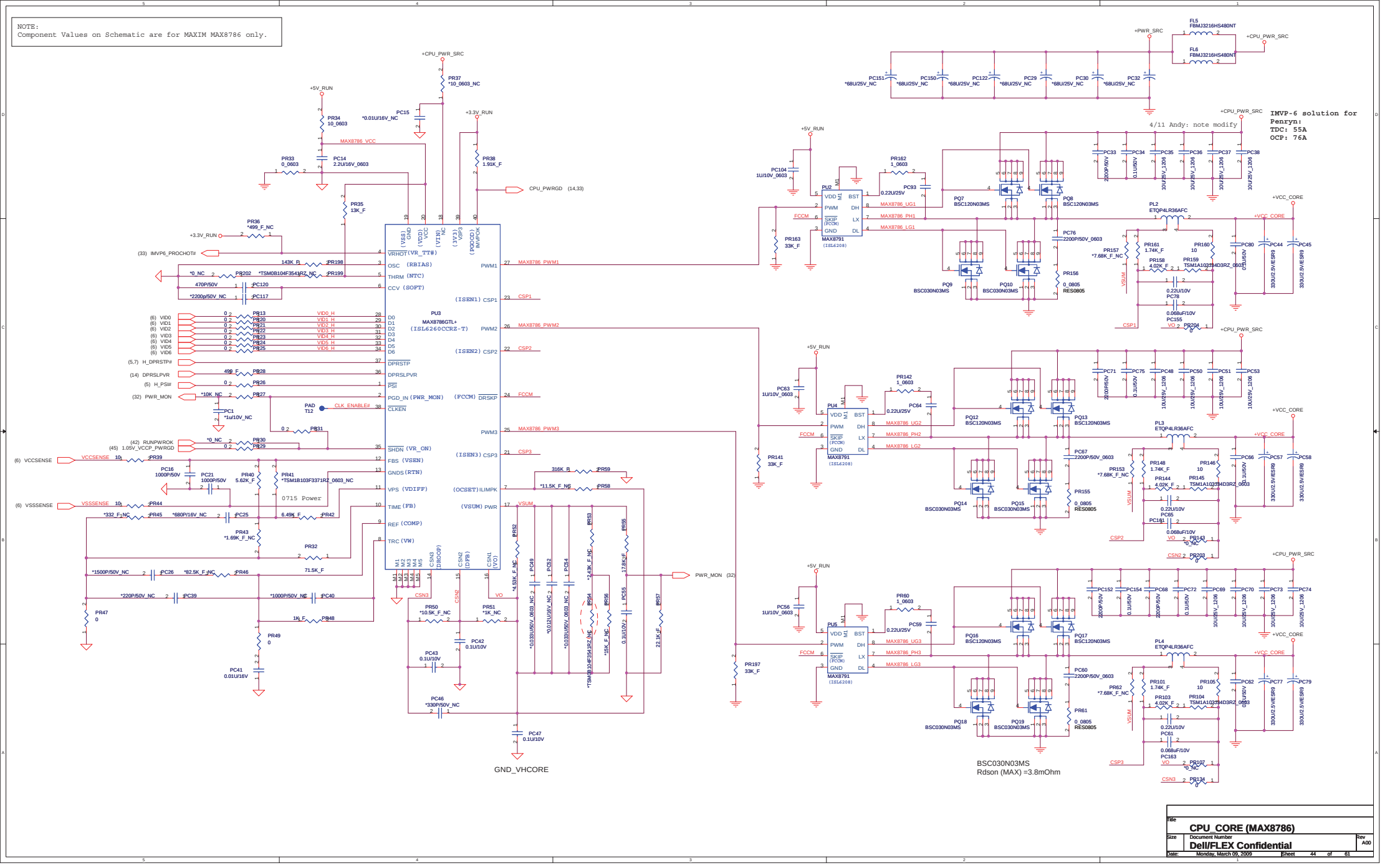
TABLE 3 , PIN NAME DIFFERENCES			
PIN	MAX8731A	ISL88731	bq24745
1	GND	NC	ICREF
3	REF	VREF	VREF
4	CCS	ICOMP	EAO
5	CCI	NC	EAI
6	CCV	VCOMP	FBO
7	DAC	NC	CE
8	IINP	ICM	VICM
11	VDD	VDDSMB	VDDSMB
14	BATSEL	NC	NC
15	FBSA	VFB	VFB
16	FBSB	NC	NC
17	CSIN	CSON	CSON
18	CSIP	CSOP	CSOP
20	DLO	LAGTE	LAGTE
21	LDO	VDDP	VDDP
23	LX	PHASE	PHASE
24	DHI	UGATE	UGATE
25	BST	BOOT	BOOT
26	VCC	VCC	ICOUT

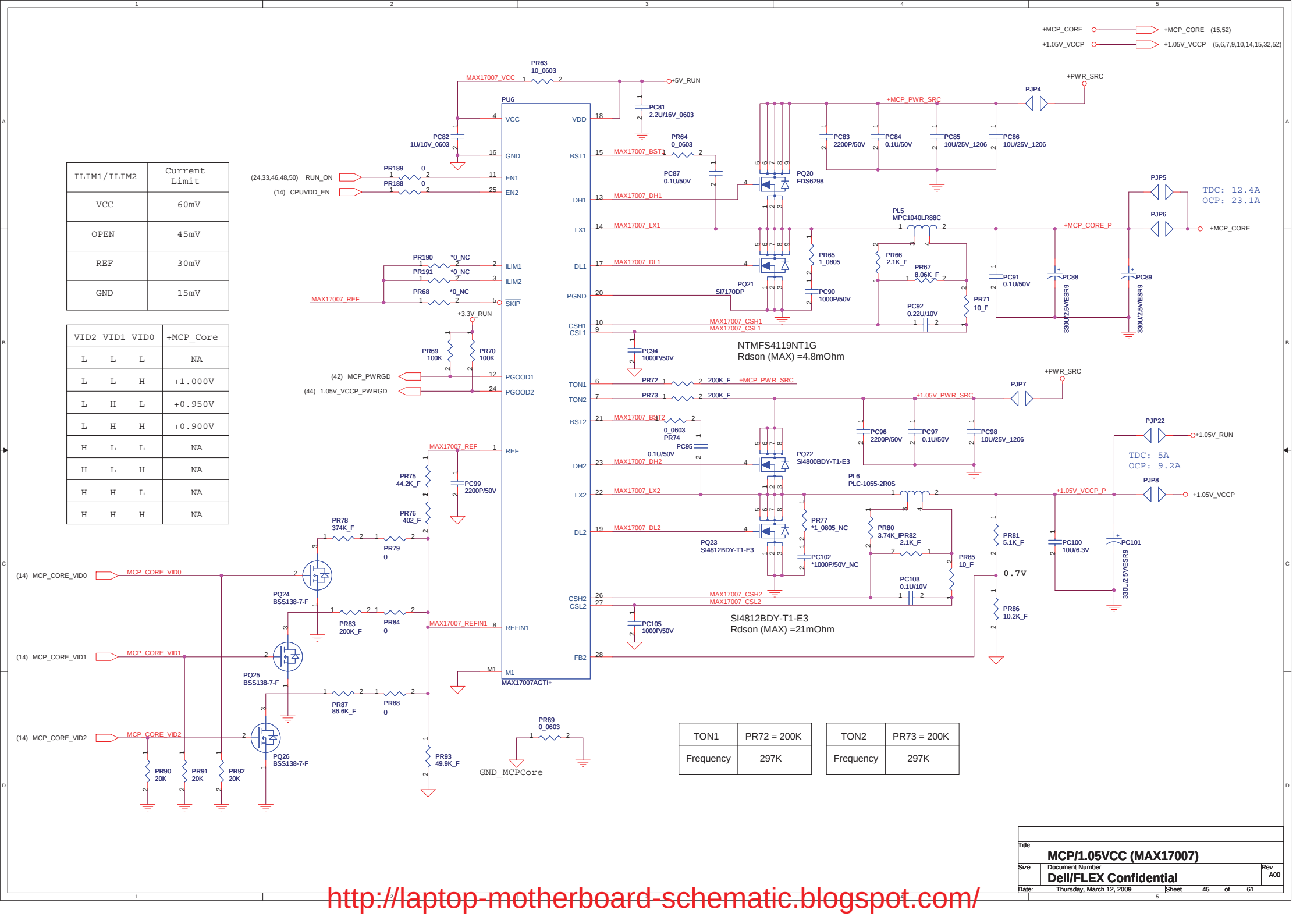
"NC" means no-connect

TABLE 2 BOM DIFFERENCES			
REF DES	MAXIM	INTERSIL	TI
PR245	NO STUFF	10K , 0402 , 5%	NO STUFF
PR227	0 , 0402 , 5%	10 , 0402 , 5%	0 , 0402 , 5%
PR228	0 , 0402 , 5%	10 , 0402 , 5%	0 , 0402 , 5%
PC157	NO STUFF	0.1uF	0.1uF
PC202	NO STUFF	NO STUFF	0.1uF
PC203	NO STUFF	NO STUFF	NO STUFF
PR230	0 , 0402 , 5%	10 , 0402 , 5%	0 , 0402 , 5%
PR231	0 , 0402 , 5%	10 , 0402 , 5%	0 , 0402 , 5%
PC207	NO STUFF	NO STUFF	0.1uF
PC208	NO STUFF	0.1uF	0.1uF
PC209	NO STUFF	NO STUFF	NO STUFF
PR17	8.2K , 0402 , 5%	2.2K , 0402 , 5%	4.7K , 0402 , 5%
PR18	8.45K , 0402 , 1%	NO STUFF	NO STUFF
PR232	NO STUFF	NO STUFF	200K , 0402 , 5%
PR233	NO STUFF	NO STUFF	7.5K , 0402 , 5%
PR234	NO STUFF	NO STUFF	0 , 0402 , 5%
PC23	0.1uF , 0402 , 10V	NO STUFF	200pF , 0402 , 10V
PC24	0.01uF	0.01uF	NO STUFF
PC210	NO STUFF	NO STUFF	130pF , 0402 , 10V
PC211	0.01uF	NO STUFF	NO STUFF
PC153	0.01uF	0.01uF	NO STUFF
PC204	NO STUFF	NO STUFF	51pF , 0402 , 10V
PC206	NO STUFF	NO STUFF	2000pF , 0402 , 10V
PC27	1.0uF , 0603 , 10V	NO STUFF	1.0uF , 0603 , 10V
PC28	0.1uF , 0402 , 10V	NO STUFF	NO STUFF
PR10	10K , 0402 , 1%	10K , 0402 , 1%	NO STUFF
PR7	15.8K , 0402 , 1%	15.8K , 0402 , 1%	NO STUFF
PR229	NO STUFF	NO STUFF	10K , 0402 , 5%
PR5	365K , 0402 , 1%	215K , 0402 , 1%	309K , 0402 , 1%
PD1	CH501H-40PT	NO STUFF	CH501H-40PT
PR6	33 , 0603 , 1%	33 , 0603 , 1%	NO STUFF
PC11	1.0uF , 0603 , 10V	1.0uF , 0603 , 10V	NO STUFF
PR12	1 , 0603 , 1%	0 , 0603 , 5%	0 , 0603 , 5%
PR16	100 , 0402 , 5%	100 , 0402 , 5%	0 , 0402 , 5%
PC22	220pF , 0402 , 50V	NO STUFF	NO STUFF
PR239	0 , 0402 , 5%	8.45K , 0402 , 1%	8.45K , 0402 , 1%
PC214	0.01uF	0.1uF	0.1uF
PC12	3.3nF	NO STUFF	NO STUFF

TABLE 1								
			MAX8731A/ISL88731			bq24745		
ADAPTER(W)	TRIP CURRENT (A)	R237	R241	R243	R242 (see Note 1)	R241	R243	R242 (see Note 1)
65	3.17	57.6K	13K	105	24.9K	12.4K	205	24.3K
150	7.43	30.9K	24.9K	499	10.7K	23.7K	499	10.5K
240	11.69 (see Note 2)	17.8K	6.49K	3.48K	2.37K	8.45K	1.18K	23.2K

Note 1 : R242 is popu;ated if ADAPT_TRIP_SET is used to program for the next lower adapter
ADAPT_TRIP_SET is floating for the higher adapter , grounded for the lower adapter
Note 2 : RR1 must be 5mOhms instead of 10mOhms for the 240W adapter





ILIM1/ILIM2	Current Limit
VCC	60mV
OPEN	45mV
REF	30mV
GND	15mV

VID2	VID1	VID0	+MCP_Core
L	L	L	NA
L	L	H	+1.000V
L	H	L	+0.950V
L	H	H	+0.900V
H	L	L	NA
H	L	H	NA
H	H	L	NA
H	H	H	NA

TON1	PR72 = 200K
Frequency	297K

TON2	PR73 = 200K
Frequency	297K

Title	MCP/1.05VCC (MAX17007)		
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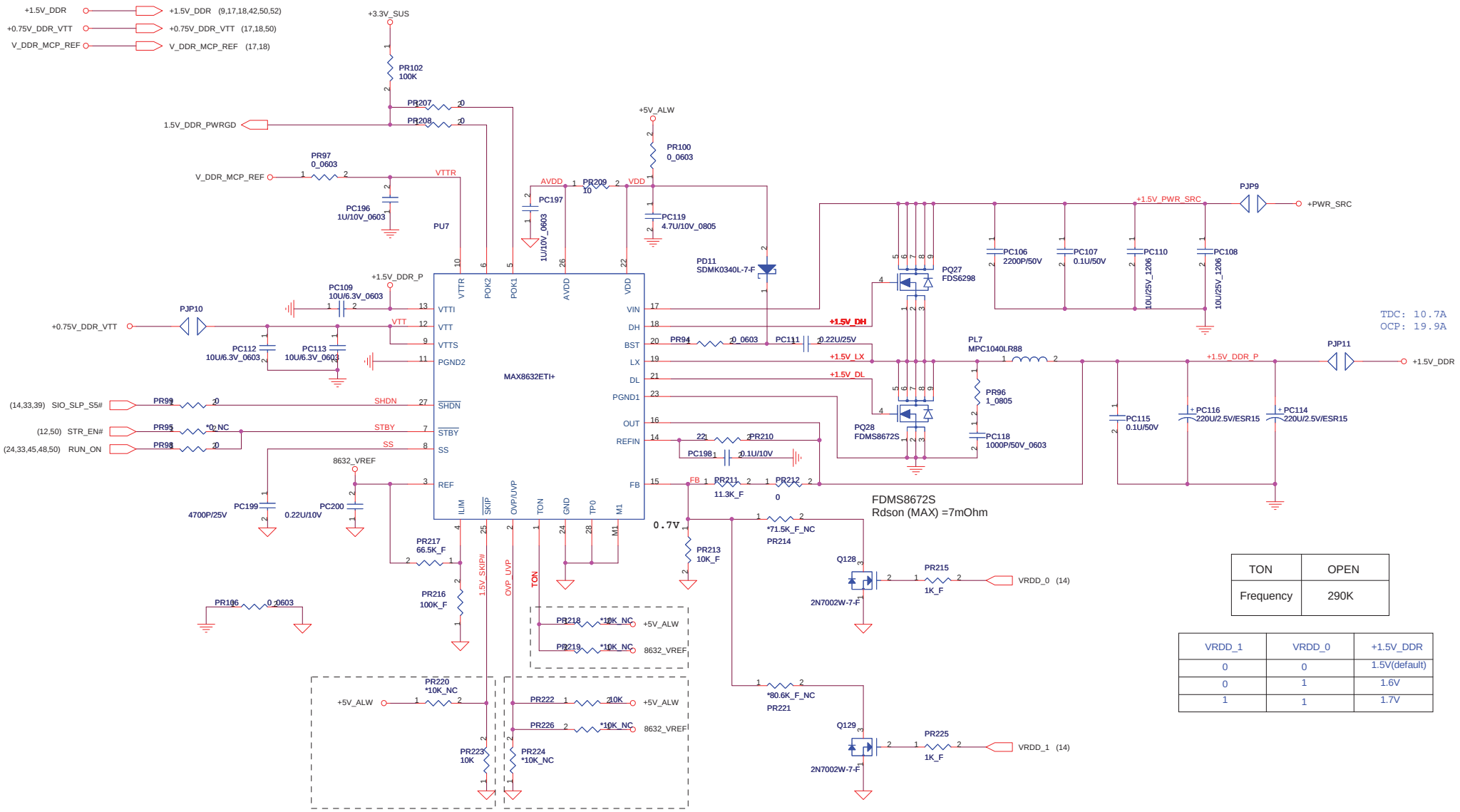

TON	OPEN
Frequency	290K

VRDD_1	VRDD_0	+1.5V_DDR
0	0	1.5V(default)
0	1	1.6V
1	1	1.7V

Title	DDR1.5/0.75(TPS51116)	
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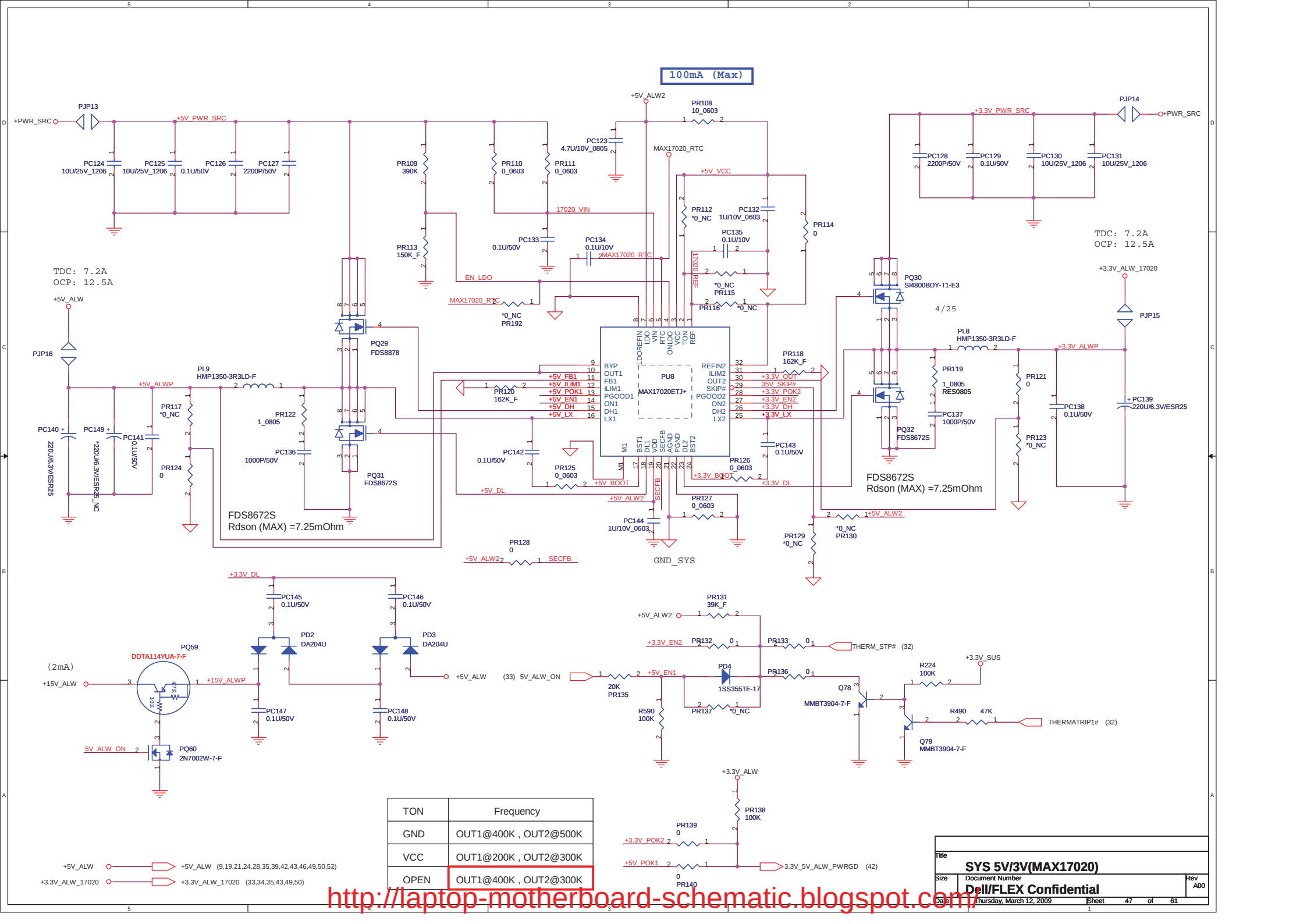
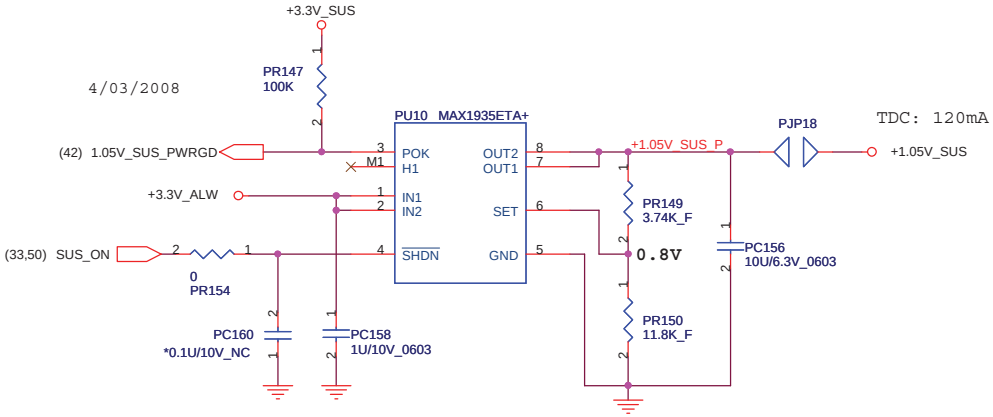
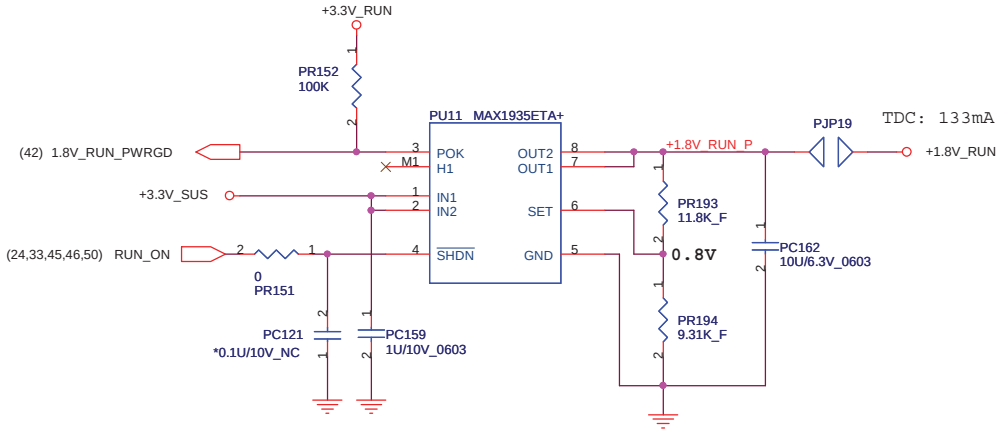


TON	Frequency
GND	OUT1@400K , OUT2@500K
VCC	OUT1@200K , OUT2@300K
OPEN	OUT1@400K , OUT2@300K





Title	1.1V_SUS/1.8V_RUN	
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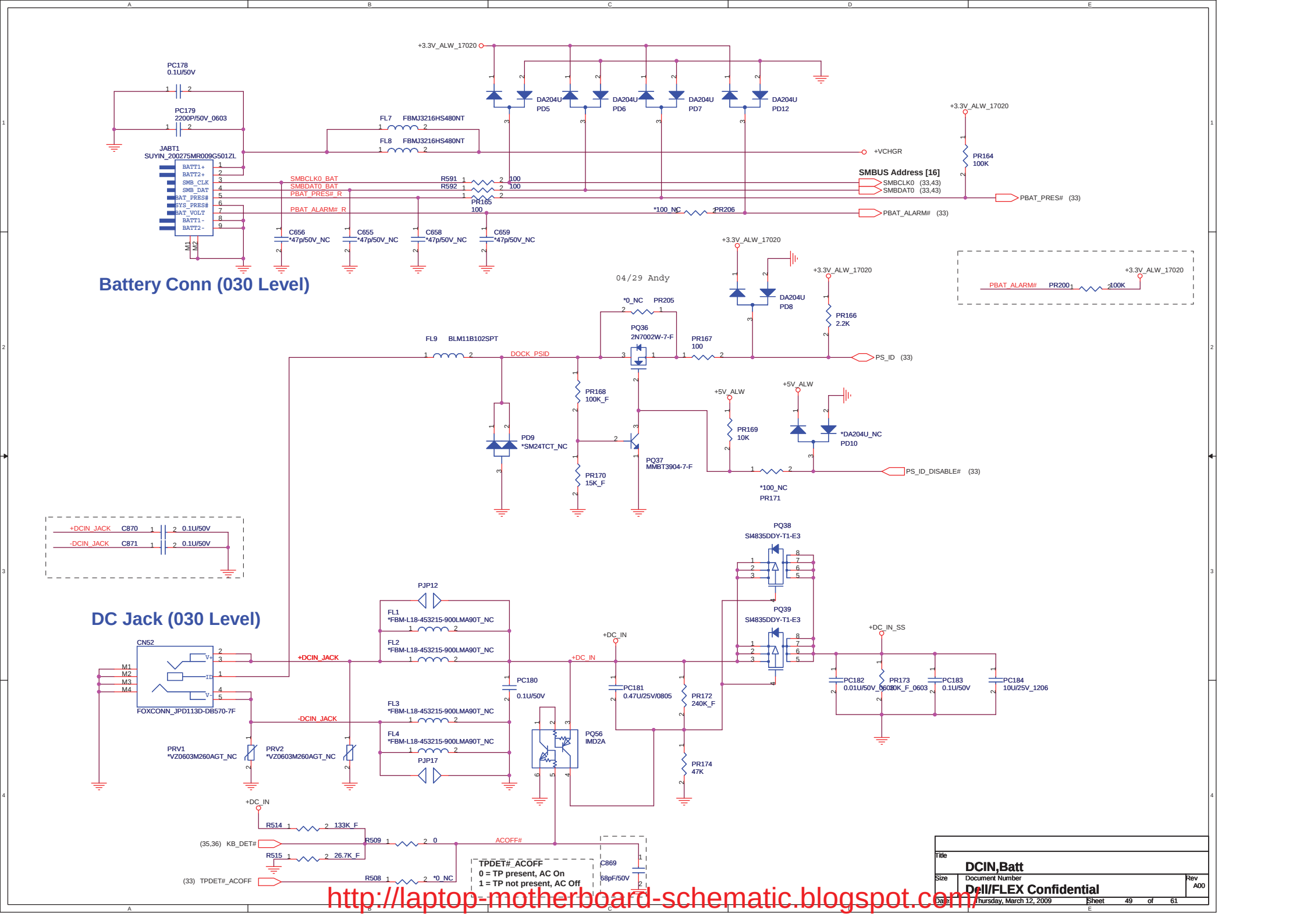

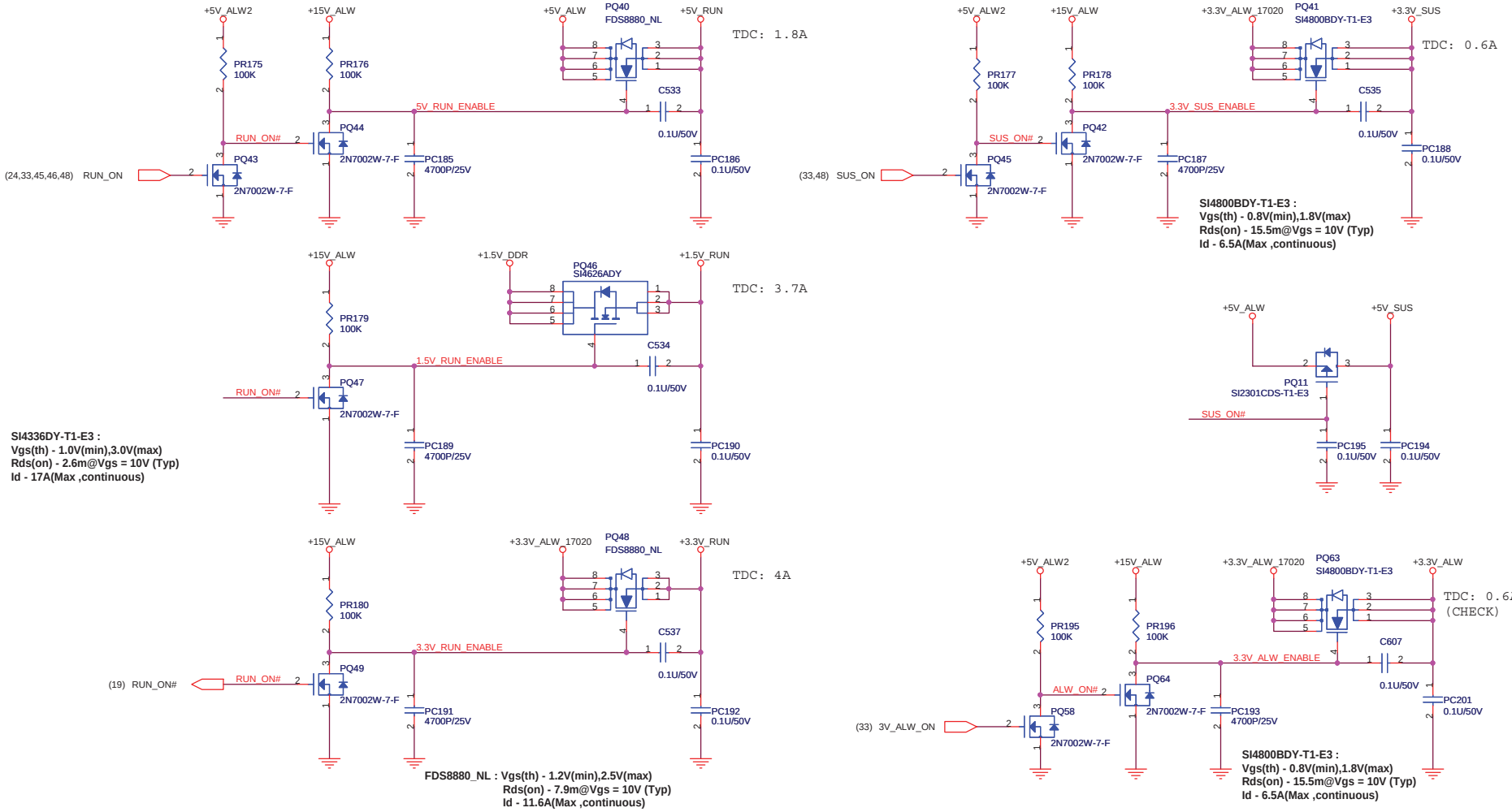

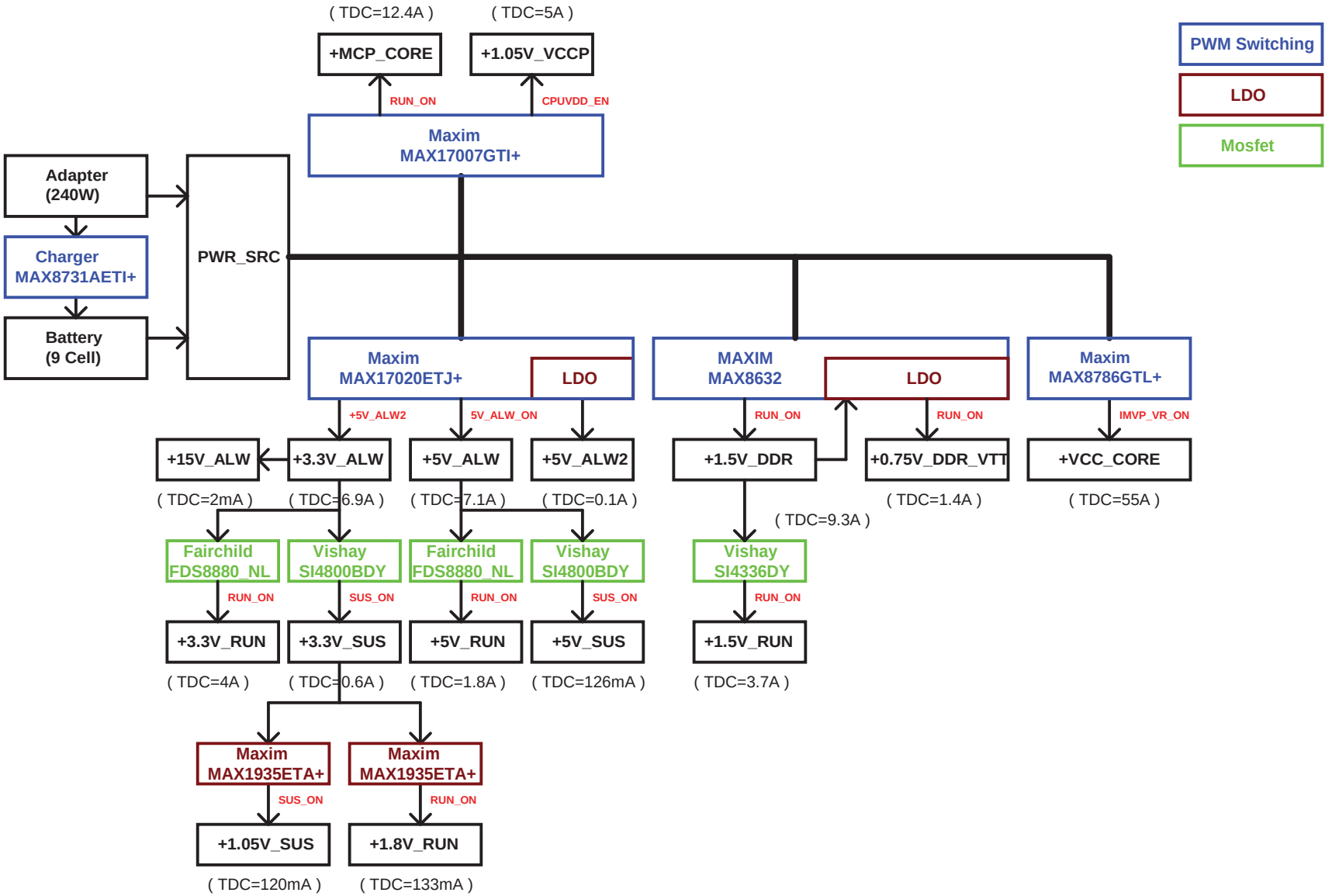

Title: **Power Block Diagram**

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Screw Hole

H1 NPTH7_2.8
H2 NPTH7_2.8
H3 NPTH7_2.8
H4 NPTH7_2.8
H5
H6 NPTH7_2.8
H7 NPTH7_2.8
H8 NPTH9B7_2.8
H9 NPTH9B7_2.8
H10 NPTH9B7_2.8
H11 PTH9B7_2.8
H12 NPTH9B7_2.8
H13 NPTH9B7_2.8
H14 PTH6B0_1.2
H15 PTH6B0_1.2
H16 PTH0B7_6
H17 PTH0B7_6
H18 PTH0B7_6
H19 PTH0B7_6

FID

FID1 NC, NO CONNECT TO ANY.
FID2 NC, NO CONNECT TO ANY.
FID3 NC, NO CONNECT TO ANY.
FID4 NC, NO CONNECT TO ANY.
FID5 NC, NO CONNECT TO ANY.
FID6 NC, NO CONNECT TO ANY.
FID7 NC, NO CONNECT TO ANY.
FID8 NC, NO CONNECT TO ANY.

Unused Gate

+3.3V_RUN U44C 74LVC08APW
+3.3V_RUN U44D 74LVC08APW
+5V_ALW PU12B LM393ADR

+PWR_SRC
C273 C385 C388 C445 C446 C448 0.1U/50V_0603

Moat Cap

+3.3V_RUN +5V_ALW
C674 C675 C676 C892 C893 0.1U/10V

+MCP_CORE +1.05V_VCCP
C732 0.1U/10V

+PWR_SRC +MCP_CORE
C389 0.1U/50V_0603

+5V_RUN +3.3V_KBVCC
C743 0.1U/10V

+3.3V_RUN +PWR_SRC
C243 C244 C245 0.1U/50V_0603

+5V_RUN +PWR_SRC
C269 C272 0.1U/50V_0603

+PWR_SRC_MXM1
C268 C271 C270 C447 0.1U/50V_0603

+1.5V_DDR +PWR_SRC
C249 C264 C265 C266 C267 0.1U/50V_0603

+1.05V_VCCP +PWR_SRC
C246 C247 C248 0.1U/50V_0603

+5V_RUN +3.3V_RUN
C744 C745 C746 C747 C757 C758 C759 C760 C767 C766 C768 C770 C769 C771 C773 C772 C774 0.1U/10V

+1.05V_VCCP +3.3V_RUN
C721 C720 C722 C723 C727 C729 C730 C731 C752 C753 C754 C755 C756 0.1U/10V
C761 C762 2200P/50V
C889 C888 C891 C890 0.1U/10V

+MCP_CORE +1.5V_DDR
C735 0.1U/10V

+1.5V_DDR +1.05V_VCCP
C733 C734 0.1U/10V
C748 C763 2200P/50V

+1.5V_DDR
C736 C737 C738 C739 C740 0.1U/10V

+5V_ALW +5V_RUN
C741 C749 C750 C751 C872 C873 C878 C879 C880 C887 0.1U/10V

+3.3V_RUN +3.3V_KBVCC
C742 0.1U/10V

+5V_ALW +PWR_SRC
C240 C241 C242 0.1U/50V_0603

Title	PAD & SCREW	
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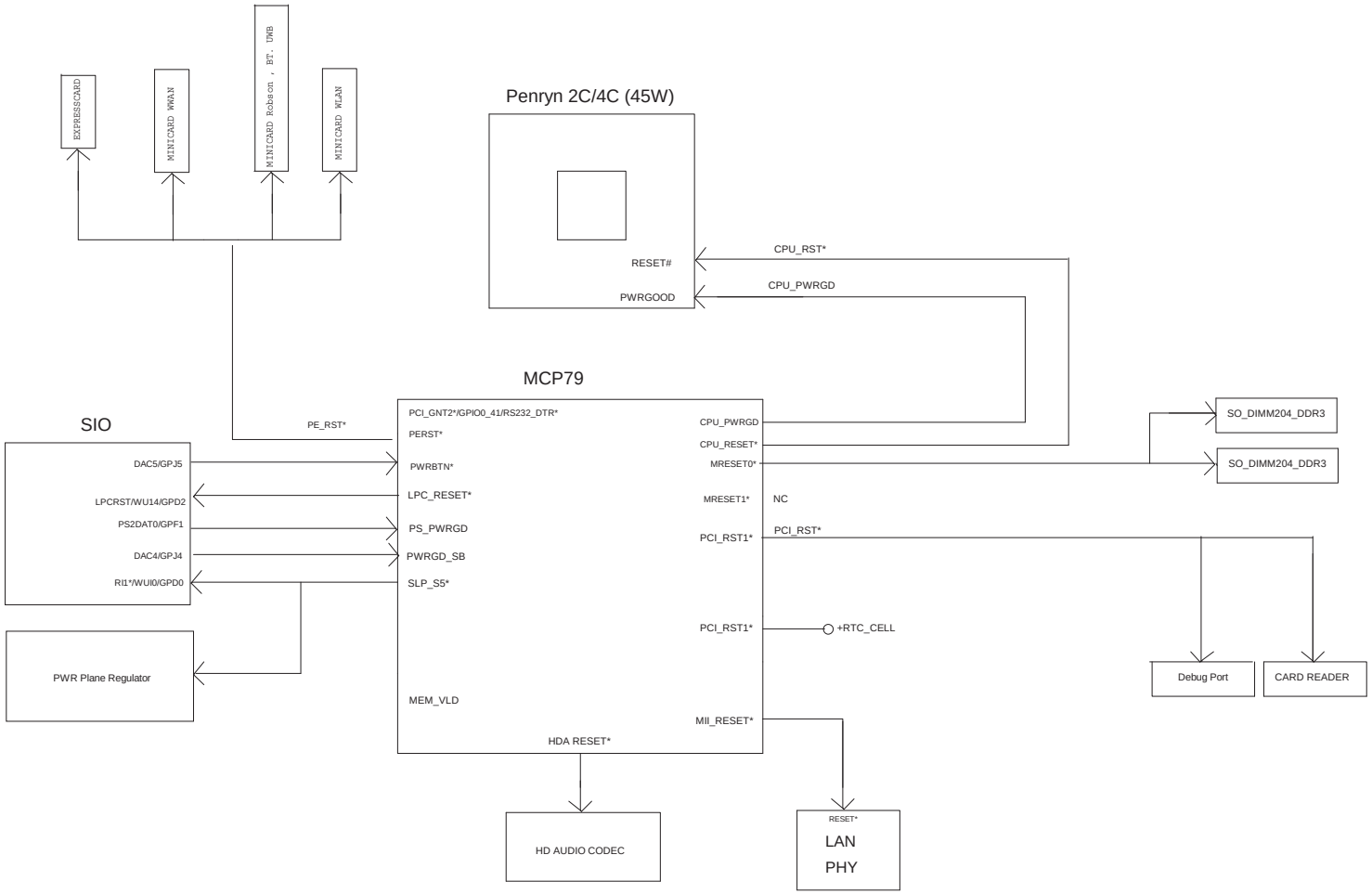
RESET MAP



Title	PCI RESET MAP	
Size	Document Number: Dell/FLEX Confidential	Rev: A00
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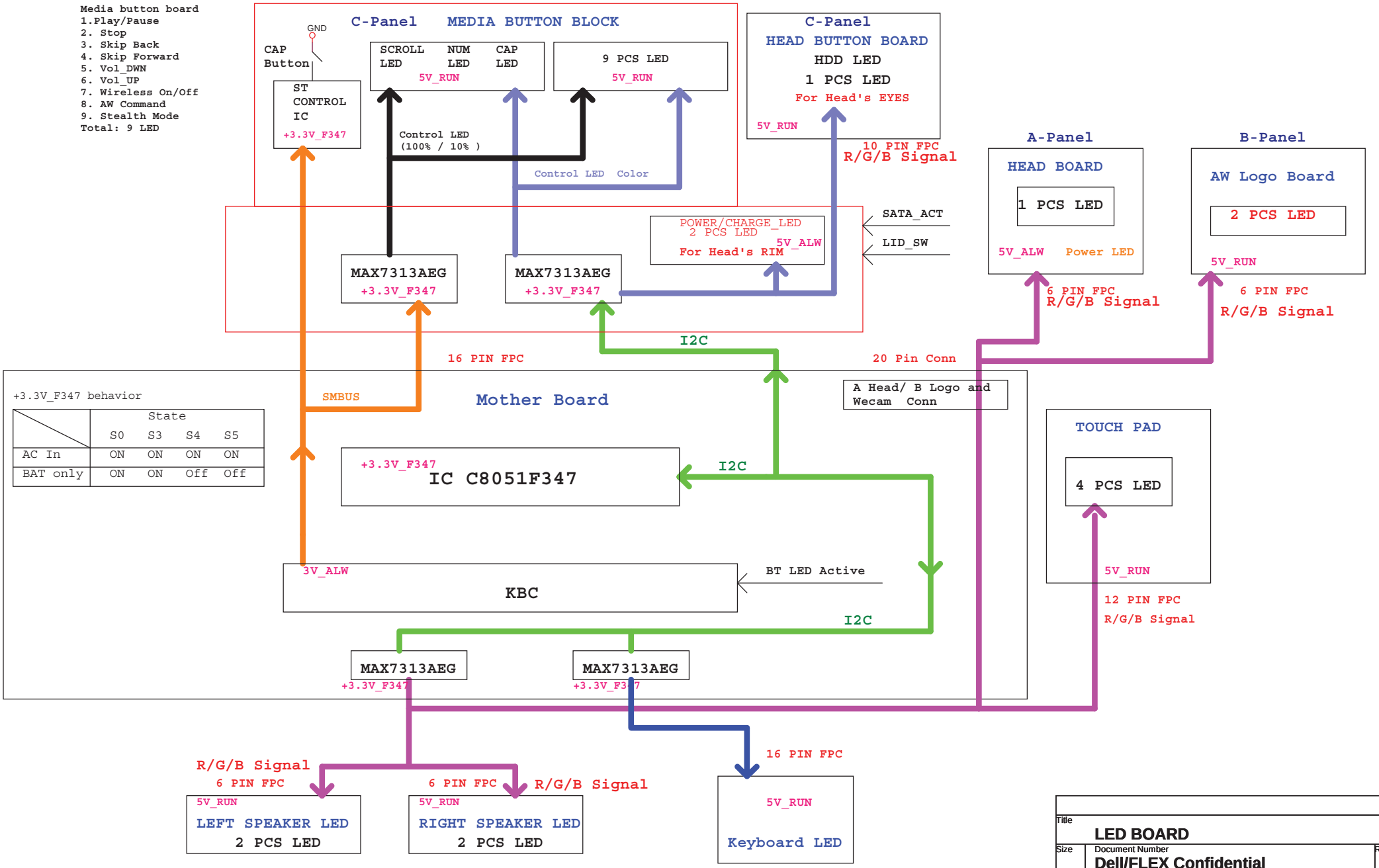

Version change list (P.I.R. List)

Item	Fixed Issue	Reason for Change	Rev	PG#	Modify List	B Ver#	Phast
1	EMI Modify Part of Bead		X00	44, 49	Modify Part of FL5, FL6, FL7, FL8 to BJ3216HS480NT.	X00	SSI
2	Modify Thermal sense Diode	To meet SMSC suggestion in Document AN1214.	X00	5, 6, 9, 32, 42, 49	Modify Q2, Q5, Q22, Q23, Q24, Q25, Q26, Q27, Q28, Q51, Q86, Q88, Q90, Q92, Q94, Q102, Q103, Q111, Q121, PQ37 to MMBT3904-7-F. (From MMST3904, also modify footprint)	X00	SSI
3	Modify ELC parts to NA.	To meet Dell circuit design requirment.	X00	36	1. Modify R637, R638, R639, R640, R641 to NA. 2. Modify Q50, R373, R372, R528, R529, C532, C542, C543, U118 to NA. 3. Modify U45 pin24, R635 pin2, R647 pin2 to +3.3V_ALW. 4. Modify U45 pin22 to LED_CLK, U45 pin23 to LED_DATA. 5. Add CN27 (4 pin debug header)	X00	SSI
4	Modify Footprint of Mini Card.	To separate Wini-lock& Connector	X00	30, 31	Del CN18(MiniCard WLAN Connector)& CN19(MiniCard WWAN, BT, UWB Connector)& CN20(Flash Cache Module Connector) Pin M3,M4,M5,M6.	X00	SSI
5	Move DP AUX pull-up& down resistor.	Modify by NV recommend.	X00	27	Move R191,R200 to CN10(DP conn) side.(NV recommend)	X00	SSI
6	Add LVDS DDC selection pull-up.	Add by NV recommend.	X00	26	Add R520 on U124 pin 1 and pull up to +3.3V_RUN	X00	SSI
7	Separte Head LED power	To meet Dell circuit design requirment.	X00	24	Modify CN62(CAM/ Head/ Logo Conn) pin11 to +5V_ALW& add C627 decoupling cap	X00	SSI
8	Fine tune MCP power trace.	To increase MCP power trace	X00	7, 9, 10, 13, 14, 15	1. Modify L1 pin1, L2 pin1, L3 pin2, L10 pin1 to +1.05V_VCCP. 2. DEL C427, C57, C62, C121, C122, C432, C174, C311, C217, C204, C214	X00	SSI
9	Modify ELC circuit design	To meet Dell circuit design requirment.	X00	36	1. Modify TP_LED_R_DRV#, TP_LED_G_DRV#, TP_LED_B_DRV# from U43 pin17, 18, 19 to U45 pin17, 18, 19. 2. Modify U51 pin 16 to +5V_ALW, U45 pin 1& 16 to +3.3V_ALW. 3. Modify U45 pin 22& 23 to LED_CLK& LED_DATA.	X00	SSI
10	Modify +1.5V_DDR power sequence	To meet NV power sequence recommend.	X00	46	1. Modify PR95& PR98 to connect "STBY". Also modify PR99 to "SHDN". 2. Modify PR100 to connect "+5V_ALW".	X00	SSI
11	Remove Hardware Total Power control	To solve CPU CLKSTP can't work issue.	X00	7	1. Remove R513 2. Add "H_CLKSTP" to connect MCP79& CPU directly.	X00	SSI
12	Modify Gating parts to NA.	Didn't use these Gating circuit but reserve all of these parts for MXM power gating.	X00	19, 21	Modify Q13, Q15, Q16, Q17, Q36, Q38, Q39, Q40, R189, R190, R248, R249, C310, C312, C313, C324, C326, C333, C334, C365, C366, C367, C368 and C369 to NA.	X00	SSI
13	Update all of connector lists	Update all of connector modification by M.E..	X00	24, 25, 29, 31, 35, 49	Modify footprint of CN7, CN8, CN14, CN16, CN17, CN23, CN52, CN57 and CN62.	X00	SSI
14	Add Moat capacity	Add Moat capacity by EMI request	X00	52	Add C761, C762& C763 Moat capacity by EMI request.	X00	SSI
15	Backlite final-tune.	Add reserve resistor for backlite final-tune.	X00	24	Add R520& R631 (0ohm_0603) for Backlite final-tune.	X00	SSI
16	WebCam DGND	WebCam DGND connect GND directly.	X00	24	Delete C673 to connect GND directly.	X00	SSI
17	Verify BIOS debug pin	Add test pad on Mini card pin 16, 17, 19.	X00	30	Add T29, T31, T32 on CN18 pin 16, 17, 19.	X00	SSI

Title	LED BOARD	
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Item	Fixed Issue	Reason for Change	Rev	PG#	Modify List	B Ver#	Phast
18	Add 100pF cap near by SIM con.	Verify SIM card DATA& Reset lines.	X00	31	Add C628& C629 to NA and near by CN23.	X00	SSI
19	Connect +V_TV_DAC to GND	Follow NV design guideline	X00	11	Delete R452 and connect it directly to GND.	X00	SSI
20	Modify ELC circuit	To meet Dell circuit design requirment.	X00	36	U42 changes: 1. Change VBUS(pin 8) power to +5V_SUS 2. Change REGIN(pin 7), R632 and R636 pullup to +3.3V_F347. You could use the Q50 circuit for this. 3. Generate +3.3V_F347 from +3V_ALW and control the power state by SUS_ON and ACIN. We need this power to be ON during S0/S3/S4/S5 when on AC. On Battery this power is available only in S3. 4. Connect U40 power to +3.3V_F347 power. 5. Remove all the RGB_OVERRIDE# circuit. 6. Connect LID_SW# to U42 (similar to KB_DET#_R FET circuit) 7. Connect a new GPIO LOW_BATTERY from EC to U42 GPIO. U51: Remove I2C/SMBDAT2 MUX switch. Not required as per new requirement from AlienFX. U43: Change the power to this part to +3.3V_F347 U45 Changes: 1. Change the power to this part to +3.3V_F347 2. Change SCL and SDA connection to I2C_CLK_R, I2C_DAT_R. Change R264, R262, R596 power to +3.3V_F347. Add LID_SW# circuit.	X00	SSI
21	Modify ELC circuit	To meet Dell circuit design requirment.	X00	35	Add R655, Q116, Q117, Q118, Q119 for TP_LED_DRV disable.	X00	SSI
22	Add HDD Power Bulk Capacity	To meet Dell circuit design requirment.	X00	35	Add C630 for HDD 3V power Bulk cap	X00	SSI
23	Improve thermal trip sequence	EMC4002 thermal trip sequence	X00	32	Add C631 for EMC4002 thermal trip sequence.	X00	SSI
24	Add Jumper near by DC Jack	Add Jumper for EMI parts reserve	X00	49	Add PJP12& PJP17 for EMI parts reserve.	X00	SSI
25	Delete S5, S3 pull-high resistor.	Delete EC S5, S3 PH resistor by NV recommend.	X00	33	Delete R380& R383 by NV recommend	X00	SSI
26	Add +5V_SUS gating circuit.	Add +5V_SUS gating circuit for ELC circuit	X00	50	Add PQ11, PC194, PC195 for ELC circuit.	X00	SSI
27	Remove power source cap	Remove it due to space issue.	X00	44	Remove PC31 due to space issue.	X00	SSI
28	Add EMI's modification.	Add EMI's modification.	X00	44	Page11: 1. R75 change from 0ohm to 22ohm. 2. Add 22ohm resistor*4pcs to Net RGMII_TXD0 ,RGMII_TXD1, RGMII_TXD2,RGMII_TXD3(close to MCP79SLI). Page 14: 1. C177,C173 change from 10pf to 22pf 2. R126,R257 change 0ohm to 22ohm Page24: 1. Mount C568,C569. 2. Modify R415,R416 to L63, L64. 3. Add 0.1uf caps between +5V_RUN and Gnd(close to CN7) for 1 EA (C633) 4. Add 0.1uf caps between +GFX_PWR_SRC and Gnd (close to CN7) for 2 EA (C635, C636) Page28: 1. Mount L27, L28, L46 and leave R300, R301, R302, R304, R394, R395 empty 2. Mount ESD2,ESD3,ESD5. Page 35: 1. Mount CP1,CP2,CP3,CP4,CP5,CP6.	X00	SSI

2. Add 100pf caps*3pcs to Net RSPK_LED_B_DRV# ,RSPK_LED_G_DRV#, RSPK_LED_R_DRV# to GND (close to CN6). (C638, C639, C641)
Page 40: 1. Resved a Crystal 25MHz to Lan chip(close to U33) (Y3, C204, C214)
2. C136, C695 change from N/A to 22pf
3. R538, R541 change from 0ohm to 22ohm
4. Add 100pf caps* 3pcs to Net SPD10LDE, SPD100LED, PHY-ACTLED to GND. (C644, C645, C646)
5. Add 0.1uf caps between +3.3PHY and GND for 2 EA. (C764, C765)
Page44: Mount PC67, PC76, PC60, R61,PR155,PR156 also change to 0 ohm.
Page52: Add 0.1uf caps between 3.3V_RUN and GND for 9 EA. (C766, C767, C768, C769, C770, C771, C772 , C773, C774)

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Item	Fixed Issue	Reason for Change	Rev	PG#	Modify List	B Ver#	Phast
29	Modify 0603 resistor to JP	Mini-card power consumption more than R327 absorb.	X00	30	Delete R327 and Add JP4 to instead.	X00	SSI
30	Add 3 caps near by Vcore choke	To reduce AC droop	X00	44	Add PC155, PC161, PC163 parallel with PC78, PC65, PC61.	X00	SSI
31	Leave Power resisotr empty	Leave PR41 empty for line load modify	X00	44	Leave PR41 to empty.	X00	SSI
32	Add dampping resistor	Add dampping resistor by Ricoh recommend to final-tune media card signal.	X00	39	Add R504, R505, R534, R535, R638, R656, R657 ,R658 to final-tune Media card signal.	X00	SSI
33	Add PH resistor on display MUX	Add Pull-high resistor by TI recommend.	X00	39	Add R659, R155, R660, R56, R661, R662 pull-high resisotr by TI recommend.	X00	SSI
34	Add TPM circuit	Add TPM circuit by Dell requirement	X00	34	Add U145, R66, R69, R70, R72, R120, R415, RJ5, RJ6, C647, C648, C650, C650, C652, C653 for TPM circuit	X00	SSI
35	Change the MUX source for support Hybrid function	SN74LVC1G3157DCKR repair easier & lower cost than FUSB20.	X00	26	Change MUX source from FUSB20 (10pins) to SN74LVC1G3157DCKR(6pins). The SN74LVC1G3157DCKR amount need double. U120=> U120 & U132 (MXM/MCP LVDS DDC MUX) U121=> U121 & U134 (MXM/MCP VGA DDC MUX) U122=> U122 & U136 (MCP AUX/DDC MUX) U123=> U123 & U138 (MXM/MCP DP AUX MUX) U119=> U119 & U144 (MXM DP AUX/DDC MUX) U126=> U126 & U143 (MXM/MCP HDMI DDC MUX) U124=> U124 & U140 (MCP MEM& LVDS SMBus MUX)	X00	SSI
36	Add test-PAD	Add test-PAD for NV software debug.	X00	12	Add test-PAD on "PCI_REQ2, MXM1_PWR_EN, WLAN_RADIO_DIS#, WLAN_PCIE_RST#, WPAN_PCIE_RST#, WWAN_PCIE_RST#".	X00	SSI
37	Update EMI solution	Update EMI solution	X00	12	Page 29: Add 0.1uF cap between +5V_HDD& GND for 5 EA. (C660, C661, C662, C664, C667). Page 33: 1. R387 change from 0ohm to 22ohm 2. R396 change from N/A to 0ohm 3. C550 change from N/A to 10pf Page 41: Add 0.1uF between GND_LAN& GND and leave empty.	X00	SSI
38	Add Jumpper& Modify power plante	Add Jumpper& Modify power plante for MXM1 power measurement.	X00	19, 52	1. Add JP20& create +PWR_SRC_MXM1 power. 2. Modify power plante of C315, C316, C317, C318, C319, C320, C268, C270, C271, C447 to +PWR_SRC_MXM1.	X00	SSI
39	Add +5V_RUN_BLOGO power gating	Add +5V_RUN_BLOGO power gating by Dell ELC request.	X00	24	Add Q72, Q123, R96, R327 to gating +5V_RUN and create +5V_RUN_BLOGO power.	X00	SSI
40	Add stitch cap	Add stitch cap between +1.05V_VCCP& GND	X00	10	Add C121, C122 stitch cap fbetween +1.05V_VCCP and GND.	X00	SSI
41	Modify resistor value. (BOM)	Modify the value to meet PCI-E high swing function.	X01	20, 22	Modify R518& R600 to 0 ohm to meet PCI-E high swing function. (MXM card internal pull-high for 10Kohm)	X01	PT
42	eSATA re-drive IC setting	Add components for eSATA re-drive setting	X01	28	Add R663& R664 for eSATA future setting use	X01	PT
43	Revise EC control pin	Remove reserve circuit after double confirm with intel.	X01	5, 6	Page5: Remove R87, Page 6: Remove R689, R690, C798, Q120& Q121 to remove Quad core detect circuit. Page 33: Modify U15 pin 98 to "FUSB31_ON#"& pin 99 to "MXM2_PRESENT#".	X01	PT

Item	Fixed Issue	Reason for Change	Rev	PG#	Modify List	B Ver#	Phast
44	Fine tune 1394 signal (BOM)	Fine tune 1394 signal	X01	39	Modify R465, R466, R467& R468 to 54.9ohm.	X01	PT
45	Add Mini-Card card detect resistor	Add pull-high restor for Mini-Card detect	X01	30, 31	Add R380, R383, R402, R416& R452 for Mini-card detect level.	X01	PT
46	Add CAM power control circuit	Driver of CAM can't shut power down	X01	24, 36	Page 24: Add Q73, C668, C311. Page 30: Add R687 pull-high resistor& U41 pin20 for "CAM_PWR_ON"	X01	PT
47	Modify Media Card signal dampping resistor. (BOM)	Modify Media Card signal dampping resistor for EMI signal fine-tune	X01	39	Modify R504, R505, R534, R535, R638, R656, R657, R658& R482 to 27ohm for EMI signal fine-tune.	X01	PT
48	Imporve X'tal timing. (BOM)	To improve X'tal timing by Vendor suggestion.	X01	14, 33, 34	Modify C185, C186, C551& C552 to 15pF and modify C597& C598 to 20pF	X01	PT
49	Fine tune MXM sequence (BOM)	Fine tune MXM power sequence for reliability	X01	32, 42	P32: Delete R223, R224, R530& R374 and Add R607, R608, R487, R488, C794& C795 then connect to "MXM1_35VOK" P42: Modify R567 to 20Kohm and add C775 to GND.	X01	PT
50	Fine tune Media Card signal	Fine tune Media Card signal for EMI& reliability	X01	39	Add R689, R690, R693& R694 (27ohm) for Media Card signal fine tune.	X01	PT
51	For "PE0_PRSNT16#" It need a SW control (MXM_ON#).	When "Hybrid" enabled and MXM_ON# assert to low, 2 of MXM cards PCIECLK will be active.(NV suggest)	X01	10	Stuff R78 and Unstuff R67& R424	X01	PT
52	For GPIO_47 it need to connect "MXM1_PRESENT#"	SBIOS used GPIO_47 to do a judgment whether MXM cards on board.(NV suggestion)	X01	10	Add R141	X01	PT
53	Unstuff DP HPD 100K pull low resistors.	MXM card has internal pull low.Follow MXM3.0 Design guideline.	X01	10, 27	Unstuff R503& R513	X01	PT
54	V_RGB_DAC can be shorted to GND if RGB interface is not used.	Follow MCP79 checklist v08	X01	11	Unstuff L6, C138& C139. Del C137 and Add R87	X01	PT
55	Follow MXM design guideline seqence	Follow MXM design guideline seqence.	X01	19, 21	Modify CN4& CN5 pin278, 280 to +3.3V_RUN. Change C327, C328, C329& C359 pin1 from +3.3V_MXM1(+3.3V_MXM2) to +3.3V_RUN. Modify CN4& CN5 pin1, 3, 5, 7, 9 to +5V_RUN. Change C829, C321, C322, C855, C325, C323, C830, C665, C654, C858, C666& C657 pin1 from +5V_MXM1(+5V_MXM2) to +5V_RUN. Add JP22 to connect +3.3V_MXM1& +3.3V_MXM2.	X01	PT
56	Fix MXM card leakage issue	Add gating circuit to fix leakage issue	X01	19, 20, 22	DEL +3.3V_RUN _HYBRID circuit.(R214,Q78,Q80,R402,C613,Q79,C614,C377) Change +3.3V_RUN _HYBRID power to +3.3V_MXM1(+3.3V_MXM2) . Stuff Q12, R185, Q14, R186, Q104, R500, Q105& R501 Unstuff R201, R582, R639& R640 Stuff Q81, R498, Q82, R499, Q20, R196, Q21& R197 Add D56& D57 Unstuff R641, R652, R653& R654	X01	PT
57	Reserve cap to fine tune sequence	Reserve cap to fine tune PWR_EN sequence	X01	20, 22	Reserve 0.1uf (Unstuff) C766& C777	X01	PT
58	Fix TMDS251 leakage issue	Plug external HDMI device will cause system leakage from TMDS251 vcc pin.	X01	19, 23	Add Q76,C377,C614,C613,C377 and Add net +3.3V_MXM1_HDMI.	X01	PT
59	Update EMI solution of X01 (BOM)	Update EMI solution of X01	X01	40	Modify R683, R684, R685, R686 to 22ohm.	X01	PT

Item	Fixed Issue	Reason for Change	Rev	PG#	Modify List	B Ver#	Phast
60	Let KBC can judge 2'nd MXM card plug in.	Connect MXM2_PRESENT2# to KBC.Let KBC can judge 2'nd MXM card plug in.	X01	33	MXM2_PRESENT2# connect to U15 pin 99.	X01	PT
61	Fix press 4 second shutdown leakage issue.	Crt_Ddc_Sel (GPIO36), Dp_Sel(GPIO4), Lvds_Sel(GPIO 20), Lvds_Ddc_Sel(GPIO 21), Lvds_Mem_Ddc_Sel (GPIO6), HDMI_DDC_Sel(GPIO5) active high after press 4 second shutdown then cause leakage to +3V_RUN.	X01	23, 26	Add pull high resistors & diodes. R695, R696, R697, R698, R699, D44, D47, D48, D54, D49& D55	X01	PT
62	Delay MXM1_35VOK sequence (BOM)	Delay MXM1_35VOK sequence to control MXM thermaltrip gating.	X01	42	Add C775 Change R567 to 20K	X01	PT
63	Delete HDMI pass resistor	Remove them to improve HDMI signal	X01	23	Remove R485, R486, R487, R488, R489, R490, R491, R492, R493, R607& R608.	X01	PT
64	Add cap near by Media card controller	Add cap to improve Media card signal	X01	39	Add C217, C778, C779, C780, C781, C782, C785, C786, C787, C788, C789, C790, C791& C792	X01	PT
65	Meet SMSC EMC4002 circuit design (BOM)	Add circuit to meet SMSC suggest, also keep Dell request.	X01	32, 47	Modify R218 to 4.7K ohm and pull-high power to +3.3V_SUS Add Q78, Q79, R224& R490.	X01	PT
66	Add Dampping resistor	Add 22 ohm resistor to improve CRT signal	X01	25	Add R374& R485	X01	PT
67	Fix Keyboard LED wrong color	In order to correct keyboard LED display	X01	37	Swap CN57 pin 3, 4 pin define from R to G& G to R.	X01	PT
68	Follow NV designguide (BOM)	Modify schematic to meet NV design guideline	X01	9, 10, 11, 13, 14, 15	Modify C115, C123, C131, C161, C164, C191, C196& C198 to 2.2uF. Unstuff R100 Modify R145, R146, R211& R244 to 2.2Kohm. Modify C116 to 2.2uF. Add C65, C174& C793	X01	PT
69	Update EMI solution of X01	Update EMI solution of X01	X01	11, 19, 24, 28, 32, 35, 39, 40, 47, 49, 52	Unstuff R82, R469, R470, R471, R474, R541& C136 Stuff C204, C214, C835, C836, C837, C838, L39, L40& Y3. Add C796, C797, C798, C799, C800, C801, C802, C803, C804, C805, C806, C807, C824, C825, C864, C865, C866, C867, C869, C870, C871, C872, C873, C874, C878, C879, C880, C887, C888, C889, C890, C891, C892, C893. Move C677, C678, C679, C680, C681, C682, C683& C684 to near by CN63. Delete R549 and Add C894.	X01	PT
71	Power VDS derating modify	To meet Power VDS derating specification	X01	45, 46, 47	Stuff PR65, PR96, PR119, PR122& PC90. Stuff PC118, PC136& PC137 and modify them to 1000pF	X01	PT
72	Improve AC-in Detect function	Due to MXM had internal pull-hign at AC-in signal cause AC-in detection fail	X01	19	Add R491& Q120 and R502 to 100Kohm	X01	PT
73	Update eSATA re-drive& FSUSB31K8X IC setting (BOM)	Due to eSATA re-drive IC set to increase signal stress cause signal failure and FSUSB31K8X setting.	X01	28	Stuff R663& R664 and Unstuff R618& R619 for eSATA re-drive IC. Stuff R489 for FSUSB31K8X.	X01	PT
74	Reserve SIM card connector and stuff components to test FCM mini card connector (BOM)	In order to prepare reserve CN19 so stuff all of components for FCM and reserve SIM card connector	X01	31	Unstuff CN23, C523, C524, C525, C526, C527& ESD4. Stuff R333, R334, R335, R336, R337 R338, R339, R349, R351, R353& R355.	X01	PT

Item	Fixed Issue	Reason for Change	Rev	PG#	Modify List	B Ver#	Phast
75	Fine tune PCI clock (BOM)	Due to PCI clock fail of EA test report.	X01	12	Stuff C151 and modify to 15pF	X01	PT
76	Reserve unused MXM2 power sequence control circuit (BOM)	Reserve unused MXM2 power sequence control circuit	X01	42	Unstuff C724, C725, C726, C728, D45, D46, R611, R612, R613, R642, R643, R644, R645, Q100, Q101, Q102& Q103.	X01	PT
77	CRT signal improvement (BOM)	To improve CRT signal	X01	25	Modify L56, L57& L58 to BLM18BB750SN1D	X01	PT
78	Turn off SUS power in DC mode	Turn off SUS power in DC mode to prevent leackage current	X01	32, 33, 42	Modify R205 pin 1 to +3.3V_SUS. Add R492 and unstuff. Modify U15 pin 85 to "RUNPWROK#" and delete R590& Q77.	X01	PT
79	MCP79 Vcore table modify	To meet NV MCP79 designguide - DG-03328-001_v12	X01	45	Modify PR83 to 200Kohm_F. Also modify MCP79 Vcore table.	X01	PT
80	DP HPD floating (BOM)	R513 avoid DP HPD floating	X02	27	Mount R513	X02	ST
81	DP power drop too big (BOM also)	Avoid DP power drop cause by D17.	X02	27	Add R549 (0ohm_0603) and leave D17 NC.	X02	ST
82	DP leackage current issue (BOM)	Avoid DP leackage current	X02	27	Modify D33 from BAV99-7-F to RB500V-40.	X02	ST
83	HDMI TV leackage issue	Fix HDMI TV plug -in leackage from TMDS251 to system.	X02	19	Add Q77 (2N7002) for dis-charge.	X02	ST
84	Meet new inductor's droop voltage (BOM)	Meet new inductor's droop voltage	X02	44	Modify PL2, PL3, PL4 to ETQP4LR36WFC. Modify PR40& PR59 to 5.63Kohm & 316Kohm.	X02	ST
85	Media Board sometimes fail (BOM)	Improve SM bus fan-out ability for Media baord	X02	22, 33	Modify R196, R197, R273, R274 to 13Kohm	X02	ST
86	EMI solution in ST phase - 1. (BOM)	Add EMI solution	X02	28, 41	Add EMI2& EMI3. Mounted L32, L42, L43& L45 and remove R366, R371, R375, R381, R382, R411, R412& R414 by BOM change.	X02	ST
87	AMD MXM leackage current issue	Avoid AMD MXM leackage current	X02	20, 22	Add D60& D61 and Delete R640& R652.	X02	ST
88	SM bus equivalent parallel resistance low (BOM)	SM bus equivalent parallel resistance too low so increase the value of resistor	X02	23, 26	Modify R494, R495, R496, R497, R601& R604 to 10Kohm in page 23. Modify R147, R155, R156, R609, R610, R627, R659, R660, R661& R662 to 10Kohm in page 26.	X02	ST
89	eSATA output driving strength (BOM)	Improve eSATA output driving strength	X02	28	R618, R619 Mount and R663, R664 NA.	X02	ST
90	Fine tune +3.3V_MXM1 power sequence (BOM)	Fine tune +3.3V_MXM1 power sequence to close 3V of MXM card's power sequence	X02	28	C310,C312,C614 change to NA	X02	ST
91	Fine tune MXM card power enable sequence (BOM)	Fine tune MXM card power enable sequence make sure +3.3V_MXM1 power sequence to close 3V of MXM card's power sequence	X02	20, 22	R192,R256 change to 10Kohm C776,C777 Mount.	X02	ST
92	Follow TI vendor suggestion	To make sure the TMDS 251 power stable	X02	23	Add 10UF on +3.3V_MXM1_HDMI	X02	ST
93	Reserve unused power (Audio board)	Reserve unused power for Media card of Audio board	X02	39	Add 0ohm and leave empty.	X02	ST

Item	Fixed Issue	Reason for Change	Rev	PG#	Modify List	B Ver#	Phast
94	Fine tune +3.3V_MXM1& +5V_MXM1 power sequence (BOM)	Fine tune +3.3V_MXM1& +5V_MXM1 power sequence .	X02	19	Stuff R176& Unstuff R486	X02	ST
95	USB waveform fail	Improve USB waveform	X02	28	Stuff R394, R395& Unstuff L46, ESD5	X02	ST
96	VGA ACAVIN control (BOM)	Add VGA ACAVIN	X02	19	Add Q80 and connect to ADAPT_TRIP_SET. Modify R502 to 4.7Kohm.	X02	ST
97	3.3V OCP keeping re-try (BOM)	Make sure signal won't floating and keep original request	X02	47	Modify PR135 to 20K Add R590	X02	ST
98	EMI solution in ST phase - 2. (BOM)	Add EMI solution	X02	39	C792 change from 10pf to 15pf R482 change from 27ohm to 0ohm	X02	ST
99	Media Card signal waveform improve	Media Card signal waveform improve	X02	39	R118, R504, R505, R534, R535, R638, R656, R657, R658, R689, R690, R693& R694 change from 27ohm to 33ohm Unmoute C217, C778, C779, C780, C781, C782, C785, C786, C787, C788, C789, C790, C791& C792.	X02	ST
100	1.5V power regulator level modify (BOM)	Modify 1.5V power regulator level	A00	46	Modify PR221 to 80.6Kohm	A00	MP
101	Fix 1.5V power non-modification (BOM)	Fix 1.5V power non-modification	A00	46	PR214& PR221 un-stuff	A00	MP
102	Fine tune +3.3V_MXM1& +5V_MXM1 power sequence (BOM)	Fine tune +3.3V_MXM1& +5V_MXM1 power sequence .	A00	19	Unstuff R176& stuff R486	A00	MP
103	Fine tune MXM card power enable sequence (BOM)	Fine tune MXM card power enable sequence make sure +3.3V_MXM1 power sequence to close 3V of MXM card's power sequence	A00	20, 22	R192,R256 change to 0ohm C776,C777 Unstuff.	A00	MP
104	Modify Display Port HPD vlotage sense.	Modify Display Port HPD vlotage sense to meet NV checklist	A00	27	Modify R65 to 1Kohm	A00	MP